

LM94

TruTherm[™] Hardware Monitor with PI Loop Fan Control for Server Management

1.0 General Description

The LM94 hardware monitor has a two wire digital interface compatible with SMBus 2.0. Using a $\Sigma\Delta$ ADC, the LM94 measures the temperature of four remote diode connected transistors as well as its own die and 16 power supply voltages. The LM94 has new TruTherm technology that supports precision thermal diode measurements of processors on submicron processes.

To set fan speed, the LM94 has two PWM outputs that are each controlled by up to six temperature zones. The fan-control algorithm can be based on a lookup table, PI (proportional/integral) control loop, or a combination of both. The LM94 includes digital filters that can be invoked to smooth temperature readings for better control of fan speed such that acoustical noise is minimized. The LM94 has four tachometer inputs to measure fan speed. Limit and status registers for all measured values are included.

The LM94 builds upon the functionality of previous mother-board server management ASICs, such as the LM93. It also adds measurement and control support for dynamic Vccp monitoring for VRD10/11 and PROCHOT. It is designed to monitor a dual processor Xeon class motherboard with a minimum of external components.

2.0 Features

- 8-bit ΣΔ ADC
- Monitors 16 power supplies
- Monitors 4 remote thermal diodes and 2 LM60
- New TruTherm technology support for precision thermal diode measurements
- Internal ambient temperature sensing
- Programmable autonomous fan control based on temperature readings with fan boost support
- Fan boost support on tachometer limit error event
- Fan control based on 13-step lookup table or PI Control Loop or combination of both
- PI fan control loop supports Tcontrol
- Temperature reading digital filters
- 0.5°C digital temperature sensor resolution
- 0.0625°C filtered temperature resolution for fan control

- 2 PWM fan speed control outputs
- 4 fan tachometer inputs
- Dual processor thermal throttling (PROCHOT) monitoring
- Dual dynamic VID monitoring (6/7 VIDs per processor) supports VRD10.2/11
- 8 general purpose I/Os:
 - 4 can be configured as fan tachometer inputs
 - 2 can be configured to connect to processor THERMTRIP
 - 2 are standard GPIOs that could be used to monitor IERR signal
- 2 general purpose inputs that can be used to monitor the 7th VID signal for VRD11
- Limit register comparisons of all monitored values
- 2-wire serial digital interface, SMBus 2.0 compliant Supports byte/block read and write
 Selectable slave address (tri-level pin selects 1 of 3 possible addresses)

ALERT output supports interrupt or comparator modes

- 2.5V reference voltage output
- 56-pin TSSOP package
- XOR-tree test mode

3.0 Key Specifications

Voltage Measurement Accuracy	±2% FS (max)
Temperature Resolution	9-bits, 0.5°C
Temperature Sensor Accuracy	±2.5 °C (max)
Temperature Range:	
111010	000: 0500

■ LM94 Operational 0°C to +85°C
Remote Temp Accuracy 0°C to +125°C
■ Power Supply Voltage +3.0V to +3.6V
■ Power Supply Current 1.6 mA

4.0 Applications

- Servers
- Workstations
- Multi-processor based equipment

5.0 Ordering Information

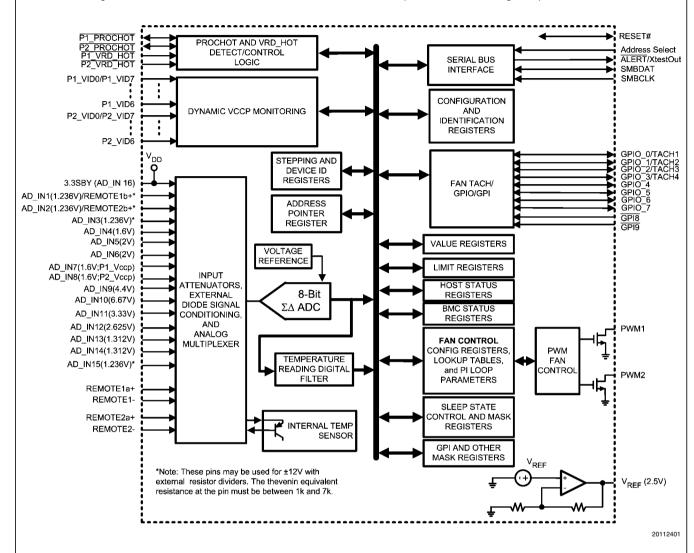
Order Number	NS Package Number	Transport media
LM94CIMT	MTD56	34 units in rail
LM94CIMTX	MTD56	1000 units in tape- and-reel

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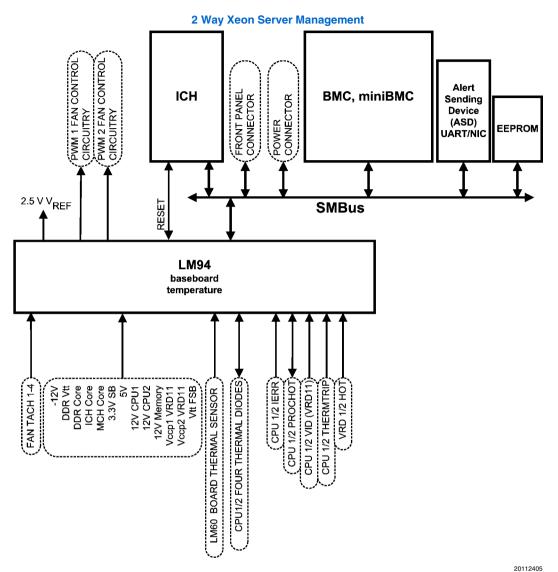
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6.0 Block Diagram 查询"LM94"供应商

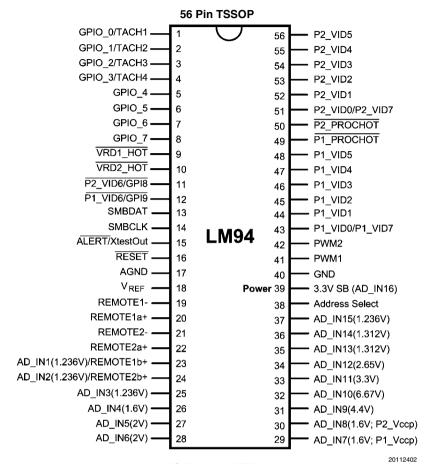
The block diagram of LM94 hardware is illustrated below. The hardware implementation is a single chip ASIC solution.



7.0 Application
Baseboard management of a dual processor server. Two LM94s may be required to manage a quad processor board. The system diagram below shows a dual processor server



查**衡见例如怏cris**on Diagram



NS Package MTD56
Top View
NS Order Numbers:
LM94CIMT (34 units per rail), or
LM94CIMTX (1000 units per tape-and-reel)

9.0 Pin Descriptions 查询"LM94"供应商

Symbol	Pin #	Туре	Function
GPIO_0/TACH1	1	Digital I/O (Open- Drain)	Can be configured as fan tach input or a general purpose open-drain digital I/O.
GPIO_1/TACH2	2	Digital I/O (Open- Drain)	Can be configured as fan tach input or a general purpose open-drain digital I/O.
GPIO_2/TACH3	3	Digital I/O (Open- Drain)	Can be configured as fan tach input or a general purpose open-drain digital I/O.
GPIO_3/TACH4	4	Digital I/O (Open- Drain)	Can be configured as fan tach input or a general purpose open-drain digital I/O
GPIO_4 / P1_THERMTRIP	5	Digital I/O (Open- Drain)	A general purpose open-drain digital I/O. Can be configured to monitor a CPU's THERMTRIP signal to mask other errors. Supports TTL input logic levels and AGTL compatible input logic levels.
GPIO_5 / P2_THERMTRIP	6	Digital I/O (Open- Drain)	A general purpose open-drain digital I/O. Can be configured to monitor a CPU's THERMTRIP signal to mask other errors. Supports TTL input logic levels and AGTL compatible input logic levels.
GPIO_6	7	Digital I/O (Open- Drain)	Can be used to detect the state of CPU1 IERR or a general purpose opendrain digital I/O. Supports TTL input logic levels and AGTL compatible input logic levels.
GPIO_7	8	Digital I/O (Open- Drain)	Can be used to detect the state of CPU2 IERR or a general purpose opendrain digital I/O. Supports TTL input logic levels and AGTL compatible input logic levels.
VRD1_HOT	9	Digital Input	CPU1 voltage regulator HOT. Supports TTL input logic levels and AGTL compatible input logic levels.
VRD2_HOT	10	Digital Input	CPU2 voltage regulator HOT. Supports TTL input logic levels and AGTL compatible input logic levels.
P2_VID6/GPI8	11	Digital Input	CPU2 VID6 input. Could also be used as a general purpose input to trigger an error event. Supports TTL input logic levels and AGTL compatible input logic levels.
P1_VID6/GPI9	12	Digital Input	CPU1 VID6 input. Could also be used as a general purpose input to trigger an error event. Supports TTL input logic levels and AGTL compatible input logic levels.
SMBDAT	13	Digital I/O (Open- Drain)	Bidirectional System Management Bus Data. Output configured as 5V tolerant open-drain. SMBus 2.0 compliant.
SMBCLK	14	Digital Input	System Management Bus Clock. Driven by an open-drain output, and is 5V tolerant. SMBus 2.0 Compliant.
ALERT/XtestOut	15	Digital Output (Open- Drain)	Open-drain ALERT output used in an interrupt driven system to signal that an error event has occurred. Masked error events do not activate the ALERT output. When in XOR tree test mode, functions as XOR Tree output.
RESET	16	Digital I/O (Open- Drain)	Open-drain reset output when power is first applied to the LM94. Used as a reset for devices powered by 3.3V stand-by. After reset, this pin becomes a reset input. See <i>Section 15.2 RESETS</i> for more information. If this pin is not used, connection to an external resistive pull-up is required to prevent LM94 malfunction.
AGND	17	GROUND Input	Analog Ground. Digital ground and analog ground need to be tied together at the chip then both taken to a low noise system ground. A voltage difference between analog and digital ground may cause erroneous results.
V _{REF}	18	Analog Output	2.5V used for external ADC reference, or as a V _{REF} reference voltage
REMOTE1-	19	Remote Thermal Diode_1- Input (CPU 1 THERMDC)	This is the negative input (current sink) from both of the CPU1 thermal diodes. Connected to THERMDC pin of Pentium processor or the emitter of a diode connected MMBT3904 NPN transistor. Serves as the negative input into the A/D for thermal diode voltage measurements. A 100 pF capacitor is optional and can be connected between REMOTE1– and REMOTE1+.

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Symbol	Pin #	Туре	Function
童的IÖπM94"供应商		Remote Thermal Diode_1+ I/O (CPU1 THERMDA1)	This is a positive connection to the first CPU1 thermal diode. Serves as the positive input into the A/D for thermal diode voltage measurements. It also serves as a current source output that forward biases the thermal diode. Connected to THERMDA pin of Pentium processor or the base of a diode connected MMBT3904 NPN transistor. A 100 pF capacitor is optional and can be connected between REMOTE1- and each REMOTE1+.
REMOTE2-	21	Remote Thermal Diode_2 - Input (CPU2 THERMDC)	This is the negative input (current sink) from both of the CPU2 thermal diodes. Connected to THERMDC pins of Pentium processor or the emitter of a diode connected MMBT3904 NPN transistor. Serves as the negative input into the A/D for thermal diode voltage measurements. A 100 pF capacitor is optional and can be connected between REMOTE2– and each REMOTE2+.
REMOTE2a+	22	Remote Thermal Diode_2 + I/O (CPU2 THERMDA1)	This is a positive connection to the first CPU2 thermal diode. Serves as the positive input into the A/D for thermal diode voltage measurements. It also serves as a current source output that forward biases the thermal diode. Connected to THERMDA pin of Pentium processor or the base of a diode connected MMBT3904 NPN transistor. A 100 pF capacitor is optional and can be connected between REMOTE2- and REMOTE2+.
AD_IN1/REMOTE1b+	23	Analog Input (+12V1 or CPU1 THERMDA2)	Analog Input for +12V Rail 1 monitoring, for CPU1 voltage regulator. External attenuation resistors required such that 12V is attenuated to 0.927V for nominal ¾ scale reading. This pin may also serve as the second positive thermal diode input for CPU1.
AD_IN2/REMOTE2b+	24	Analog Input (+12V2 or CPU2 THERMDA2)	Analog Input for +12V Rail 2 monitoring, for CPU2 voltage regulator. External attenuation resistors required such that 12V is attenuated to 0.927V for nominal ¾ scale reading. This pin may also serve as the second positive thermal diode input for CPU2.
AD_IN3	25	Analog Input (+12V3)	Analog Input for +12V Rail 3, for Memory/3GIO slots. External attenuation resistors required such that 12V is attenuated to 0.927V for nominal $\frac{3}{4}$ scale reading.
AD_IN4	26	Analog Input (FSB_Vtt)	Analog input for 1.2V monitoring, nominal 3/4 scale reading
AD_IN5	27	Analog Input (3GIO / PXH / MCH_Core)	Analog input for 1.5V monitoring, nominal ¾ scale reading
AD_IN6	28	Analog Input (ICH_Core)	Analog input for 1.5V monitoring, nominal ¾ scale reading
AD_IN7 (P1_Vccp)	29	Analog Input (CPU1_Vccp)	Analog input for +Vccp (processor voltage) monitoring.
AD_IN8 (P2_Vccp)	30	Analog Input (CPU2_Vccp)	Analog input for +Vccp (processor voltage) monitoring.
AD_IN9	31	Analog Input (+3.3V)	Analog input for +3.3V monitoring, nominal ¾ scale reading
AD_IN10	32	Analog Input (+5V)	Analog input for +5V monitoring silver box supply monitoring, nominal ¾ scale reading
AD_IN11	33	Analog Input (SCSI_Core)	Analog input for +2.5V monitoring, nominal ¾ scale reading. This pin may also be used to monitor an analog temperature sensor such as the LM60, since readings from this input can be routed to the fan control logic.
AD_IN12	34	Analog Input (Mem_Core)	Analog input for +1.969V monitoring, nominal ¾ scale reading.
AD_IN13	35	Analog Input (Mem_Vtt)	Analog input for +0.984V monitoring, nominal ¾ scale reading.
AD_IN14	36	Analog Input (Gbit_Core)	Analog input for +0.984V S/B monitoring, nominal ¾ scale reading.
AD_IN15	37	Analog Input (-12V)	Analog input for -12V monitoring. External resistors required to scale to positive level. Full scale reading at 1.236V, , nominal ¾ scale reading. This pin may also be used to monitor an analog temperature sensor such as the LM60, since readings from this input can be routed to the fan control logic.
Address Select	38	3 level analog input	This input selects the lower two bits of the LM94 SMBus slave address.

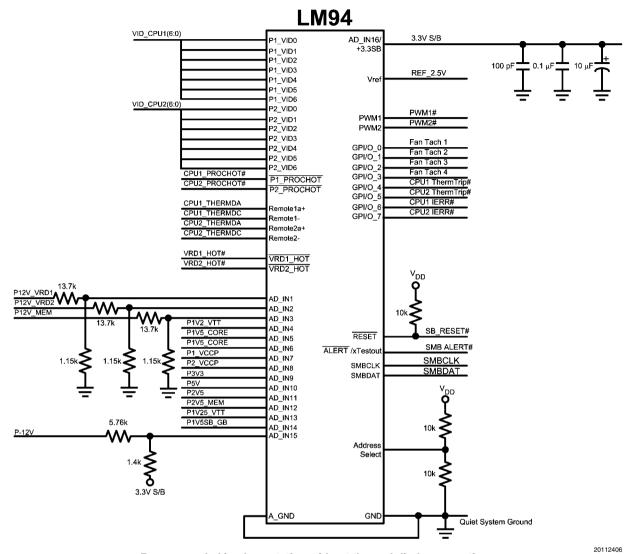
Symbol	Pin #	Туре	Function
3.3V SB (194	"姚应商	POWER (V _{DD}) +3.3V	V _{DD} power input for LM94. Generally this is connected to +3.3V standby
		standby power	power.
			The LM94 can be powered by +3.3V if monitoring in low power states is not
			required, but power should be applied to this input before any other pins.
			This pin also serves as the analog input to monitor the 3.3V stand-by (SB)
			voltage. It is necessary to bypass this pin with a 0.1 µF in parallel with 100
			pF. A bulk capacitance of 10 μ F should be in the near vicinity. The 100 pF
			should be closest to the power pin.
GND	40	GROUND	Digital Ground. Digital ground and analog ground need to be tied together
			at the chip then both taken to a low noise system ground. A voltage
			difference between analog and digital ground may cause erroneous results.
PWM1	41	Digital Output (Open-	Fan control output 1.
		Drain)	
PWM2	42	Digital Output (Open-	Fan control output 2
		Drain)	
P1_VID0/P1_VID7	43	Digital Input	Voltage Identification signal from the processor. Supports TTL input logic
			levels and AGTL compatible input logic levels.
P1_VID1	44	Digital Input	Voltage Identification signal from the processor. Supports TTL input logic
			levels and AGTL compatible input logic levels.
P1_VID2	45	Digital Input	Voltage Identification signal from the processor. Supports TTL input logic
			levels and AGTL compatible input logic levels.
P1_VID3	46	Digital Input	Voltage Identification signal from the processor. Supports TTL input logic
			levels and AGTL compatible input logic levels.
P1_VID4	47	Digital Input	Voltage Identification signal from the processor. Supports TTL input logic
			levels and AGTL compatible input logic levels.
P1_VID5	48	Digital Input	Voltage Identification signal from the processor. Supports TTL input logic
			levels and AGTL compatible input logic levels.
P1_PROCHOT	49	Digital I/O (Open-	Connected to CPU1 PROCHOT (processor hot) signal through a
		Drain)	bidirectional level shifter. Supports TTL input logic level.
P2_PROCHOT	50	Digital I/O (Open-	Connected to CPU2 PROCHOT (processor hot) signal through a
		Drain)	bidirectional level shifter. Supports TTL input logic level.
P2_VID0/P2_VID7	51	Digital Input	Voltage Identification signal from the processor. Supports TTL input logic
			levels and AGTL compatible input logic levels.
P2_VID1	52	Digital Input	Voltage Identification signal from the processor. Supports TTL input logic
			levels and AGTL compatible input logic levels.
P2_VID2	53	Digital Input	Voltage Identification signal from the processor. Supports TTL input logic
			levels and AGTL compatible input logic levels.
P2_VID3	54	Digital Input	Voltage Identification signal from the processor. Supports TTL input logic
			levels and AGTL compatible input logic levels.
P2_VID4	55	Digital Input	Voltage Identification signal from the processor. Supports TTL input logic
			levels and AGTL compatible input logic levels.
P2_VID5	56	Digital Input	Voltage Identification signal from the processor. Supports TTL input logic
	1	1	levels and AGTL compatible input logic levels.

The over-score indicates the signal is active low ("Not").

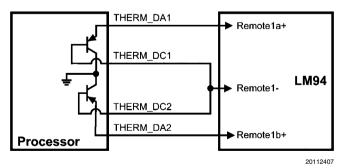
ͺ.	10.0 Server Terminology 以上M94"供知道g to Digital Converter				
1	A/DLIVI94 IX	Analog to Digital Converter			
	ACPI	Advanced Configuration and Power			
		Interface			
	ALERT	SMBus signal to bus master that an event			
		occurred that has been flagged for attention.			
	ASF	Alert Standard Format			
	BMC	Baseboard Management Controller			
	BW	Bandwidth			
	DIMM	Dual in line memory module			
	DP	Dual-processor			
	ECC	Error checking and correcting			
	FRU	Field replaceable unit			
	FSB	Front side bus			
	FW	Firmware			
	Gb	Gigabit			
	GB	Gigabyte			
	Gbe	Gigabit Ethernet			
	GPI	General purpose input			
	GPIO	General purpose I/O			
	HW	Hardware			
	I ² C	Inter integrated circuit (bus)			
	LAN	Local area network			
	LSb	Least Significant Bit			

LSB	Least Significant Byte		
LVDS	Low-Voltage Differential Signaling		
LUT	Look-Up Table		
Mb	Megabit		
МВ	Megabyte		
MP	Multi-processor		
MSb	Most Significant Bit		
MSB	Most Significant Byte		
MTBF	Mean time between failures		
MTTR	Mean time to repair		
NIC	Network Interface Card (Ethernet Card)		
os	Operating system		
P/S	Power Supply		
PCI	PCI Local Bus		
PDB	Power Distribution Board		
POR	Power On Reset		
PS	Power Supply		
SMBCLK and	These signals comprise the SMBus		
SMBDAT	interface (data and clock) See the SMBus		
	Interface section for more information.		
VRD	Voltage Regulator Down - regulates Vccp		
	voltage for a CPU		

11.0 Recommended Implementation 查询"LM94"供应商



Recommended implementation without thermal diode connections



Note: 100 pF cap across each thermal diode is optional and should be placed close to the LM94, if used. The maximum capacitance between thermal diode pins is 300 pF.

Thermal diode recommended implementation

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12.0 Functional Description 词"LM94"供应码 The LM94 provides to channels of voltage monitoring, 4 remote thermal diode monitors, an internal/local ambient temperature sensor, 2 PROCHOT monitors, 4 fan tachometers. 8 GPIOs, THERMTRIP monitor for masking error events, 2 sets of 7 VID inputs, an ALERT output and all the associated limit registers on a single chip, and communicates to the rest of the baseboard over the System Management Bus (SM-Bus). The LM94 also provides 2 PWM outputs and associated fan control logic for controlling the speed of system fans. There are two sets of fan control logic, a lookup table and a PI (proportional/integral) loop controller. The lookup table and PI controller are interactive, such that the fans run at the fastest required speed. Upon a temperature or fan tach error event, the PWM outputs may be programmed such that they automatically boost to 100% duty cycle. A timer is included that sets the minimum time that the fans are in the boost condition when activated by a fan tach error.

The LM94 incorporates National Semiconductor's TruTherm technology for precision "Remote Diode" readings of processors on 90nm process geometry or smaller. Readings from the external thermal diodes and the internal temperature sensor are made available as an 9-bit two's-complement digital value with the LSb representing 0.5°C. Filtered temperature readings are available as a 12-bit two's-complement digital value with the LSb representing 0.0625°C.

All but 4 of the analog inputs include internal scaling resistors. External scaling resistors are required for measuring ±12V. The inputs are converted to 8-bit digital values such that a nominal voltage appears at 34 scale for positive voltages and 1/4 scale for negative voltages. The analog inputs are intended to be connected to both baseboard resident VRDs and to standard voltage rails supplied by a SSI compliant power supply.

The LM94 has logic that ties a set of dynamically moving VID inputs to their associated Vccp analog input for real time window comparison fault determination. Voltage mapping for VRD10, VRD10 extended and VRD11are supported by the LM94. When VRD10 mode is selected GPI8 and GPI9 can be used to detect external error flags whose state is be reflected in the status registers.

Error events are captured in two sets of mirrored status registers (BMC Error Status Registers and Host Status Registers) allowing two controllers access to the status information without any interference.

The LM94's ALERT output supports interrupt mode or comparator mode of operation. The comparator mode is only functional for thermal monitoring.

The LM94 provides a number of internal registers, which are detailed in the register section of this document.

12.1 MONITORING CYCLE TIME

When the LM94 is powered up, it cycles through each temperature measurement followed by the analog voltages in sequence, and it continuously loops through the sequence. The total monitoring cycle time is not more than 100 ms, as this is the time period that most external micro-controllers require to read the register values.

Each measured value is compared to values stored in the limit registers. When the measured value violates the programmed limit, a corresponding status bit in the B_Error and H_Error Status Registers is set.

The PROCHOT, tachometer and dynamic VID/Vccp monitoring is performed independently of the analog and temperature monitoring cycle.

12.2 ΣΔ A/D INHERENT AVERAGING

The $\Sigma\Delta$ A/D architecture filters the input signal. During one conversion many samples are taken of the input voltage and these samples are effectively averaged to give the final result. The output of the $\Sigma\Delta$ A/D is the average value of the signal during the sampling interval. For a voltage measurement, the samples are accumulated for 1.5 ms. For a temperature measurement, the samples are accumulated for 8.4 ms.

12.3 TEMPERATURE MONITORING

The LM94 remote diode target is the embedded thermal diode found in a Xeon class processor in 90nm processes but can also work with any Intel based processor in 90nm or 65nm. The LM94 has an advanced thermal diode input stage using National's TruTherm technology that reduces the spread in ideality found in sub-micron geometry thermal diodes. Internal analog filtering has been included in the thermal diode input stage thus minimizing the need for external thermal diode filter capacitors. In addition a digital filter has been included for the thermal diode temperature readings.

In some cases instead of using the embedded thermal diode, found on the Xeon processor, a diode connected 2N3904 transistor type can also be used. An example of this would be a MMBT3904 with its collector and base tied to the thermal diode REMOTE+ pin and the emitter tied to the thermal diode REMOTE- pin. Since the MMBT3904 is a surface mount device and has very small thermal mass, it measures the board temperature where it is mounted. The ideality and series resistance varies for different diodes. Therefore the LM94 has register support to allow calibration selection between a 2N3904 or a Xeon processor. The LM94 is optimized for typical Intel processors on 90nm or 65nm process or 2N3904 transistor. Other transistor types may used but may have additional error that can be can be corrected for by programming the appropriate Zone Adjustment Offset register.

The LM94 acquires temperature data from four different sources:

- 4 external diodes (embedded in a processor or discrete)
- 1 internal diode (internal to the LM94)
- 2 analog temperature sensors, such as the LM60, that are connected to the AD_IN11 or AD_15 pins
- a temperature value can be externally written into an LM94 register from the SMBus.

All of these values, although not necessarily simultaneously, can be used to control fans, compared against limits, etc.

The temperature value registers are located at addresses 06h-09h, 50h-55h and 10h-23h. The temperature sources are referred to as "zones" for convenience:

Zone	Description		
Zone a le			
	(REMOTE1a+, REMOTE1-)		
Zone 1b	Processor 1 remote diode 2		
	(REMOTE1b+, REMOTE1-)		
Zone 2a	Processor 2 remote diode 1		
	(REMOTE2a+, REMOTE2-)		
Zone 2b	Processor 2 remote diode 2		
	(REMOTE2b+, REMOTE2-)		
Zone 3	Internal LM94 on-chip sensor or external LM60		
	analog sensor connected to AD_IN11; also		
	accepts writes via SMBus		
Zone 4	External digital temperature value from SMBus		
	write to register 53h or external LM60 analog		
	sensor connected to AD_IN15		

12.3.1 "Remote Diode" TruTherm Mode

The processor "remote thermal diode" is more correctly described as a transistor. The LM93 treated the "remote diode" as a diode thus introducing inaccuracies. These inaccuracies have become more apparent as the geometry of processors is shrinking. The LM94 can sense the "remote diode" using a new TruTherm technology that treats the remote device as a transistor. The TruTherm Mode is more accurate for processors on 90nm and smaller geometry. The LM94 still supports the old diode method and is callibrated for 2N3904 transistor type.

12.3.2 Temperature Data Format

Most of the temperature data for the LM94 is represented in three formats:

 8-bit, two's complement byte with the LSb equal to 1.0 °C; this applies to temperature measurements as well as any temperature limit registers and some configuration registers.

Temperature	Binary	Hex
+125°C	0111 1101	7Dh
+25°C	0001 1001	19h
+1.0°C	0000 0001	01h
0°C	0000 0000	00h
−1.0°C	1111 1111	FFh
−25°C	1110 0111	E7h
−55°C	1100 1001	C9h
−127°C	1000 0001	81h

Note: A value of 80h has a special meaning in the limit registers. It means that the temperature channel is masked. In addition, temperature readings of 80h indicate thermal diode faults.

 9-bit two's complement word with the LSb equal to 0.5°C; this applies to unfiltered temperature measurement extended resolution value registers

Temperature	Binary		Hex
	MSB	LSB	
+125.5°C	0111 1101	1000 0000	7D 80h
+25.5°C	0001 1001	1000 0000	19 80h
+0.5°C	0000 0000	1000 0000	00 80h
0°C	0000 0000	0000 0000	00 00h
−0.5°C	1111 1111	1000 0000	FF 80h

Temperature	Binary		Hex
	MSB	LSB	
−25.5°C	1110 0111	1000 0000	E7 80h
−55.5°C	1100 1001	1000 0000	C9 80h
−127.5°C	1000 0001	1000 0000	81 80h

 12-bit two's complement word with the LSb equal to 0.0625°C; this applies to extended filtered temperature measurement extended resolution value registers

Temperature	Binary		Hex
	MSB	LSB	
+125.0625°C	0111 1101	0001 0000	7D 10h
+25.0625°C	0001 1001	0001 0000	19 10h
+1.0625°C	0000 0001	0001 0000	01 10h
0°C	0000 0000	0000 0000	00 00h
-0.0625°C	1111 1111	1111 0000	FF F0h
-25.0625°C	1110 0111	1111 0000	E7 F0h
-55.0625°C	1100 1001	1111 0000	C9 F0h
-127.0625°C	1000 0000	1111 0000	80 F0h

Some fan control configuration registers use four bits and have an unsigned binary format, please see the fan control configuration register descriptions for further details on this 4-bit format.

12.3.3 Thermal Diode Fault Status

The LM94 provides for indications of a fault (open or short circuit) with the remote thermal diodes. Before a remote diode conversion is updated, the status of the remote diode is checked for an open or short circuit condition. If such a fault condition occurs, a status bit is set in the status register. A short circuit is defined as the diode pins connected to each other. When an open or short circuit is detected, the corresponding temperature register is set to 80h.

12.4 EVENT ERRORS FOR FAN BOOST

Temperature boost error and tachometer error events can cause the fan control PWM output(s) to go to full on. A boost temperature error event will cause both PWM outputs to go to full on, while a tachometer event can be either bound to PWM1 or PWM2.

A fan boost temperature event occurs if any of the four temperature zones exceeds the temperature Fan Boost Limit for that zone. Once a temperature has exceed the boost limit, it must drop to a value equal to the boost limit minus the boost hysteresis before the boost condition is deactivated. The default setting for Zones 1 and 2 is 60°C and for Zones 3 and 4 it is 35°C.

The tachometer error boost function is enabled via the Tachometer Fan Boost Control register. Depending on the setting of the tachometer to PWM binding bits one or both of the PWM outputs will go to 100% duty cycle upon the detection of an unmasked Fan Tachometer Error Event. A Fan Tachometer Error event occurs when a tachometer reading exceeds the value set in it's FAN Tach Limit register. Once the error event ends the PWM output(s) will remain at 100% duty cycled for a time interval, Tach Boost Timeout, as programmed in the Tachometer Fan Boost Control register. If the tachometer error event returns during the middle of the timout interval the Tach Boost Timeout interval will be reset and restart once the error event ends.

12.5 VOLTAGE MONITORING

itie LNP3-code in the correct value refers to approximately 3/4 scale or 192 decimal on all inputs, except the ±12V. Scaling is accomplished by using internal resistor dividers, except for the ±12V. The typical input resistance of these inputs is 200 k ohms. Input voltages are converted by an 8-bit Delta-Sigma (ΔΣ) A/D. The Delta-Sigma A/D architecture provides inherent filtering and spike smoothing of the analog input signal.

The ±12V inputs must be scaled externally. A full scale reading is achieved when 1.236V is applied to these inputs. For optimum performance the +12V should be scaled to provide a nominal ¾ full scale reading, while the -12V should be

scaled to provide a nominal $^{1}\!\!/$ scale reading. The thevenin resistance at the pin should be kept between 1 k Ω and 7 k Ω . The –12V monitoring is particularly challenging. It is required that an external offset voltage and external resistors be used to bring the –12V rail into the positive input voltage region of the A/D input. It is suggested that the supply rail for the LM94 device be used as the offset voltage. This voltage is usually derived from the P/S 5V stand-by voltage rail via a ±1% accurate linear regulator. In this fashion we can always assume that the offset voltage is present when the –12V rail is present as the system cannot be turned on without the 3.3V stand-by voltage being present.

Voltage vs Register Reading

Pin	Normal Use	Nominal Voltage	Register Reading at Nominal Voltage	Maximum Voltage	Register Reading at Maximum Voltage	Minimum Voltage	Register Reading at Minimum Voltage	Absolute Maximum Range
AD_IN1	+12V1	0.927V	C0h	1.236V	FFh	0V	00h	$-0.3V$ to $(V_{DD} + 0.05V)$
AD_IN2	+12V2	0.927V	C0h	1.236V	FFh	0V	00h	$-0.3V$ to $(V_{DD} + 0.05V)$
AD_IN3	+12V3	0.927V	C0h	1.236V	FFh	0V	00h	-0.3V to (V _{DD} + 0.05V)
AD_IN4	FSB_Vtt	1.20V	C0h	1.60V	FFh	0V	00h	-0.3V to +6.0V
AD_IN5	3GIO	1.5V	C0h	2V	FFh	0V	00h	-0.3V to +6.0V
AD_IN6	ICH_Core	1.5V	C0h	2V	FFh	0V	00h	-0.3V to +6.0V
AD_IN7	Vccp1	1.20V	C0h	1.60V	FFh	0V	00h	-0.3V to +6.0V
AD_IN8	Vccp2	1.20V	C0h	1.60V	FFh	0V	00h	-0.3V to +6.0V
AD_IN9	+3.3V	3.30V	C0h	4.40V	FFh	0V	00h	-0.3V to +6.0V
AD_IN10	+5V	5.0V	C0h	6.667V	FAh	0V	00h	-0.3V to +6.5V
AD_IN11	SCSI_Core	2.5V	C0h	3.333V	FFh	0V	00h	-0.3V to +6.0V
AD_IN12	Mem_Core	1.969V	C0h	2.625V	FFh	0V	00h	-0.3V to +6.0V
AD_IN13	Mem_Vtt	0.984V	C0h	1.312V	FFh	0V	00h	-0.3V to +6.0V
AD_IN14	Gbit_Core	0.984V	C0h	1.312V	FFh	0V	00h	-0.3V to +6.0V
AD_IN15	-12V	0.309V	40h	1.236V	FFh	0V	00h	$-0.3V$ to $(V_{DD} + 0.05V)$
AD_IN16	+3.3V S/B	3.3V	C0h	3.6V	D1h	3.0V	AEh	-0.3V to +6.0V

The nominal voltages listed in this table are only typical values. Voltage rails with different nominal voltages can be monitored, but the register reading at the nominal value is no longer C0h. For example, a Mem_Core rail at 2.5V nominal could be monitored with AD_IN12, or a Mem_Vtt rail at 1.2V could be monitored with AD_IN13.

AD_IN16 is also the power pin of the LM94, therefore special limitations apply to this AD input. The guaranteed operational voltage range for the LM94 is 3.0V to 3.6V, therefore the voltage input to this pin is limited by this restriction. Care should also be taken not to apply more than 6V to this pin to prevent catastrophic damage.

12.6 RECOMMENDED EXTERNAL SCALING RESISTORS FOR + 查省例科科斯拉商

The +12V inputs require external scaling resistors. The resistors need to scale 12V down to 0.927V.

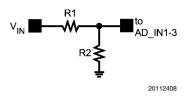


FIGURE 1. Required External Scaling Resistors for +12V Power Input

To calculate the required ratio of R1 to R2 use this equation:

It is recommended that the equivalent thevenin resistance of the divider be between 1k and 7k to minimize errors caused by leakage currents at extreme temperatures. The best values for the resistors are: R1=13.7 k Ω and R2=1.15 k Ω . This yields a ratio of 11.94498, which has a +0.27% deviation from the theoretical. It is also recommended that the resistors have $\pm 1\%$ tolerance or better.

Each LSB in the voltage value registers has a weight of 12V / 192 = 62.5 mV. To calculate the actual voltage of the +12V power input, use the following equation:

$$V_{IN} = (8-bit value register code) x (62.5 mV)$$
 (2)

12.7 RECOMMENDED EXTERNAL SCALING CIRCUIT FOR -12V POWER INPUT

The -12V input requires external resistors to level shift the nominal input voltage of -12V to +0.309V.

FIGURE 2. Required External Level Shifting Resistors for –12V Power Input

The $\pm 3.3V$ standby voltage is used as a reference for the level shifting. Therefore, the tolerance of this voltage directly effects the accuracy of the -12V reading. To minimize ratio errors, a tolerance of better than $\pm 1\%$ should be used. It is recommended that the equivalent thevenin resistance of the divider is between 1k and 7k to minimize errors caused by leakage currents at extreme temperatures. To calculate the ratio of R1 to R2 use this equation:

$$\frac{R1}{R2} = \frac{(V_{IN} - V_{REF})}{(AD_{IN} - V_{REF})} - 1$$
(3)

where V_{IN} is the nominal input voltage of –12V, V_{REF} is the reference voltage of +3.3V and AD_IN is the voltage required at the AD input for a $\frac{1}{4}$ scale reading or 0.309V.

Therefore, for this case:

$$\frac{R1}{R2} = \frac{(-12 - 3.3)}{(0.309 - 3.3)} - 1 = 4.11535$$
(4)

Using standard 1% resistor values for R1 of 5.76 k Ω and R2 of 1.4 k Ω yields an R1 to R2 ratio of 4.1143.

The input voltage $\rm V_{\rm IN}$ can be calculated using the value register reading (VR) using this equation:

$$V_{IN} = (\frac{R1}{R2} + 1) \times [(1.236V \times \frac{VR}{256}) - 3.3V] + 3.3V$$

= (24.69 mV x VR) - 13.5771V (5)

The table below summarizes the theoretical voltage values for value register readings near –12V.

Value Register	V _{IN}	% ∆ from –12V
15	-13.2068	-10.0563
16	-13.1821	-9.8505
17	-13.1574	-9.6448
18	-13.1327	-9.4390
19	-13.1080	-9.2332
20	-13.0833	-9.0275
21	-13.0586	-8.8217
22	-13.0339	-8.6159
23	-13.0092	-8.4101
24	-12.9845	-8.2044
25	-12.9598	-7.9986
26	-12.9351	-7.7928
27	-12.9104	-7.5871
28	-12.8858	-7.3813
29	-12.8611	-7.1755
30	-12.8364	-6.9698
31	-12.8117	-6.7640
32	-12.7870	-6.5582
33	-12.7623	-6.3524
34	-12.7376	-6.1467
35	-12.7129	-5.9409
36	-12.6882	-5.7351
37	-12.6635	-5.5294
38	-12.6388	-5.3236
39	-12.6141	-5.1178

	Value Register	, V _{IN}	% ∆ from –12V
查	洵"LM94"供应ī	-12.5894	-4.9121
	41	-12.5648	-4.7063
	42	-12.5401	-4.5005
	43	-12.5154	-4.2947
	44	-12.4907	-4.0890
	45	-12.4660	-3.8832
	46	-12.4413	-3.6774
	47	-12.4166	-3.4717
	48	-12.3919	-3.2659
	49	-12.3672	-3.0601
	50	-12.3425	-2.8544
	51	-12.3178	-2.6486
	52	-12.2931	-2.4428
	53	-12.2684	-2.2370
	54	-12.2438	-2.0313
	55	-12.2438	-1.8255
	56	-12.191	-1.6197
	57	-12.1944	-1.4140
	58	-12.1450	
	59	-12.1203	-1.2082 -1.0024
	60	-12.0956	-0.7967
	61	-12.0936	-0.5909
	62		
	63	-12.0462 -12.0215	-0.3851
	64		-0.1793 0.0264
	65	-11.9968 -11.9721	0.0264
		-11.9474	
	66		0.4380 0.6437
	68	-11.9228	
	69	-11.8981	0.8495
	70	-11.8734 -11.8487	1.0553 1.2610
	70	-11.8240	1.4668
	71	-11.7993	
			1.6726
	73 74	-11.7746 -11.7499	1.8784 2.0841
	75	-11.7252	
			2.2899
	76	-11.7005 -11.6758	2.4957
	77		2.7014
	78 79	-11.6511 -11.6264	3.1130
	80	-11.6018 -11.5771	3.3188
	81		3.5245
	82	-11.5524	3.7303
	83	-11.5277	3.9361
	84	-11.5030	4.1418
	85	-11.4783	4.3476
	86	-11.4536	4.5534
	87	-11.4289	4.7591
	88	-11.4042	4.9649
	89	-11.3795	5.1707

Value Register	V _{IN}	% ∆ from –12V
90	-11.3548	5.3765
91	-11.3301	5.5822
92	-11.3054	5.7880
93	-11.2807	5.9938
94	-11.2561	6.1995
95	-11.2314	6.4053
96	-11.2067	6.6111
97	-11.1820	6.8168
98	-11.1573	7.0226
99	-11.1326	7.2284
100	-11.1079	7.4342
101	-11.0832	7.6399
102	-11.0585	7.8457
103	-11.0338	8.0515
104	-11.0091	8.2572
105	-10.9844	8.4630
106	-10.9597	8.6688
107	-10.9351	8.8745
108	-10.9104	9.0803
109	-10.8857	9.2861
110	-10.8610	9.4919
111	-10.8363	9.6976
112	-10.8116	9.9034
113	-10.7869	10.1092

12.8 ADDING EXTERNAL SCALING RESISTORS TO OTHER ANALOG INPUTS

All analog inputs, except AD_IN1 through AD_IN3 and AD_IN15, include internal resistor dividers. Further scaling of AD_IN4 through AD_IN14 inputs with external scaling resistors is possible if the errors due to the internal dividers are accounted. The internal resistors, $R_{\rm IN}1+R_{\rm IN}2$ shown in *Figure 3*, will present to the external divider a minimum resistive load of 140 $k\Omega$.

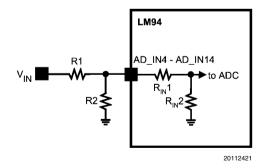


FIGURE 3. AD_IN4 - AD_IN14 External Resistor Divider

12.9 DYNAMIC Vccp MONITORING USING VID

The AD_IN7 (CPU1 Vccp) and AD_IN8 (CPU2 Vccp) inputs are dynamically monitored using the P1_VIDx and P2_VIDx inputs to determine the limits. The dynamic comparisons operate independently of the static comparisons which use the statically programmed limits. The LM94 supports 3 different specifications for the Voltage Regulator (VRM or VRD) used on motherboards with Intel CPUs with four different VID

Modes of operation. The Voltage Regulator Specifications supported and VRD11.7 PM 10, VRD10.2 Extended and VRD11.7 PM 11, and in this document they will be referred to as the VRD10, VRD10.2 and VRD11 specifications, respectively.

According to the VRD 10 specification when a VID signal is ramping to a new value, it steps by one LSB at a time, and one step occurs every 5 µs. In worse case, up to 20 steps may occur at once over 100 µs. The Vccp voltage from the VRD has to settle to the new value within 50 µs of the last VID change. The LM94 expects that the VID changes will not occur more frequently than every 5 µs in the VRD10 mode. Similarly the LM94 can support the timing requirements of the VRD10.2 and VRD11 specifications.

The VID signals can be changed by the processor under program control, by internal thermal events or by external control, like force PROCHOT.

The reference voltages selected by each value of the VID code can be found in the different VRM/VRD specifications. Transient VID values caused by line-to-line skew are ignored by the LM94. See the VRM/VRD specifications for the worst case line-to-line skew.

The LM94 averages the VID values over a sampling window to determine the average voltage that the VID input was indicating during the sampling window. At the completion of a voltage conversion cycle the LM94 performs limit comparisons based on average VID values and not instantaneous values. The upper limit is determined by adding the upper limit offset to the average voltage indicated by VID. The lower limit is determined by subtracting the lower limit offset from average voltage indicated by VID. If the AD_IN7 (or AD_IN8) voltage falls outside the upper and lower limits, an error event is generated. Dynamic and static comparisons are performed once every 100 ms. The averaging time interval is 1.5 ms.

If at any time during the Vccp sampling window, the VID code indicates that the VRD/VRM should turn off its output, the dynamic Vccp checking is disabled for that sample.

The comparison accuracy is ± 25 mV, therefore the comparison limits must be set to include this error. Since the Vccp voltage may be in the process of settling to a new value (due to a VID change), this settling should be taken into account when setting the upper and lower limit offsets.

The LM94 has a limitation on the upper limit voltage for dynamic Vccp checking. The upper limit cannot exceed 1.5875V. If the sum of the voltage indicated by VID and the upper offset voltage exceed 1.5875, the upper limit checking is disabled.

Pins 11 and 12 have dual purpose. When VRD10 mode is selected they can be used as general purpose inputs whose state is reflected the BMC and Host Error Status registers. In the other VRD modes they are used as a VID6 input.

12.10 MONITORING ANALOG TEMPERATURE SENSORS

AD_IN11 and AD_IN15 readings can be routed to the fan control logic to facilitate the use of external temperature sensors such as the LM60. When these inputs are used for temperature sensing the digital output returned is in signed format, that is the MSb is inverted.

The following table lists critical parameters necessary for converting the binary data to temperature.

Input	V NOM	Full Scale (code 256) V	254.5 code V	mV /LSb	LM60 deg /LSb	LM50 deg /LSb
AD_	2.500	3.3333	3.3138	13.0	2.0833	1.3021
IN11	(¾ scale)					
AD_	0.309	1.2360	1.2288	4.8	0.7725	0.4828
IN15	(¼ scale)					

The following table lists the equations to use for converting the AD_IN11 or AD_IN15 Digital Value (DV) to a temperature value.

Input	LM60 Equation	LM50 Equation	
AD_IN11	(DV + 95.44) × 2.0833	(DV + 89.60) × 1.3021	
AD_IN15	(DV + 40.18) × 0.7725	(DV + 24.44) × 0.4828	

The following table lists the ideal values generated when using the LM60 at different temperatures.

Temp LM60		AD IN11	Reading	AD IN15	Reading
	Ideal	Signed	Signed	Signed	Signed
	Vout	Decimal	Hex	Decimal	Hex
0	0.424	-95.44	A1	-40.18	D8
25	0.5803	-83	AD	-8	F8
30	0.6115	-81	AF	-1	FF
35	0.6428	-79	B1	5	5
40	0.6740	-76	B4	12	С
45	0.7053	-74	B6	18	12
50	0.7365	-71	B9	25	19
55	0.7678	-69	ВВ	31	1F
60	0.7990	-67	BD	37	25
65	0.8303	-64	C0	44	2C
70	0.8615	-62	C2	50	32
75	0.8928	-59	C5	57	39
80	0.9240	-57	C7	63	3F
85	0.9553	-55	C9	70	46
90	0.9865	-52	CC	76	4C
95	1.0178	-50	CE	83	53
100	1.0490	-47	D1	89	59
105	1.0803	-45	D3	96	60
110	1.1115	-43	D5	102	66
115	1.1428	-40	D8	109	6D
120	1.1740	-38	DA	115	73
125	1.2053	-35	DD	122	7A
130	1.2365	-33	DF	127	7F

The following table lists the expected ideal digital values when

Temp	LM50	AD_IN11	Reading	AD_IN15	Reading
	Ideal Vout	Signed Decimal	Signed Hex	Signed Decimal	Signed Hex
0	0.5	-89.60	A7	-24.44	E8
25	0.7500	-70	ВА	27	1B
30	0.8000	-67	BD	38	26
35	0.8500	-63	C1	48	30
40	0.9000	-59	C5	58	ЗА
45	0.9500	-55	C9	69	45
50	1.0000	-51	CD	79	4F
55	1.0500	-47	D1	89	59
60	1.1000	-44	D4	100	64
65	1.1500	-40	D8	110	6E
70	1.2000	-36	DC	121	79
75	1.2500	-32	E0	127	7F
80	1.3000	-28	E4	127	7F
85	1.3500	-24	E8	127	7F
90	1.4000	-20	EC	127	7F
95	1.4500	-17	EF	127	7F
100	1.5000	-13	F3	127	7F
105	1.5500	-9	F7	127	7F
110	1.6000	-5	FB	127	7F
115	1.6500	-1	FF	127	7F
120	1.7000	3	3	127	7F
125	1.7500	6	6	127	7F
130	1.8000	10	Α	127	7F

12.11 V_{REF} OUTPUT

 V_{REF} is a fixed voltage to be used by an external VRD or as a voltage reference input for the BMC A/D inputs. V_{REF} is 2.5V $\pm 1\%$. There is internal current limit protection for the V_{REF} output in case it gets shorted to supply or ground accidentally.

12.12 PROCHOT BACKGROUND INFORMATION

PROCHOT is an output from a processor that indicates that the processor has reached a predetermined temperature trip point. At this trip point the processor can be programmed to lower its internal operating frequency and/or lower its supply voltage by changing the value of the 6 bit VID that it supplies to the VRD. The final VID setting and the rate at which it transitions to the new VID is programmable within the processor. If PROCHOT is 100% throttled, it does not mean that the CPU is not executing, but it may mean that the CPU is about to encounter a thermal trip if the processor temperature continues to rise.

PROCHOT is also an input to some processors so that an external controller can force a thermal throttle based on external events.

PROCHOT is no longer asserted by the processor when the temperature drops below the predefined thermal trip point.

Oscillation around the trip point is avoided by the processor by requiring that the temperature be above/below the trip point for a predetermined period of time. A counter inside the processor is used to track this time and it has to be incremented to a max count for an above temperature trip and decremented to zero when below the trip temperature setting, to remove the trip.

The minimum time for $\overline{PROCHOT}$ assertion is time dependant on the FSB frequency. The minimum time that the processor asserts $\overline{PROCHOT}$ is estimated to be 187 µs.

12.13 PROCHOT MONITORING

PROCHOT monitoring applies to both the P1_PROCHOT and P2_PROCHOT inputs. Both inputs are monitored in the same fashion, but the following description discusses a single monitor. (Px_PROCHOT represents both P1_PROCHOT and P2_PROCHOT).

PROCHOT monitoring is meant to achieve two goals. One goal is to measure the percentage of time that PROCHOT is asserted over a programmable time period. The result of this measurement can be read from an 8-bit register where one LSB equals 1/256th of the PROCHOT Time Interval (0.39%). The second goal is to have a status register that indicates, as a coarse percentage, the amount of time a processor has been throttled. This second goal is required in order to communicate information over the NIC using ASF, i.e. status can be sent, not values.

To achieve the first goal, the PROCHOT input is monitored over a period of time as defined by the PROCHOT Time Interval Register. At the end of each time period, the 8-bit measurement is transferred to the Current Px_PROCHOT register. Also at the end of each measurement period, the Current Px_PROCHOT register value is moved to the Average Px_PROCHOT register by adding the new value to the old value and dividing the result by 2. Note that the value that is averaged into the Average Px_PROCHOT register is not the new measurement but rather the previous measurement. If the SMBus writes to the Current P1_PROCHOT (or Current P2_PROCHOT) register, the capture cycle restarts for both monitoring channels (P1_PROCHOT and P2_PROCHOT). Also note, that a strict average of two 8-bit values may result in Average Px PROCHOT reflecting a value that is one LSB lower than the Current Px_PROCHOT in steady state.

It should be noted that the 8-bit result has a positive bias of one half of an LSB. This is necessary because a value of 00h represents that Px_PROCHOT was not asserted at all during the sampling window. Any amount of throttling results in a reading of 01h.

The following table demonstrates the mapping for the 8-bit result:

8-Bit Result	Percentage Thottled
0	Exactly 0%
1	Between 0% and 0.39%
2	Between 0.39% and 0.78%
-	-
n	Between (n-1)/256 and n/256
-	-
253	Between 98.4% and 98.8%
254	Between 98.8% and 99.2%
255	Greater than 99.2%

To achieve the second goal, the LM94 has several comparators that compare the measured percentage reading against several fixed and 1 variable value. The variable value is user programmable.

The result of these comparisons generates several error status bits described in the following table:

Status Description	Comparison Formula
100% <u></u> 	朝ROCHOT was never de- asserted during monitoring interval.
Greater than or equal to 75% and less than 100%	193 ≤ measured value and not 100%
Greater than or equal to 50% and less than 75%	129 ≤ measured value < 193
Greater than or equal to 25% and less than 50%	65 ≤ measured value < 129
Greater than or equal to 12.5% and less than 25%	33 ≤ measured value < 65
Greater than 0% and less than 12.5%	0 < measured value < 33
Greater than 0%	0 < measured value
Greater than user limit	user limit < measured value

These status bits are reflected in the $\overline{\text{PROCHOT}}$ Error Status Registers. Each of the $\overline{\text{P1_PROCHOT}}$ and $\overline{\text{P2_PROCHOT}}$ inputs is monitored independently, and each has its own set of status registers.

In S3 and S4/5 sleep states, the PROCHOT Monitoring function does not run. VRDx_Hot is disabled from activating PROCHOT pins in S3 and S4/5. The Current Px_PROCHOT registers are reset to 00h and the Average Px_PROCHOT registers hold their current state. Once the sleep state changes back to S0, the monitoring function is restarted. After the first PROCHOT measurement has been made, the measurement is written directly into the Current and Average Px_PROCHOT registers without performing any averaging. Averaging returns to normal on the second measurement.

12.14 PROCHOT OUTPUT CONTROL

In some cases, it is necessary for the LM94 to drive the Px_PROCHOT outputs low. There are several conditions that cause this to happen.

The LM94 can be told to logically short the two $\overline{PROCHOT}$ inputs together. When this is done, the LM94 monitors each of the $\overline{Px_PROCHOT}$ inputs. If any external device asserts one of the $\overline{PROCHOT}$ signals, the LM94 responds by asserting the other $\overline{PROCHOT}$ signal until the first $\overline{PROCHOT}$ signal is de-asserted. This feature should never be enabled if the $\overline{PROCHOT}$ signals are already being shorted by another means

Whenever one of the VRDx_HOT inputs is asserted, the corresponding Px_PROCHOT pins are asserted by the LM94. The response time is less than 10 µs. When the VRDx_HOT input is de-asserted, the Px_PROCHOT pin is no longer asserted by the LM94. If the LM94 is configured to short the PROCHOT signals together, it always asserts them together whenever either of the VRDx_HOT inputs is asserted. This response is disabled in sleep states 3 and 4/5 and can be disabled through the PROCHOT Control register.

Software can manually program the LM94 to drive a PWM type signal onto P1_PROCHOT or P2_PROCHOT. This is done via the PROCHOT Override register. See the description of this register for more details. Once again, if the LM94 is configured to short the PROCHOT signals together, it always asserts them together whenever this function is enabled.

12.15 FAN SPEED MEASUREMENT

The fan tach circuitry measures the period of the fan pulses by enabling a counter for two periods of the fan tach signal. The accumulated count is proportional to the fan tach period and inversely proportional to the fan speed. All four fan tach signals are measured within 1 second.

Fans in general do not over-speed if run from the correct voltage, so the failure condition of interest is under speed due to electrical or mechanical failure. For this reason only low-speed limits are programmed into the limit registers for the fans. It should be noted that, since fan period rather than speed is being measured, a fan tach error event occurs when the measurement *exceeds* the limit value.

12.16 SMART FAN SPEED MEASUREMENT

If a fan's speed is varied using PWM drive of either of the fans power pins, the tachometer output of the fan is corrupted. The LM94 includes smart tachometer circuitry that allows an accurate tachometer reading to be achieved despite the signal corruption. In smart tach mode all four signals are measured within 4 seconds.

A smart tach capture cycle works according to the following steps:

- Both PWM outputs are synchronized such that they activate simultaneously.
- Both PWM output active times are extended for up to 50 ms.
- The number of tach signal periods during the 50 ms interval are tracked:
- a) If less than 1 period is sensed during the 50 ms extension the result returned is 3FFh.
- After one period occurs the count for that period is memorized.
- If during the 50 ms interval 2 periods do not occur, the tach value reported is the 1 period count multiplied by 2.
- d) If 2 periods do occur, the 2 period count is loaded into the value register and the 50 ms PWM extension is terminated.

The lowest two bits in each of the Fan Tach value registers are reserved. The smart tach feature takes advantage of these bits. In normal tach mode, these bits return 00. In smart tach mode the two bits determine the accuracy level of the reading. 11 is most accurate (2 periods used) and 10 is the least accurate (1 period used). If less than 1 period occurred during the measurement cycle, the lower two bits are set to 10.

In smart fan tach mode, the TACH_EDGE field is honored in the LM94 Status/Control register. If only one edge type is active, the measurement always uses that edge type (rising or falling). If both are active, the measurement uses whichever edge type occurs first.

Typically the minimum RPM captured by smart fan tach mode is 900 RPM for a fan that produces two pulses per revolution at about 50% duty cycle.

13.0 Inputs/Outputs

Besides all the pins associated with sensor inputs the LM94 has several pins that are assigned for other specific functions.

13.1 ALERT OUTPUT

The ALERT output is an active-low open drain output signal. The ALERT output is used to signal a micro-controller that one or more sensors have crossed their corresponding limit

thresholds. This is generally not a fatal event unless the mi-

If enabled, the ALERT output is asserted whenever any bit in any BMC Error Status register is set (with the exception of the fixed PROCHOT threshold bits). By definition, when ALERT is enabled, it always matches the inverse of the BMC_ERR bit in the LM94 Status/Control register. When the ALERT output is disabled, an alert event can still be determined by reading the state of the BMC ERR bit.

The ALERT functions like an interrupt. The LM94 does not support the SMBus ARA (Alert Response Address) protocol. ALERT is only de-asserted when there are no error status bits set in any BMC Error Status registers. Alternatively, software can disable the ALERT output to cause it to de-assert. The ALERT output re-asserts once enabled if any BMC Error Status register bits are still set.

The ALERT output also functions in comparator mode for thermal events, that is the ALERT output will be asserted for unmasked thermal error events and will de-assert immediately when the error event ceases. The operation of the ALERT output is controlled by the LM94 Configuration register.

Further information on how the ALERT output behaves can be found in *Section 15.7 MASKING, ERROR STATUS AND ALERT.*

13.2 RESET INPUT/OUTPUT

This pin acts as an active low reset output when power is applied to the LM94. It is asserted when the LM94 first sees a voltage that exceeds the internal POR level on its +3.3V S/B V_{DD} input. The internal registers of the LM94 are reset to their defaults when power is applied.

After this reset has completed, the RESET pin becomes an input. When an external device asserts RESET, the LM94 clears the LOCK bit in the LM94 Configuration register. This feature allows critical registers to be locked and provides a controlled mechanism to unlock them.

If the LM94 RESET is not used it must be tied high through an external resistive pull-up to prevent LM94 malfunction.

Within 10 µsec of asserting $\overline{\text{RESET}}$ externally, the Sleep State Control register shall be automatically set to S4/5. This causes several error events to be masked according to the S4/5 masking definitions. Refer to the register descriptions for more information. $\overline{\text{RESET}}$ may not be detected if it is asserted for less than 4 µsec.

13.3 PWM1 AND PWM2 OUTPUTS

The PWM outputs are used to control the speed of fans. The duty cycle of each output is automatically controlled by the temperature of one or more temperature zones. They are also influenced by various other inputs and registers. See Section 15.10 FAN CONTROL for further information on the behavior of the PWM outputs.

13.4 VRD1_HOT AND VRD2_HOT INPUTS

These inputs monitor the thermal sensor associated with each processor VRD on a baseboard. When one of the inputs is activated, it indicates that the VRD has exceeded a predetermined temperature threshold. The LM94 responds by gradually increasing the duty cycle of any PWM outputs that are bound to the corresponding processor and setting the appropriate error status bits. The corresponding PROCHOT signal is also asserted. See the Section 15.10 FAN CONTROL and the Section 12.14 PROCHOT OUTPUT CONTROL for more information.

13.5 GPIO and GPI PINS

The LM94 has 8 GPIO pins than can act as either as general purpose inputs or outputs and 2 GPI pins that can act as general purpose inputs. Each can be configured and controlled independently. When acting as an input the pin can be masked to prevent it from setting a corresponding bit in the GPI Error status registers. Some of these pins can also function as tachometer or VID inputs.

13.6 FAN TACH INPUTS

The fan inputs are Schmitt-Trigger digital inputs. Schmitt-Trigger input circuitry is included to accommodate slow rise and fall times typical of fan tachometer outputs.

The maximum input signal range is 0V to +6.0V, even when V_{DD} is less than 5V. In the event that these inputs are supplied from fan outputs, which exceed 0V to +6.0V, either resistive attenuation of the fan signal or diode clamping must be included to keep inputs within an acceptable range, thereby preventing damage to the LM94.

Hot plugging fans can involve spikes on the Tach signals of up to 12V so diode protection or other circuitry is required. For "Hot Plug" fans, external clamp diodes may be required for signal conditioning.

14.0 SMBus Interface

The SMBus is used to communicate with the LM94. LM94 SMBus interface lines are designed to be tolerant to 5V signalling. Necessary pull-ups are located on the baseboard. Care should be taken to ensure that only one pull-up is used for each SMBus signal. The SMBus interface obeys the SMBus 2.0 protocols and signaling levels.

The SMBus interface of the LM94 does not load down the SMBus if no power is applied to the LM94. This allows a module containing the LM94 to be powered down and replaced, if necessary.

14.1 SMBus ADDRESSING

Each time the LM94 is powered up, it latches the assigned SMBus slave address (determined by ADDR_SEL) during the first valid SMBus transaction in which the first five bits of the targeted slave address match those of the LM94 slave address. Once the address has been latched, the LM94 continues to use that address for all future transactions until power is lost.

The address select input detects three different voltage levels and allows for up to 3 devices to exist in a system. The address assignment is as follows:

Address Select Pin (ADDR_SEL)	Slave Address Assignment
High	01011 01
V _{DD} /2	01011 10
Low	01011 00

14.2 DIGITAL NOISE EFFECT ON SMBus COMMUNICATION

Noise coupling into the digital lines (greater than 150mV), overshoot greater than V_{DD} and undershoot less than GND, may prevent successful SMBus communication with the LM94. SMBus No Acknowledge (NACK) is the most common symptom, causing unnecessary traffic on the bus. Although, the SMBus maximum frequency of communication is rather low (100 kHz max), care still needs to be taken to ensure proper termination within a system with multiple parts on the bus and long printed circuit board traces. The LM94 includes

on chip low-pass filtering of the SMBCLK and SMBDAT signals to the state of the summary of the s

14.3 GENERAL SMBus TIMING

The SMBus 2.0 specification defines specific conditions for different types of read and write operations but in general the SMBus protocol operates as follows:

The master initiates data transfer by establishing a START condition, defined as a high to low transition on the serial data line SMBDAT while the serial clock line SMBCLK remains high. This indicates that a data stream follows. All slave peripherals connected to the serial bus respond to the START condition, and shift in the next 8 bits. This consists of a 7-bit slave address (MSB first) plus a R/W bit, which determines the direction of the data transfer, i.e. whether data is written to or read from the slave device (0 = write, 1 = read).

The peripheral whose address corresponds to the transmitted address responds by pulling the data line low during the low period before the ninth clock pulse, known as the Acknowledge Bit, and holding it low during the high period of this clock pulse. All other devices on the bus now remain idle while the selected device waits for data to be read from or written to it. If the R/W bit is a 0 then the master writes to the slave device. If the R/W bit is a 1 the master reads from the slave device.

Data is sent over the serial bus in sequences of 9 clock pulses, 8 bits of data followed by an Acknowledge bit. Data transitions on the data line must occur during the low period of the clock signal and remain stable during the high period, as a low to high transition when the clock is high may be interpreted as a STOP signal.

If the operation is a write operation, the first data byte after the slave address is a command byte. This tells the slave device what to expect next. It may be an instruction, such as telling the slave device to expect a block write, or it may simply be a register address that tells the slave where subsequent data is to be written.

Since data can flow in only one direction as defined by the R/W bit, it is not possible to send a command to a slave device during a read operation. Before doing a read operation, it is necessary to do a write operation to tell the slave what sort of read operation to expect and/or the address from which data is to be read.

When all data bytes have been read or written, stop conditions are established. In WRITE mode, the master will allow the data line to go high during the 10th clock pulse to assert a STOP condition. In READ mode, the slave drives the data not the master. For the bit in question, the slave is looking for an acknowledge and the master doesn't drive low. This is known as 'No Acknowledge'. The master then takes the data line low during the low period before the 10th clock pulse, then high during the 10th clock pulse to assert a STOP condition.

Note, a repeated START may be given only between a write and read operation that are in succession.

14.4 SMBus ERROR SAFETY FEATURES

To provide a more robust SMBus interface, the LM94 incorporates a timeout feature for both SMBCLK and SMBDAT. If either signal is low for a long period of time (see SMBus AC specs), the LM94 SMBus state machine reverts to the idle

state and waits for a START signal. Large block transfers of all zeros should be avoided if the SMBCLK is operating at a very low frequency to avoid accidental timeouts. Pulling the Reset pin low does not reset the SMBus state machine. If the LM94 SMBDAT pin is low during a system reset, the LM94's state machine timeouts and resets automatically. If the LM94's SMBDAT pin is high during a system reset, the first assertion of a start by the master resets the LM94's interface state machine.

Although it is a violation of the SMBus specification, in some cases a START or STOP signal occurs in the middle of a byte transfer instead of coming after an acknowledge bit. If this occurs, only a partial byte was transferred. If a byte was being written, it is aborted and the partial byte is not committed. If a byte was being read from a read-to-clear register, the register is not cleared.

14.5 SERIAL INTERFACE PROTOCOLS

The LM94 contains volatile registers, the registers occupy address locations from 00h to EFh.

Data can be read and written as a single byte, a word, or as a block of several bytes. The LM94 supports the following SMBus/I²C transactions/protocols:

- Send Byte
- Write Byte
- Write Word
- SMBus Write Block
- I²C Block Write
- Read Byte
- Read Word
- SMBus Read Block
- SMBus Block-Write Block-Read Process Call
- I²C Block Read

In addition to these transactions the LM94 supports a few extra items and also has some behavior that must be defined beyond the SMBus 2.0 specification. No other SMBus 2.0 transactions are supported (PEC, ARA etc.).

The SMBus specification defines several protocols for different types of read and write operations. The ones used in the LM94 are discussed below. The following abbreviations are used in the diagrams:

S — START

P — STOP

R — READ

W — WRITE

A — ACKNOWLEDGE

/A — NO ACKNOWLEDGE

14.5.1 Address Incrementing

The established base address does not increment. Repeatedly reading without re-establishing a new base address returns data from the same address each time. I²C read transactions can use this information and skip reestablishing the base address, when only one master is used. One exception to this rule exists when a block write and block read is used to emulate a block write/read process call. This is detailed later, see the Block Write/Read Process Call description.

查<mark>说 5.2 Block Command Code Summary</mark> 查<mark>说 5.2 Block (共)业尚 Block command codes control the block read and write operations of the LM94 as summarized in the following table:</mark>

Command Code Name	Value	Description
Block Write Command	F0h	SMBus Block Write Command Code
Block Read Command	F1h	SMBus Block Write/Read Process Call
Fixed Block 0	F2h	Fixed Block Read Command Code: address 40h, size 8 bytes
Fixed Block 1	F3h	Fixed Block Read Command Code: address 48h, size 8 bytes
Fixed Block 2	F4h	Fixed Block Read Command Code: address 50h, size 6 bytes
Fixed Block 3	F5h	Fixed Block Read Command Code: address 56h, size 16 bytes
Fixed Block 4	F6h	Fixed Block Read Command Code: address 67h, size 4 bytes
Fixed Block 5	F7h	Fixed Block Read Command Code: address 6Eh, size 8 bytes
Fixed Block 6	F8h	Fixed Block Read Command Code: address 78h, size 12 bytes
Fixed Block 7	F9h	Fixed Block Read Command Code: address 90h, size 32 bytes
Fixed Block 8	FAh	Fixed Block Read Command Code: address B4h, size 8 bytes
Fixed Block 9	FBh	Fixed Block Read Command Code: address C8h, size 8 bytes
Fixed Block 10	FCh	Fixed Block Read Command Code: address D00h, size 16 bytes
Fixed Block 11	FDh	Fixed Block Read Command Code: address E5h, size 9 bytes

14.5.3 Write Operations

The LN SMBus write protocols.

14.5.3.1 Write Byte

In this operation the master device sends an address byte and one data byte to the slave device, as follows:

- 1. The master device asserts a START condition.
- 2. The master sends the 7-bit slave address followed by the write bit (low).
- The addressed slave device asserts ACK.
- 4. The master sends a command code (register address).
- 5. The slave asserts ACK.
- 6. The master sends the data byte.
- 7. The slave asserts ACK.
- 8. The master asserts a STOP condition to end the transaction.

1	2		3	4	5	6	7	8
S	Slave	W	Α	Register	Α	Data	Α	Р
	Address			Address		Byte		

14.5.3.2 Write Word

In this operation the master device sends an address byte and two data bytes to the slave device, as follows:

- The master device asserts a START condition.
- 2. The master sends the 7-bit slave address followed by the write bit (low).
- 3. The addressed slave device asserts ACK.
- 4. The master sends a command code (register address).
- 5. The slave asserts ACK.
- 6. The master sends the low data byte.
- 7. The slave asserts ACK.
- 8. The master sends the high data byte.
- 9. The slave asserts ACK.
- 10. The master asserts a STOP condition to end the transaction.

1	2		3	4	5	6	7	8	9	10
S	Slave	W	Α	Register	Α	Data Byte	Α	Data Byte	Α	Р
	Address			Address		Low		High		

14.5.3.3 SMBus Write Block to Any Address

The start address for a block write is embedded in this transaction. In this operation the master sends a block of data to the slave as follows:

- 1. The master device asserts a START condition.
- 2. The master sends the 7-bit slave address followed by the write bit (low).
- 3. The addressed slave device asserts ACK.
- The master sends a command code that tells the slave device to expect a block write. The LM94 command code for a block write is F0h.
- The slave asserts ACK.
- The master sends a byte that tells the slave device how many data bytes it will send (N). The SMBus specification allows a maximum of 32 data bytes to be sent in a block write.
- 7. The slave asserts ACK.
- 8. The master sends data byte 1, the starting address of the block write.
- 9. The slave asserts ACK after each data byte.
- 10. The master sends data byte 2.
- 11. The slave asserts ACK.
- 12. The master continues to send data bytes and the slave asserts ACK for each byte.
- 13. The master asserts a STOP condition to end the transaction.

杳	 1"I	/ 194" (# 17	7商	3	4	5	6	7	8	9	10	11	~	12		13
_	S	Slave	₩	Α	Comman	Α	Byte	Α	Data	Α	Data	Α	~	Data	Α	Р
		Address			d		Count		Byte 1		Byte 2			Byte N		
					F0h		(N)		(Start							
					(Block				Address)							
					Write)											

Special Notes

- 1. Any attempts to write to bytes beyond normal address space are acknowledged by the LM94 but are ignored.
- 2. Block writes do not wrap from address FFh back to 00h the address remains at FFh.
- 3. The Byte Count field is ignored by the LM94. The master device may send more or less bytes and the LM94 accepts them.
- 4. The SMBus specification requires that block writes never exceed 32 data bytes. Meeting this requirement means that only 31 actual data bytes can be sent (the register address counts as one byte). The LM94 does not care if this requirement is met.

14.5.3.4 I²C™ Block Write

In this transaction the master sends a block of data to the LM94 as follows:

- 1. The master device asserts a START condition.
- 2. The master sends the 7-bit slave address followed by the write bit (low).
- 3. The addressed slave device asserts ACK.
- 4. The master sends the starting address of the block write.
- 5. The slave asserts ACK after each data byte.
- 6. The master sends data byte 1.
- 7. The slave asserts ACK.
- 8. The master continues to send data bytes and the slave asserts ACK for each byte.
- 9. The master asserts a STOP condition to end the transaction

1	2		3	4	5	6	7		8		9
S	Slave	W	Α	Register	Α	Data	Α	~	Data	Α	Р
	Address			Address		Byte 1			Byte N		

Special Notes:

- 1. Any attempts to write to bytes beyond normal address space are acknowledged by the LM94 but are ignored.
- 2. Block writes do not wrap from address FFh back to 00h the address remains at FFh.

14.5.4 Read Operations

The LM I Bus read protocols.

14.5.4.1 Read Byte

In the LM94, the read byte protocol is used to read a single byte of data from a register. In this operation the master device receives a single byte from a slave device, as follows:

- 1. The master device asserts a START condition.
- 2. The master sends the 7-bit slave address followed by the write bit (low).
- 3. The addressed slave device asserts ACK.
- 4. The master sends a register address.
- 5. The slave asserts an ACK.
- 6. The master sends a Repeated START.
- 7. The master sends the slave address followed by the read bit (high).
- 8. The slave asserts an ACK.
- 9. The master receives a data byte and asserts a NACK.
- 10. The master asserts a STOP condition and the transaction ends.

1	2		3	4	5	6	7		8	9		10
S	Slave	W	Α	Register	Α	S	Slave	R	Α	Data	/A	Р
	Address			Address			Address			Byte		

14.5.4.2 Read Word

In the LM94, the read word protocol is used to read two bytes of data from a register or two consecutive registers. In this operation the master device reads two bytes from a slave device, as follows:

- 1. The master device asserts a START condition.
- 2. The master sends the 7-bit slave address followed by the write bit (low).
- The addressed slave device asserts ACK.
- 4. The master sends a register address.
- 5. The slave asserts an ACK.
- 6. The master sends a Repeated START.
- 7. The master sends the slave address followed by the read bit (high).
- 8. The slave asserts an ACK.
- 9. The master receives the Low data byte and asserts an ACK.
- 10. The master receives the High data byte and asserts a NACK.
- 11. The master asserts a STOP condition and the transaction ends.

1	2		3	4	5	6	7		8	9		10		11
S	Slave	W	Α	Register	Α	s	Slave	R	Α	Data	Α	Data	/A	Р
	Address			Address			Address			Byte Low		Byte High		

14.5.4.3 SMBus Block-Write Block-Read Process Call

This transaction is used to read a block of data from the LM94. Below is the sequence of events that occur in this transaction:

- 1. The master device asserts a START condition.
- 2. The master sends the 7-bit slave address followed by the write bit (low).
- 3. The addressed slave device asserts ACK.
- 4. The master sends a command code that tells the slave device to expect a block read (F1h) and the slave asserts ACK.
- 5. The master sends the Byte Count for this write which is 2 and the slave asserts ACK.
- 6. The master sends the Start Register Address for the block read and the slave asserts the ACK.
- 7. The master sends the Byte Count (1-32) for the block read processes call and the slave asserts ACK.
- 8. The master asserts a repeat START condition.
- 9. The master sends the 7-bit slave address followed by the read bit (high).
- 10. The slave asserts ACK.
- 11. The master receives a byte count data byte that tells it how many data bytes will received. This field reflects the number of bytes requested by the Byte Count transmitted to the LM94. The SMBus specification allows a maximum of 32 data bytes to be received in a block read. Then master asserts ACK.

- 12. The master receives byte 1 and then asserts ACK.
- 查询"The goddster receives byte 2 and then asserts ACK.
 - 14. The master receives N-3 data bytes, and asserts ACK for each one.
 - 15. The master receives data byte N and asserts a NACK.
 - 16. The master asserts a STOP condition to end the transaction.

1	2		3	4		5		6		7		8	9		10	
S	Slave	W	Α	Block	Α	Byte	Α	Start	Α	Byte	Α	s	Slave	R	Α	~
	Address			Read		Count		Register		Count			Address			
				Comman		(2h)		Address		(1–20h)						
				d						(N)						
				Code												
				(F1h)												

		11		12		13		14	15	15	16
-	-	Byte	Α	Data	Α	Data	Α	~	Data	/A	Р
		Count		Byte 1		Byte 2			Byte N		
		(1-20h)									
		(N)									

Special Notes:

- 1. The LM94 returns 00h when address locations outside of normal address space are read.
- 2. Block reads do not wrap around from address FFh to 00h
- If the master acknowledges more bytes that it requested, the LM94 continues to supply data until the master does not acknowledge a byte.
- 4. If the master does not acknowledges a byte to prematurely abort a block read, the LM94 gets off the bus to allow the master to issue a STOP signal.

14.5.4.4 Simulated SMBus Block-Write Block-Read Process Call

Alternatively, if the master cannot support an SMBus Block-Write Block-Read process call, it can be emulated by two transactions (a block write followed by a block read). This should only be done in a single master system, since in a dual master system collisions can occur that corrupt the data and transaction. Below is the sequence of events for these transactions:

- 1. The master issues a START to start this transaction.
- 2. The master sends the 7-bit slave address followed by a write bit (low).
- 3. The slave asserts the ACK.
- 4. The master sends the Block Read command code (F1h) and the slave asserts the ACK.
- 5. The master sends the Byte Count (2h) for this transaction and the slave asserts the ACK.
- 6. The master sends the Start Register Address and the slave asserts the ACK.
- 7. The master sends the Byte Count (1-20h) for the Block-Read Process Call and the slave asserts the ACK.
- 8. The master sends a STOP to end this transaction.
- 9. The master sends a START to start this transaction.
- 10. The master sends the 7-bit slave address followed by a write bit (low) and the slave asserts the ACK.
- 11. The master sends the Block Read Command code (F1h) and the slave asserts the ACK.
- 12. The master sends a repeat START.
- 13. The master sends the 7-bit slave address followed by a read bit (high) and the slave asserts the ACK.
- 14. The master receives Byte Count (this matches the size sent by the master in step 7) and asserts the ACK.
- 15. The master receives Data Byte 1 and asserts the ACK.
- 16. The master receives Data Byte 2 and asserts the ACK.
- 17. The master receives N-3 data bytes, and asserts ACK for each one.
- 18. The master receives the last data byte and asserts a NACK.
- 19. The master issues a STOP to end this transaction.

1	2		3	4		5		6		7		8	9	10			
S	拿 福"LIV	94"	供	™ ioodik	Α	Byte	Α	Start	Α	Byte	Α	Р	S	Slave	W	Α	~
	Address			Read		Count		Register		Count				Address			
				Comman		(2h)		Address		(1-20h)							
				d						(N)							
				Code													
				(F1h)													

	11		12	13			14		15		16			17		16
~	Block	Α	S	Slave	R	Α	Byte	Α	Data	Α	Data	Α	~	Data	/A	Р
	Read			Address			Count		Byte 1		Byte 2			Byte N		
	Command						(1-20h)									
	Code						(N)									
	(F1h)															

Special Notes:

- 1. Steps 9 through 19 can be repeated to read another block of data. The address auto-increments such that the next block starts where the last block left off. The size returned by the LM94 is the same each time.
- 2. The LM94 returns 00h when address locations outside of normal address space are read.
- Block reads do not wrap around from address FFh to 00h
- 4. If the master acknowledges more bytes that it requested, the LM94 continues to supply data until the master does not acknowledge a byte.
- 5. If the master does not acknowledges a byte to prematurely abort a block read, the LM94 gets off the bus to allow the master to issue a STOP signal.
- 6. After a block read is finished, the base address of the LM94 is updated to point to the byte just beyond the last byte read.

14.5.4.5 SMBus Fixed Address Block Reads

Block reads can be performed from pre-defined addresses. A special command code has been reserved for each pre-defined address. See the *Section 14.5.2 Block Command Code Summary* for more details on the command codes. Below is the sequence of events that occur for this type of block read:

- 1. The master sends a START to start this transaction.
- 2. The master sends the 7-bit slave address followed by a write bit (low).
- 3. The slave asserts an ACK.
- 4. The master sends a Fixed Block Command Code (F2h-FDh) and the slave asserts an ACK.
- 5. The master sends a repeated START.
- 6. The master sends the 7-bit slave address followed by a read bit (high).
- 7. The slave asserts an ACK.
- 8. The master receives the Byte Count (depends on the Fixed Block Command Code used) and asserts an ACK.
- 9. The master receives the first data byte and asserts an ACK.
- 10. The master continues to receive data bytes and asserting an ACK.
- 11. The master receives the last data byte.
- 12. The master asserts a NACK.
- 13. The master issues a STOP to end this transaction.

1	2		3	4		5	6		7	8		9		10	11	12	13
S	Slave	W	Α	Fixed	Α	S	Slave	R	Α	Byte	Α	Data	Α	~	Data	/A	Р
	Address			Block			Address			Count		Byte 1			Byte N		
				Command						(N)							
				Code													
				(F2h-FDh)													

Special Notes

- The LM94 returns 00h when address locations outside of normal address space are read.
- 2. Block reads do not wrap around from address FFh to 00h.
- 3. If the master acknowledges more bytes that it requested, the LM94 continues to supply data until the master does not acknowledge a byte.
- 4. If the master does not acknowledges a byte to prematurely abort a block read, the LM94 gets off the bus to allow the master to issue a STOP signal.

14.5.4.6 I2C Block Reads

查询。LM94su供应商 block reads. The following sequence of events occur in this transaction:

- 1. The master sends a START to start this transaction .
- 2. The master send 7-bit slave address followed by a write bit (low).
- 3. The slave asserts an ACK.
- 4. The master sends the register address and the slave asserts an ACK.
- 5. The master sends a repeated START.
- 6. The master sends the 7-bit slave address followed by a read bit (high).
- 7. The slave asserts an ACK.
- 8. The master receives Data Byte 1 and asserts an ACK.
- 9. The master continues to receive bytes and asserting an ACK for each byte received.
- 10. The master receives the last byte.
- 11. The master asserts a NACK.
- 12. The master issues a STOP.

1	2		3	4		5	6		7	8		9		~	10	11	12
S	Slave	W	Α	Register	Α	S	Slave	R	Α	Data	Α	Data	Α	~	Data	/A	Р
	Address			Address			Address			Byte 1		Byte 2			Byte N		

Special Notes:

- 1. The LM94 returns 00h when address locations outside of normal address space are read.
- 2. Block reads do not wrap around from address FFh to 00h.
- If the master acknowledges more bytes that it requested, the LM94 continues to supply data until the master does not acknowledge a byte.
- 4. If the master does not acknowledges a byte to prematurely abort a block read, the LM94 gets off the bus to allow the master to issue a STOP signal.

14.6 READING AND WRITING 16-BIT REGISTERS

Whenever the low byte of a 16-bit register is read, the high byte is frozen. After the high byte is read, it is unfrozen. This ensures that the entire 16-bit value is read properly and the high byte matches with the low byte. If the low byte of a different 16-bit register is read, the currently frozen high byte is unfrozen and the high byte of the new 16-bit register is frozen. In a system with two SMBus masters, it is very important that only one master reads any 16-bit registers at a time. One possible method to achieve this would involve using 16-bit SMBus reads (instead of two separate 8-bit reads) to read 16-bit registers.

Whenever the low byte of a 16-bit register is written, the write is buffered and does not take effect until the corresponding high byte is written. If the low byte of a different 16-bit register is written, the previously buffered low byte of the first register is discarded. If a device attempts to write the high byte of a 16-bit register, and the corresponding low byte was not written (or was discarded), then the LM94 will NACK the byte.

15.0 Using The LM94

15.1 POWER ON

The LM94 generates a power on reset signal on RESET when power is applied for the first time to the part.

15.2 RESETS

Upon power up, the \overline{RESET} output is asserted when the voltage on the power supply crosses the power-on-reset threshold level (see Electrical Specifications). The \overline{RESET} output is open-drain and should be used with an external pull-up resistor connected to V_{DD} . Once the power on reset has completed, the \overline{RESET} pin becomes an input and 10 μ s after assertion of \overline{RESET} the LOCK bit in the LM94 Configuration register shall be cleared. In addition, 10 μ s after assertion of

RESET the sleep control register shall be automatically set to S4/S5. This causes several error events to be masked according to the S4/S5 masking definitions. Since the RESET pin becomes an active input, it must not be left floating at any time as this may cause the LM94 to drift into S4/S5 and thus have unpredictable behavior. RESET must be asserted for more than 4µs in order to guarantee detection.

Register Types	Power On Reset	External Reset
Factory regs	Х	
BMC Error Status regs	Х	
Host Error Status regs	Х	
Value regs		
Limit regs	Х	
Setup regs	Х	
LM94 Configuration Lock Bit	Х	х
LM94 Configuration GMSK Bit	x (reset)	
Sleep Mask	Х	
Sleep State Control		х
Other Mask regs	Х	

All other registers are not effected by power on reset or external reset.

15.3 ADDRESS SELECTION

LM94 is designed to be used primarily in dual processor server systems that may require only one monitoring device.

If multiple LM94 devices are implemented in a system, they must have unique SMBus slave addresses. See the *Section 14.1 SMBus ADDRESSING* for more information.

The board designer may apply a 10 k Ω pull-down and/or pull-up resistors to ground and/or to 3.3V SB V_{DD} on the

ADDR_SEL pin. The LM94 is designed to work with resistors of 5% to the resistors are required. Upon the first SMBus communication to the part, the LM94

assigns itself an SMBus address according to the ADDR_SEL input.

Address	Board	SMBus
Select	Implementation	Address
less-than 10% of V _{DD}	Pulled to ground through a 10 k Ω resistor	0101 100b
≈ V _{DD} /2	10 k Ω (5%) Resistor to 3.3V SB V_{DD} and to Ground	0101 110b
greater-than 90% of V_{DD}	Pulled to 3.3V SB V_{DD} through a 10 $\mathrm{k}\Omega$ resistor	0101 101b

15.4 DEVICE SETUP

BIOS executes the following steps to configure the registers in the LM94. All steps may not be necessary if default values are acceptable.

Set limits and parameters (not necessarily in this order):

Set up Fan control

Set up PWM temperature bindings

Set fan tach limits

Set fan boost temperature and hysteresis

Set the VRD_HOT and PROCHOT PWM ramp control rate Enable Smart Tach Mode and Tachometer Input to PWM binding (required with PWM drive of fan ground or power pins)

Set the temperature absolute limits

Set the temperature hysteresis values

Set temperature filtered or unfiltered usage

15.5 ROUND ROBIN VOLTAGE/TEMPERATURE CONVERSION CYCLE

The LM94 monitoring function is started as soon as the part is powered up. The LM94 performs a "round robin" sampling of the inputs, in the order shown below. Each cycle of the round robin is completed in less than 100 ms.

The results of the sampling and conversions can be found in the value registers and are available at any time.

Channel #	Input	Typical Assignment
3	Temp Zone 3	Internal Temperature Reading
1	Temp Zone 1a	Remote Diode 1a Temp Reading
	Temp Zone 1b	Remote Diode 1b Temp Reading (if selected)
2	Temp Zone 2a	Remote Diode 2a Temp Reading
	Temp Zone 2b	Remote Diode 2b Temp Reading (if selected)
4	AIN1	+12V1 (if selected)
5	AIN2	+12V2 (if selected)
6	AIN3	+12V3
7	AIN4	FSB_Vtt
8	AIN5	3GIO/PXH/MCH_Core
9	AIN6	ICH_Core
10	AIN7	CPU_1Vccp
11	AIN8	CPU2_Vccp
12	AIN9	3.3V
13	AIN10	+5V
14	AIN11	SCSI_Core

Set the Zone Adjustment Offset temperature

Set the PROCHOT override and time interval values

Set the PROCHOT user limit

Enable THERMTRIP masking of error events (if GPIO4 and GPIO5 are used as THERMTRIP inputs)

Set voltage sensor limits and hysteresis

Set the Dynamic Vccp offset limits

Set the Sleep State control and mask registers

Set Other Mask Registers (GPI Error, VRDx_HOT, and

Dynamic Vccp limit checking)

Set start bit to select user values and unmask error events Set the sleep state to 0

Set Lock bit to lock the limit and parameter registers (optional)

Channel #	Input	Typical Assignment
15	AIN12	Mem_Core
16	AIN13	Mem_Vtt
17	AIN14	GBIT_Core
18	AIN15	-12V
19	AIN16	3.3V SB V _{DD} Supply Rail

15.6 ERROR STATUS REGISTERS

The LM94 contains several error status registers for the BMC side, and duplicated error status registers for the Host side. These registers are used to reflect the state of all the possible error conditions that the LM94 monitors.

The BMC/Host Error Status registers hold a set bit until the event is cleared by software, even if the condition causing the error event goes away.

To clear a bit in the Error Status registers, a '1' has to be written to the specific bit that is required to be cleared. If the event that caused the error is no longer active then the bit is cleared. Clearing a bit in a BMC Error Status register does not clear the corresponding bit in the Host Error Status register or vise versa.

15.6.1 ASF Mode

Error Status registers function allow the LM94 to act as a legacy sensor (6.1.2 of ASF spec DSP0114 rev 2) and to easily connect to the SMBus of an ASF capable NIC chip.

The LM94 can be placed into ASF mode by setting the appropriate bit in the LM94 Status/Control register. Once this bit is set, the BMC Error Status registers become read-to-clear. Writing a '1' to clear a particular bit is also allowed in ASF mode. The Host Error Status registers are not effected by ASF mode.

15.7 MASKING, ERROR STATUS AND ALERT

Tasking 知识 中央 Tane vent is masked, the corresponding error bit in the HOST or BMC Error Status registers. If an event is masked, the corresponding error bit in the HOST or BMC Error Status registers is prevented from ever being set. As a result, this prevents the event from ever causing ALERT to be asserted. Masking an event does not clear its associated Error Status bit if it is currently set.

Voltage errors are masked by writing a high voltage limit value of FFh. This is the default high limit for all voltages.

Temperature errors are masked by writing a high temperature limit value of 80h. This is the default high limit for all temperatures. Masking a temperature channel masks both temperature errors and diode fault errors.

The GPI Mask register allows GPI errors to be masked. Any bits that are set in this register mask events for the corresponding GPIO_x pin.

User PROCHOT status is not really an error but it can be used to notify the user of processor throttling past a preset USER limit. A user limit of FFh acts as the mask for this register. Error bits associated with the predefined PROCHOT thresholds cannot be masked. It is important to note though, that these error bits do not cause BMC_ERR, HOST_ERR, or ALERT to be asserted under any condition.

Fan tach errors are masked if the tach limit for the given tach is set to FFh.

GPI errors and VRDx_HOT errors can be masked by setting the appropriate bit in the GPI and Miscellaneous Error Mask registers.

When the LM94 powers up, the ALERT output is disabled. The ALERT output can be enabled by setting the ALERT_EN bit in the LM94 Configuration register.

In addition the manual masking options, the LM94 also masks some errors depending on the sleep state of the system. The sleep state of the system is communicated to the LM94 by writing to the Sleep State Control register. Some types of error events are always masked in certain sleep modes. Some types of error events are optionally masked in certain sleep modes if their sleep mask register bit is set. Refer to the register descriptions for more information.

15.8 LAYOUT AND GROUNDING

Analog components such as voltage dividers should be physically located as close as possible to the LM94. See Section 15.9.2 PCB Layout for Minimizing Noise for thermal diode layout recommendations.

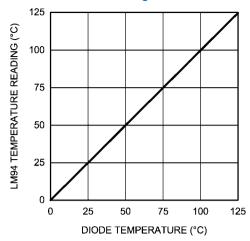
The LM94 bypass capacitors, the parallel combination of 100 pF, 10 μ F (electrolytic or tantalum) and 0.1 μ F (ceramic) bypass capacitors must be connected between power pin (pin 39) and ground, and should be located as close as possible to the LM94. The 100 pF capacitor should be placed closest to the power pin.

15.9 THERMAL DIODE APPLICATION

To measure temperature external to the LM94, use a remote discrete diode to sense the temperature of external objects or ambient air. The temperature of a discrete diode is affected, and often dominated, by the temperature of its leads.

Most silicon diodes do not lend themselves well to this application. It is recommended that a MMBT3904 transistor type base emitter junction be used with the collector tied to the base.

Thermal Diode Temperature vs. LM94 Temperature Reading



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15.9.1 DIODE NON-IDEALITY

15.9.1.1 Diode Non-Ideality Factor Effect on Accuracy

When a transistor is connected as a diode, the following relationship holds for variables $V_{\text{BE}},\,T$ and I_{F} :

$$I_{F} = I_{S} \times \left[\underbrace{ \left[\frac{V_{BE}}{\eta \times V_{t}} \right]}_{-1} \right]$$
 (6)

where:

$$V_t = \frac{k T}{q}$$

- $q = 1.6 \times 10^{-19}$ Coulombs (the electron charge),
- T = Absolute Temperature in Kelvin
- k = 1.38×10⁻²³joules/K (Boltzmann's constant),
- η is the non-ideality factor of the process the diode is manufactured on,
- I_S = Saturation Current and is process dependent,
- I_f = Forward Current through the base emitter junction
- V_{BE} = Base Emitter Voltage drop

In the active region, the -1 term is negligible and may be eliminated, yielding the following equation

$$I_{F} = I_{S} \left[\frac{V_{be}}{\eta V_{t}} \right] \tag{7}$$

In *Equation 7*, η and I_S are dependant upon the process that was used in the fabrication of the particular diode. By forcing two currents with a well controlled ratio(I_{F2}/I_{F1}) and measuring the resulting voltage difference, it is possible to eliminate the I_S term. Solving for the forward voltage difference yields the relationship:

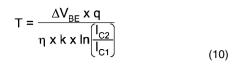
$$\Delta V_{BE} = \eta \times \frac{K \times T}{q} \times \ln \left[\frac{I_{F2}}{I_{F1}} \right]$$
 (8)

Solving Equation 8 for temperature yields:

$$T = \frac{\Delta V_{BE} \times q}{\eta \times k \times ln \left(\frac{I_{F2}}{I_{F1}}\right)}$$
(9)

Equation 9 holds true when a diode connected transistor such as the plied is used with this "diode" equation is applied to an integrated diode such as a processor transistor with its collector tied to GND as shown in Figure 4 it will yield a wide non-ideality spread. This wide non-ideality spread is not due to true process variation but due to the fact that Equation 9 is an approximation.

TruTherm technology uses the transistor equation, *Equation* 10, which is a more accurate representation of the topology of the thermal diode found in an FPGA or processor.



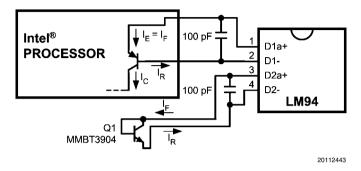


FIGURE 4. Thermal Diode Current Paths

TruTherm should only be enabled when measuring the temperature of a transistor integrated as shown in the processor of *Figure 4*, because *Equation 10* only applies to this topology.

15.9.1.2 Calculating Total System Accuracy

The voltage seen by the LM94 also includes the I_FR_S voltage drop of the series resistance. The non-ideality factor, η, is the only other parameter not accounted for and depends on the diode that is used for measurement. Since ΔV_{BF} is proportional to both η and T, the variations in η cannot be distinguished from variations in temperature. Since the non-ideality factor is not controlled by the temperature sensor, it will directly add to the inaccuracy of the sensor. For the Pentium D processor on 65nm process, Intel specifies a +4.06%/-0.89% variation in n from part to part when the processor diode is measured by a circuit that assumes diode equation. Equation 9, as true. As an example, assume a temperature sensor has an accuracy specification of ±2.5°C at a temperature of 75° C (348 Kelvin) and the processor diode has a non-ideality variation of +4.06%/-0.89%. The resulting system accuracy of the processor temperature being sensed will be:

$$T_{ACC} = \pm 2.5^{\circ}C + (+4.06\% \text{ of } 348 \text{ K}) = +16.6 ^{\circ}C$$

and

$$T_{ACC} = \pm 2.5^{\circ}C + (-0.89\% \text{ of } 348 \text{ K}) = -5.6 ^{\circ}C$$

TruTherm technology uses the transistor equation, *Equation* 10, resulting in a non-ideality spread that truly reflects the process variation which is very small. The transistor equation non-ideality spread is $\pm 0.4\%$ for the Pentium D processor on 65nm process. The resulting accuracy when using TruTherm technology improves to:

$$T_{ACC} = \pm 2.5^{\circ}C + (\pm 0.4\% \text{ of } 348 \text{ K}) = \pm 3.9 ^{\circ}C$$

The next error term to be discussed is that due to the series resistance of the thermal diode and printed circuit board traces. The thermal diode series resistance is specified on most processor data sheets. For the Pentium D processor on 65 nm process, this is specified at 4.52Ω typical. The LM94 accommodates the typical series resistance of the Pentium D processor on 90 nm process. The error that is not accounted

for is the spread of the Pentium's series resistance, that is 2.79Ω to 6.24Ω or $\pm 1.73\Omega.$ The equation to calculate the temperature error due to series resistance (T $_{ER}$) for the LM94 is simply:

$$T_{ER} = R_{PCB} \times 0.62^{\circ} C/\Omega$$
 (11)

Solving Equation 11 for R_{PCB} equal to $\pm 1.73\Omega$ results in the additional error due to the spread in the series resistance of $\pm 1.07^{\circ}$ C. The spread in error cannot be canceled out, as it would require measuring each individual thermal diode device. This is quite difficult and impractical in a large volume production environment.

Equation 11 can also be used to calculate the additional error caused by series resistance on the printed circuit board. Since the variation of the PCB series resistance is minimal, the bulk of the error term is always positive and can simply be cancelled out by subtracting it from the output readings of the LM94.

15.9.1.3 Compensating for Different Non-Ideality

In order to compensate for the errors introduced by non-ideality, the temperature sensor is calibrated for a particular processor. National Semiconductor temperature sensors are always calibrated to the typical non-ideality and series resistance of a given processor type. The LM94 is calibrated for two non-ideality factors and series resistance values thus supporting the MMBT3904 transistor and the Pentium D processor on 65nm process without the requirement for additional trims. For most accurate measurements TruTherm mode should be turned on when measuring the Pentium D processor on the 65nm process the error introduced by the false non-ideality spread (see Section 15.9.1.1 Diode Non-Ideality Factor Effect on Accuracy). When a temperature sensor calibrated for a particular processor type is used with a different processor type, additional errors are introduced. Temperature errors associated with non-ideality of different processor types may be reduced in a specific temperature

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range of concern through use of software calibration. Typical

non-ideality specification differences cause a gain variation of

the transfer function, therefore the center of the temperature range of interestished be the target temperature for calibration purposes. The following equation can be used to calculate the temperature correction factor (T_{CF}) required to compensate for a target non-ideality differing from that supported by the LM94.

$$T_{CF} = [(\eta_S - \eta_{Processor}) \div \eta_S] \times (T_{CR} + 273 \text{ K})$$
 (12)

where

- η_S = LM94 non-ideality for accuracy specification
- η_T = target thermal diode typical non-ideality
- T_{CR} = center of the temperature range of interest in °C

The correction factor of *Equation 12* should be directly added to the temperature reading produced by the LM94. For example when using the LM94, with the 3904 mode selected, to measure a AMD Athlon processor, with a typical non-ideality of 1.008, for a temperature range of 60 °C to 100 °C the correction factor would calculate to:

$$T_{CF} = [(1.003 - 1.008) \div 1.003] \times (80 + 273) = -1.75^{\circ}C$$

Therefore, 1.75°C should be subtracted from the temperature readings of the LM94 to compensate for the differing typical non-ideality target.

15.9.2 PCB Layout for Minimizing Noise

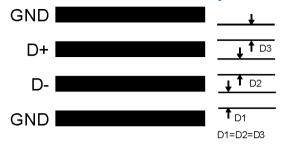
In the following guidelines, Remote+ and Remote -- refer to the REMOTE1a+, Remote 1b+, REMOTE1-, REMOTE2a+, Remote2b+ and REMOTE2- pins.

In a noisy environment, such as a power supply, layout considerations are very critical. Noise induced on traces running between the remote temperature diode sensor and the LM94 can cause temperature conversion errors.

The following guidelines should be followed:

- Place a 0.1 μF and 100 pF LM94 power bypass capacitors as close as possible to the V_{DD} pin, with the 100pF capacitor being the closest. Place 10 μF capacitor in the near vicinity of the LM94 power pin.
- Place a 100 pF capacitor as close as possible to the LM94 thermal diode Remote+ and Remote- pins. Make sure the traces to the 100 pF capacitor are matched and as short as possible. This capacitor is required to minimize high frequency noise error.
- Thermal diodes that share one Remote
 – pin must have
 a separate trace from the LM94 Remote
 – pin run to each
 diode cathode. Do not "daisy chain" these connections.
- 4. Ideally, the LM94 should be placed within 10 cm of the thermal diode pins with the traces being as straight, short and identical as possible. Trace resistance of 1Ω can cause as much as 1° C of error.
- 5. Diode traces should be surrounded by a GND guard ring to either side, above and below, if possible. This GND guard should not be between the Remote+ and Remote lines. In the event that noise does couple to the diode lines, it would be ideal if it is coupled to both identically, i.e. common mode. That is, equally to the Remote+ (D+) and Remote-(D-) lines. (See figure below):

Recommended Diode Trace Lavout



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- Avoid routing diode traces in close proximity to any power supply switching or filtering inductors.
- Avoid running diode traces close to or parallel to high speed digital and bus lines. Diode traces should be kept at least 2 cm apart from the high speed digital traces.
- If it is necessary to cross high speed digital traces, the diode traces and the high speed digital traces should cross at a 90 degree angle.
- The ideal place to connect the LM94's GND pin is as close as possible to the Processors GND associated with the sense diode. In the case of two processors pick a node in between the two that has the least noise.
- 10. Leakage current between Remote+ and GND should be kept to a minimum. Error in the diode temperature reading may reach 0.4°C with 30 nA of leakage current. Keeping the printed circuit board as clean as possible minimizes leakage current. The residue from some freeze spray can induce high leakage current.

15.10 FAN CONTROL

15.10.1 Automatic Fan Control Methods

The LM94 fan speed control method is optimized for fan noise reduction, fan power efficiency, fan reliability and minimum cost. The PWMx outputs can be filtered using an external switching regulator type output stage that provides 5V to 12V DC for fan power. A high PWM frequency is required to minimize the size and cost of the inductor and other components used in the output stage. The PWM outputs of the LM94 can operate up to 22.5 kHz with a variable step size depending on the fan control mode of operation. The LM94 supports LUT (Lookup Table) and PI (Proportional Integral) fan control methods. These methods can function interactively or independently as controlled by the PWM binding registers. Figure 5 shows the high level block diagram for these fan control methods. The mapping/binding of the temperature zones to the LUTs is completely independent of the PI loops. The temperature zones can be first independently bound to the LUTs and/or PI loops then each LUT or PI loop can be bound to either PWM Output. The LUT parameters are independent of the temperature zone binding. The PI loop controller is a proportional-integral feedback controller. It generates a 9-bit PWM duty cycle and uses temperature feedback from the processor thermal zones (Zones 1 and 2). The PWM output controls the airflow over the processors and thus the temperature of the processors is adjusted by the PI loop to maintain the hottest temperature reading between the values Tcontrol and Tcontrol - hysteresis. The LM94 supports 2 processors and each processor can have two thermal sub-zones. The hottest of each processor temperature is reported to the Zone selectors and PI loop inputs. Each processor has an independent Tcontrol setting.

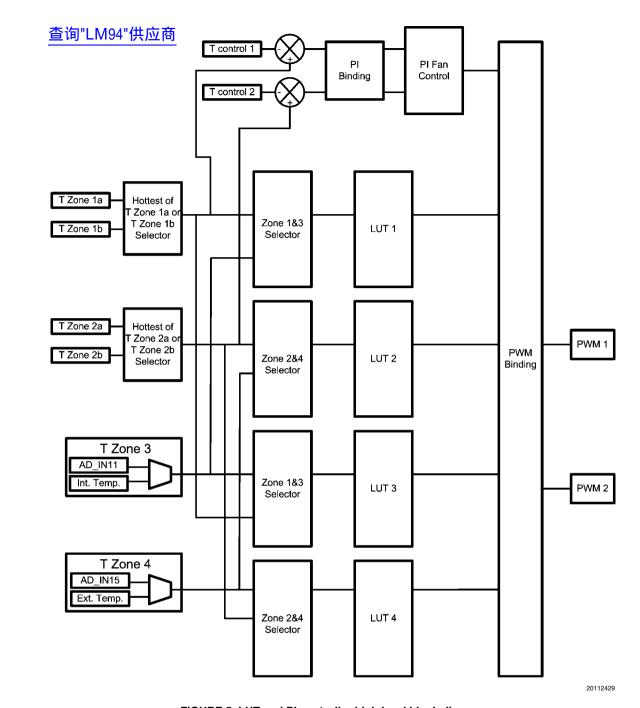


FIGURE 5. LUT and PI controller high level block diagram

15.10.2 LUT Fan Control Duty Cycles

描述文记》(如序) LM94 use 4-bit values to represent a duty cycle. All of them use a common mapping that associates the 4-bit value with a duty cycle. The 4-bit values correspond also with the 14 steps of the auto fan control algorithm. The mapping is shown below. This applies for PWM outputs running at the default 22.5 kHz (high) frequency.

4-Bit Value	Step	22.5 kHz (High Frequency) Duty Cycle
0h		0.00%
1h	1	25.00%
2h	2	31.25%
3h	3	37.50%
4h	4	43.75%
5h	5	50.00%
6h	6	56.25%
7h	7	62.50%
8h	8	68.75%
9h	9	75.00%
Ah	10	81.25%
Bh	11	87.50%
Ch	12	93.75%
Dh	13	100.00%
Eh		Reserved
Fh	_	Reserved

15.10.3 Alternate LUT PWM Mapping

The PWM output can operate at lower frequencies, instead of the default 22.5 kHz. The lower frequencies can be enabled through the PWMx Control 4 registers. Operating in the lower frequency mode, enables an alternate mapping of step numbers to duty cycle. This effects the auto fan control and all LM94 registers that describe a duty cycle using a 4-bit value. This alternate mapping can also be enable when using the default 22.5 kHz PWM frequency.

The alternate LUT PWM duty cycle mapping is listed in the following table:

4-Bit Value	LUT Step	Alternate LUT Duty Cycle
0h		0%
1h	1	25.00%
2h	2	28.57%
3h	3	32.14%
4h	4	35.71%
5h	5	39.29%
6h	6	42.86%
7h	7	46.43%
8h	8	50.00%
9h	9	53.57%
Ah	10	57.14%
Bh	11	71.43%
Ch	12	85.71%
Dh	13	100.00%

4-Bit Value	LUT Step	Alternate LUT Duty Cycle
Eh	_	Reserved
Fh	_	Reserved

15.10.4 Fan Control Priorities

The automatic fan control is not the only function that influences PWM duty cycle. There are several other functions that influence the PWM duty cycle. All the functions can be classified into several categories:

Category #	Category Name			
1	PWM to 100% conditions			
2	VRDx_HOT ramp-up/ramp-down			
3	PROCHOT ramp-up/ramp-down function			
4	Manual PWM Override			
5	Fan Spin-Up Control			
6	Automatic Fan Control Algorithm			

The ultimate PWM duty cycle that is chosen can be described by the following formula:

If (Manual PWM Override is active)

PWM = max(1,2,3,4)

Else

PWM = max(1,2,3,5,6)

So in general, categories 1, 2 and 3 are always active. In addition to that, either category 4 or categories 5 and 6 are active depending on whether manual override is enabled. In this sense the manual override, when enabled, replaces category 5 and 6.

15.10.5 PWM to 100% Conditions

There are several conditions that cause the duty cycles of all PWM outputs to immediately get set to 100%. They are:

- any of the four temperature zones exceed the programmed Fan Boost Limit setting but has not yet cooled down enough to drop below the hysteresis point
- 2. a tachometer reading exceeds its limit
- 3. the OVRID bit is set in the LM94 Status/Control

15.10.6 VRDx_HOT Ramp-Up/Ramp-Down

This function causes the duty cycle of the PWM outputs to gradually increase over time if VRD1_HOT or VRD2_HOT are asserted

When VRDx_HOT is asserted, the ramp function is enabled. The enabling process involves two steps:

- The current duty cycle being requested by other PWM functions is memorized.
- The ramp function immediately adds one PWM duty cycle step to the memorized value and requests this duty cycle.

Once the function is enabled, it gradually adds additional duty cycle steps every X milliseconds whenever $\overline{VRDx_HOT}$ is asserted (X is programmable via the PWM Ramp Control register). If $\overline{VRDx_HOT}$ remains asserted for a long enough time, the duty cycle eventually reaches 100%.

Whenever VRDx_HOT is de-asserted, the ramp function begins to ramp down by subtracting one PWM duty cycle step every X milliseconds. If VRDx_HOT is currently de-asserted, and the ramp function is less than to the PWM duty cycle be-

ing requested by other functions, the ramp function is disabled. 查询"LM94"供应商

As long as the function is enabled, it continues to ramp up or ramp down depending on the state of VRDx_HOT. The ramp enabling process described above can only re-occur after the ramp function has been disabled. Rapid assertion/de-assertion of VRDx_HOT does not trigger the enabling process unless VRDx_HOT was de-asserted long enough for the ramp function to disable itself.

This ramp function operates independently for VRD1_HOT and VRD2_HOT. In addition, the ramp function only applies to the PWM(s) that are bound to one or two VRDx_HOT inputs. Depending on the bindings, it is possible that up to four independent ramp functions are active at any given moment:

PWM1/VRD1

PWM1/VRD2

PWM2/VRD1

PWM2/VRD2

If a PWM is bound to both $\overline{VRD1_HOT}$ and $\overline{VRD2_HOT}$, then two ramp functions are active for that PWM output. In this case the duty cycle that is used is the maximum of the two ramp functions.

15.10.7 PROCHOT Ramp-Up/Ramp-Down

This function is very similar to the VRDx_HOT ramp-up/ramp-down function. The PWM duty cycle ramps up in the same

fashion whenever the PROCHOT measurement exceeds the user programmed threshold. Once a new PROCHOT measurement is made that no longer exceeds the user limit, the PWM will begin to ramp down.

Just as with the $\overline{\text{VRDx_HOT}}$ ramp function, the $\overline{\text{PROCHOT}}$ ramp function uses independent bindings to determine which PWM outputs should be effected by each $\overline{\text{PROCHOT}}$ input $\overline{\text{(P1_PROCHOT)}}$ or $\overline{\text{P2_PROCHOT}}$).

If a PWM is bound to both P1_PROCHOT and P2_PROCHOT, two PROCHOT ramp functions could be active at the same time. In this case the duty cycle that is used is the maximum of the two ramp functions.

15.10.8 Manual PWM Override

When a PWM channel is configured for manual PWM override, software can manually control the PWM duty cycle. There are some PWM control functions that could still cause the duty cycle to be higher than the manual setting. See the *Section 15.10.4 Fan Control Priorities* for details.

15.10.9 Fan Spin-Up Control

All of the other PWM control functions are combined to produce a final duty cycle that is actually used for the PWM output. If this final value changes from zero to a non-zero value, the Fan Spin-Up Control function is triggered. Once triggered, the Fan Spin-Up Control requests the programmed duty cycle for a programmed period of time.

15.11 XOR TREE TEST

The LM94 for Automated Test Equipment (ATE) board level connectivity testing. This allows the functionality of all digital inputs to be tested in a simple manner and any pins that are non-functional or shorted to-

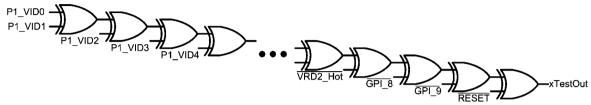
gether to be identified. When the test mode is enabled by setting the 'XEN' bit in the XOR Test register, the part enters XOR test mode.

The following signals are included in the XOR test tree:

Px_VIDy GPIO_x PWMx	Px_PROCHOT	VRDx_HOT	GPIx	RESET
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Since the test mode is XOR tree, the order of the signals in the tree is not important. SMBDAT and SMBCLK should not be included in the test tree.

Example of XOR Test Tree (not showing all signals)



20112419

To properly implement the XOR TREE test on the PCB, no pins listed in the tree should be connected directly to power or ground. If a pin needs to be configured as a permanent low, such as a GPI, it should be connected to ground through a

low value resister such as 10 k Ω , to allow the ATE (Automatic Test Equipment) to drive it high.

When generating test waveforms, a typical propagation delay of 500 ns through the XOR tree should be allowed for.

16.0 Registers 查询"LM94"供应商

In most cases, reserved registers and register bits return zero when read. This should not be relied upon, since reserved registers can be used for future expansion of the LM94 functions.

Some registers have "N/D" for their default value. This means that the power-up default of the register is not defined. In the case of value registers, care should be taken to ensure that software does not read a value register until the associated measurement function has acquired a measurement. This applies to temperatures, voltages, fan RPM, and PROCHOT monitoring.

16.2 REGISTER SUMMARY TABLE

Register Key

Term	Description		
N/D	Not Defined		
N/A	Not Applicable		
R	Read Only		
R/W	Read or Write		
RWC	Read or Write to Clear		

Loc k	Register Name	Address	Default	Description
FAC	TORY REGISTERS			
х	XOR Test	00h	00h	Used to set the XOR test tree mode
	SMBus Test	01h	00	SMBus read/write test register
	Reserved	02h-04h	N/D	
"REN	NOTE DIODE" MODE SELECT			
х	Transistor Mode Select	05h	00h	Selects Diode Mode (default) or Transistor Mode for "Remote
				Diode" measurements
VAL	UE REGISTER SECTION 1			
	Zone 1b (CPU1 Diode b) Temp	06h	00h	Measured value of remote thermal diode temperature channel 1b
	Zone 2b (CPU2 Diode b) Temp	07h	00h	Measured value of remote thermal diode temperature channel 2b
	Zone 1b (CPU1 Diode b) Filtered Temp	08h	00h	Filtered value of remote thermal diode temperature channel 1b
	Zone 2b (CPU2 Diode b) Fitlered Temp	09h	00h	Filtered value of remote thermal diode temperature channel 2b
	PWM1 8-bit Duty Cycle Value	0Ah	00h	8- bit value of the PWM1 duty cycle.
	PWM2 8-bit Duty Cycle Value	0Bh	00h	8-bit value of the PWM2 duty cycle
HIGH	RESOLUTION PWM OVERIDE REGIS	TERS		
х	PWM1 Duty Cycle Override (low byte)	0Ch	00h	Lower byte of the high resolution PWM1 duty cycle register
х	PWM1 Duty Cycle Override (high byte)	0Dh	00h	Upper byte of the high resolution PWM1 duty cycle register
х	PWM2 Duty Cycle Override (low byte)	0Eh	00h	Lower byte of the high resolution PWM2 duty cycle register
х	PWM2 Duty Cycle Override (high byte)	0Fh	00h	Upper byte of the high resolution PWM2 duty cycle register
EXTI	ENDED RESOLUTION TEMPERATURE	VALUE F	REGISTER	RS
	Z1a_LSB	10h	00h	Zone 1a (CPU1) extended resolution unfiltered temperature value register, least-significant byte
	Z1a_MSB	11h	00h	Zone 1a (CPU1) extended resolution unfiltered temperature value register, most-significant byte
	Z1b_LSB	12h	00h	Zone 1b (CPU1) extended resolution unfiltered temperature value register, least-significant-byte
	Z1b_MSB	13h	00h	Zone 1b (CPU1) extended resolution unfiltered temperature value register, most-significant byte
	Z2a_LSB	14h	00h	Zone 2a (CPU2) extended resolution unfiltered temperature value register, least-significant-byte
	Z2a_MSB	15h	00h	Zone 2a (CPU2) extended resolution unfiltered temperature value register, most-significant byte

_oc ii	Register Name LM94"供应商	Address	Default	Description
	Z2b_LSB	16h	00h	Zone 2b (CPU2) extended resolution unfiltered temperature value register, least-significant-byte
	Z2b_MSB	17h	00h	Zone 2b (CPU2) extended resolution unfiltered temperature value register, most-significant byte
	Z1a_F_LSB	18h	00h	Zone 1a (CPU1) extended resolution filtered temperature value register, least-significant byte
	Z1a_F_MSB	19h	00h	Zone 1a (CPU1) extended resolution filtered temperature value register, most-significant byte
	Z1b_F_LSB	1Ah	00h	Zone 1b (CPU1) extended resolution filtered temperature value register, least-significant-byte
	Z1b_F_MSB	1Bh	00h	Zone 1b (CPU1) extended resolution filtered temperature value register, most-significant byte
	Z2a_F_LSB	1Ch	00h	Zone 2a (CPU2) extended resolution filtered temperature value register, least-significant-byte
	Z2a_F_MSB	1Dh	00h	Zone 2a (CPU2) extended resolution filtered temperature value register, most-significant byte
	Z2b_F_LSB	1Eh	00h	Zone 2b (CPU2) extended resolution filtered temperature value register, least-significant-byte
	Z2b_F_MSB	1Fh	00h	Zone 2b (CPU2) extended resolution filtered temperature value register, most-significant byte
	Z3_LSB	20h	00h	Zone 3 (Internal) extended resolution temperature value register, least-significant byte
	Z3_MSB	21h	00h	Zone 3 (Internal) extended resolution temperature value register, least-significant byte
	Z4_LSB	22h	00h	Zone 4 (External Digital) extended resolution temperature value register, most-significant byte
	Z4_MSB	23h	00h	Zone 4 (External Digital) extended resolution temperature value register, least-significant byte
	Reserved	24h-30h	N/D	
PI LO	 OOP AND FAN CONTROL SETUP RI	 EGISTERS		
(Temperature Source Select	31h	00h	Selects the temperature source for some temperature zones.
(PWM Filter Settings	32h	00h	Sets the IIR filter coefficients for the PWM outputs for low resolution sources
(PWM1 Filter Shutoff Threshold	33h	00h	PWM1 Filter Shutoff Threshold
`	1 WWIT Filler Struton Threshold			
	PWM2 Filter Shutoff Threshold	34h	00h	PWM2 Filter Shutoff Threshold
(_	00h 30h	PWM2 Filter Shutoff Threshold PI/LUT fan control binding configuration
(PWM2 Filter Shutoff Threshold	34h		
(PWM2 Filter Shutoff Threshold PI/LUT Fan Control Bindings PI Controller Minimum PWM and	34h 35h	30h	PI/LUT fan control binding configuration
((PWM2 Filter Shutoff Threshold PI/LUT Fan Control Bindings PI Controller Minimum PWM and Hysteresis	34h 35h 36h	30h 00h	PI/LUT fan control binding configuration PI Controller Minimum PWM and Hysteresis settings
((PWM2 Filter Shutoff Threshold PI/LUT Fan Control Bindings PI Controller Minimum PWM and Hysteresis Zone 1 Tcontrol	34h 35h 36h 37h	30h 00h 00h	PI/LUT fan control binding configuration PI Controller Minimum PWM and Hysteresis settings Zone 1 (CPU1) PI Controller Target Temperature (Tcontrol)
((PWM2 Filter Shutoff Threshold PI/LUT Fan Control Bindings PI Controller Minimum PWM and Hysteresis Zone 1 Tcontrol Zone 2 Tcontrol	34h 35h 36h 37h 38h	30h 00h 00h 00h	PI/LUT fan control binding configuration PI Controller Minimum PWM and Hysteresis settings Zone 1 (CPU1) PI Controller Target Temperature (Tcontrol) Zone 2 (CPU2) PI Controller Target Temperature (Tcontrol)
< < < < < < < < < < < < < < < < < < <	PWM2 Filter Shutoff Threshold PI/LUT Fan Control Bindings PI Controller Minimum PWM and Hysteresis Zone 1 Tcontrol Zone 2 Tcontrol Zone 1 Toff	34h 35h 36h 37h 38h 39h	30h 00h 00h 00h 80h	PI/LUT fan control binding configuration PI Controller Minimum PWM and Hysteresis settings Zone 1 (CPU1) PI Controller Target Temperature (Tcontrol) Zone 2 (CPU2) PI Controller Target Temperature (Tcontrol) Zone 1 (CPU1) PI Controller Off Temperature (Toff)
< < < < < < < < < < < < < < < < < < <	PWM2 Filter Shutoff Threshold PI/LUT Fan Control Bindings PI Controller Minimum PWM and Hysteresis Zone 1 Tcontrol Zone 2 Tcontrol Zone 1 Toff Zone 2 Toff	34h 35h 36h 37h 38h 39h 3Ah	30h 00h 00h 00h 80h 80h	PI/LUT fan control binding configuration PI Controller Minimum PWM and Hysteresis settings Zone 1 (CPU1) PI Controller Target Temperature (Tcontrol) Zone 2 (CPU2) PI Controller Target Temperature (Tcontrol) Zone 1 (CPU1) PI Controller Off Temperature (Toff) Zone 2 (CPU2) PI Controller Off Temperature (Toff)
(((((((((((((((((((PWM2 Filter Shutoff Threshold PI/LUT Fan Control Bindings PI Controller Minimum PWM and Hysteresis Zone 1 Tcontrol Zone 2 Tcontrol Zone 1 Toff Zone 2 Toff P Coefficient	34h 35h 36h 37h 38h 39h 3Ah 3Bh	30h 00h 00h 00h 80h 80h 00h	PI/LUT fan control binding configuration PI Controller Minimum PWM and Hysteresis settings Zone 1 (CPU1) PI Controller Target Temperature (Tcontrol) Zone 2 (CPU2) PI Controller Target Temperature (Tcontrol) Zone 1 (CPU1) PI Controller Off Temperature (Toff) Zone 2 (CPU2) PI Controller Off Temperature (Toff) PI controller proportional coefficient
(((((((((((((((((((PWM2 Filter Shutoff Threshold PI/LUT Fan Control Bindings PI Controller Minimum PWM and Hysteresis Zone 1 Tcontrol Zone 2 Tcontrol Zone 1 Toff Zone 2 Toff P Coefficient I Coefficient	34h 35h 36h 37h 38h 39h 3Ah 3Bh 3Ch	30h 00h 00h 00h 80h 80h 00h	PI/LUT fan control binding configuration PI Controller Minimum PWM and Hysteresis settings Zone 1 (CPU1) PI Controller Target Temperature (Tcontrol) Zone 2 (CPU2) PI Controller Target Temperature (Tcontrol) Zone 1 (CPU1) PI Controller Off Temperature (Toff) Zone 2 (CPU2) PI Controller Off Temperature (Toff) PI controller proportional coefficient PI controller integral coefficient
(((((((((((((((((((PWM2 Filter Shutoff Threshold PI/LUT Fan Control Bindings PI Controller Minimum PWM and Hysteresis Zone 1 Tcontrol Zone 2 Tcontrol Zone 1 Toff Zone 2 Toff P Coefficient I Coefficient PI Exponents	34h 35h 36h 37h 38h 39h 3Ah 3Bh 3Ch	30h 00h 00h 00h 80h 80h 00h	PI/LUT fan control binding configuration PI Controller Minimum PWM and Hysteresis settings Zone 1 (CPU1) PI Controller Target Temperature (Tcontrol) Zone 2 (CPU2) PI Controller Target Temperature (Tcontrol) Zone 1 (CPU1) PI Controller Off Temperature (Toff) Zone 2 (CPU2) PI Controller Off Temperature (Toff) PI controller proportional coefficient PI controller integral coefficient
(((((((((((((((((((PWM2 Filter Shutoff Threshold PI/LUT Fan Control Bindings PI Controller Minimum PWM and Hysteresis Zone 1 Tcontrol Zone 2 Tcontrol Zone 2 Toff P Coefficient I Coefficient PI Exponents ICE IDENTIFICATION REGISTERS	34h 35h 36h 37h 38h 39h 3Ah 3Bh 3Ch 3Dh	30h 00h 00h 00h 80h 80h 00h 00h	PI/LUT fan control binding configuration PI Controller Minimum PWM and Hysteresis settings Zone 1 (CPU1) PI Controller Target Temperature (Tcontrol) Zone 2 (CPU2) PI Controller Target Temperature (Tcontrol) Zone 1 (CPU1) PI Controller Off Temperature (Toff) Zone 2 (CPU2) PI Controller Off Temperature (Toff) PI controller proportional coefficient PI controller integral coefficient PI controller coefficient exponents

oc.	Register Name 查询"LM94"供应商	Address	Default	Description
	B_Error Status 1	40h	00h	BMC error status register 1
	B_Error Status 2	41h	00h	BMC error register 2
	B_Error Status 3	42h	00h	BMC error register 3
	B_Error Status 4	43h	00h	BMC error register 4
	B_P1_PROCHOT Error Status	44h	00h	BMC error register for P1_PROCHOT
	B_P2_PROCHOT Error Status	45h	00h	BMC error register for P2_PROCHOT
	B_GPI Error Status	46h	00h	BMC error register for GPIs
	B_Fan Error Status	47h	00h	BMC error register for Fans
IOS	T ERROR STATUS REGISTERS			
	H_Error Status 1	48h	00h	HOST error status register 1
	H_Error Status 2	49h	00h	HOST error register 2
	H_Error Status 3	4Ah	00h	HOST error register 3
	H_Error Status 4	4Bh	00h	HOST error register 4
	H_P1_PROCHOT Error Status	4Ch	00h	HOST error register for P1_PROCHOT
	H_P2_PROCHOT Error Status	4Dh	00h	HOST error register for P2_PROCHOT
	H_GPI Error Status	4Eh	00h	HOST error register for GPIs
	H_Fan Error Status	4Fh	00h	HOST error register for Fans
/ALI	JE REGISTERS SECTION 2			
	Zone 1a (CPU1) Temp	50h	00h	Measured value of remote thermal diode temperature channel 1a
	Zone 2a (CPU2) Temp	51h	00h	Measured value of remote thermal diode temperature channel 2a
	Zone 3 (Internal) Temp	52h	00h	Measured temperature from on-chip sensor
	Zone 4 (External Digital) Temp	53h	00h	Measured temperature from external temperature sensor
	Zone 1a (CPU1) Filtered Temp	54h	00h	Filtered value of remote thermal diode temperature channel 1a
	Zone 2a (CPU2) Filtered Temp	55h	00h	Filtered value of remote thermal diode temperature channel 2a
	AD_IN1 Voltage	56h	N/D	Measured value of AD_IN1
	AD_IN2 Voltage	57h	N/D	Measured value of AD_IN2
	AD_IN3 Voltage	58h	N/D	Measured value of AD_IN3
	AD_IN4 Voltage	59h	N/D	Measured value of AD_IN4
	AD_IN5 Voltage	5Ah	N/D	Measured value of AD_IN5
	AD_IN6 Voltage	5Bh	N/D	Measured value of AD_IN6
	AD_IN7 Voltage	5Ch	N/D	Measured value of AD_IN7
	AD_IN8 Voltage	5Dh	N/D	Measured value of AD_IN8
	AD_IN9 Voltage	5Eh	N/D	Measured value of AD_IN9
	AD_IN10 Voltage	5Fh	N/D	Measured value of AD_IN10
	AD_IN11 Voltage	60h	N/D	Measured value of AD_IN11
	AD_IN12 Voltage	61h	N/D	Measured value of AD_IN12
	AD_IN13 Voltage	62h	N/D	Measured value of AD_IN13
	AD_IN14 Voltage	63h	N/D	Measured value of AD_IN14
	AD_IN15 Voltage	64h	N/D	Measured value of AD_IN15
	AD_IN16 Voltage	65h	N/D	Measured value of AD_IN16 (V _{DD} 3.3V S/B)
	//LE_intro vollage	0011	14/2	The desired value of the _intro (VBD ole V ole Z)
	Reserved	66h	N/D	
	rieserveu	0011	IN/D	
	Current P1_PROCHOT	67h	00h	Measured P1_PROCHOT throttle percentage
	Average P1_PROCHOT	68h	00h	Average P1_PROCHOT throttle percentage
	Current P2_PROCHOT			
	Average P2_PROCHOT	69h	00h	Measured P2_PROCHOT throttle percentage
	Average F2_FNUURUT	6Ah	00h	Average P2_PROCHOT throttle percentage
	ODI Otata	OD!	001-	O ODIO -t-t-
	GPI State	6Bh	00h	Current GPIO state

Loc	Register Name	Address	Default	Description
查询	LM94"供应商			
	P1_VID	6Ch	00h	Current VID value of Processor 1
	P2_VID	6Dh	00h	Current VID value of Processor 2
	FAN Tach 1 LSB	6Eh	00h	Measured FAN Tach 1 LSB
	FAN Tach 1 MSB	6Fh	00h	Measured FAN Tach 1 MSB
	FAN Tach 2 LSB	70h	00h	Measured FAN Tach 2 LSB
	FAN Tach 2 MSB	71h	00h	Measured FAN Tach 2 MSB
	FAN Tach 3 LSB	72h	00h	Measured FAN Tach 3 LSB
	FAN Tach 3 MSB	73h	00h	Measured FAN Tach 3 MSB
	FAN Tach 4 LSB	74h	00h	Measured FAN Tach 4 LSB
	FAN Tach 4 MSB	75h	00h	Measured FAN Tach 4 MSB
	Reserved	76h-77h	N/D	
	1.000.700	1		
TEM	PERATURE LIMIT REGISTERS			
	Zone 1 (CPU1) Low Temp	78h	80h	Low limit for external thermal diode temperature channel 1 (D1) measurement
	Zone 1 (CPU1) High Temp	79h	80h	High limit for external thermal diode temperature channel 1 (D1) measurement
	Zone 2 (CPU2) Low Temp	7Ah	80h	Low limit for external thermal diode temperature channel 2 (D2) measurement
	Zone 2 (CPU2) High Temp	7Bh	80h	High limit for external thermal diode temperature channel 2 (D2) measurement
	Zone 3 (Internal) Low Temp	7Ch	80h	Low limit for local temperature measurement
	Zone 3 (Internal) High Temp	7Dh	80h	High limit for local temperature measurement
	Zone 4 (External Digital) Low Temp	7Eh	80h	Low limit for external digital temperature sensor
	Zone 4 (External Digital) High Temp	7Fh	80h	High limit for external digital temperature sensor
x	Fan Boost Temp Zone 1	80h	3Ch	Zone 1 (CPU1) fan boost temperature
<u>x</u>	Fan Boost Temp Zone 2	81h	3Ch	Zone 2 (CPU2) fan boost temperature
<u>x</u>	Fan Boost Temp Zone 3	82h	23h	Zone 3 (Internal) fan boost temperature
<u>x</u>	Fan Boost Temp Zone 4	83h	23h	Zone 4 (External Digital) fan boost temperature
	Zone1 and Zone 2 Hysteresis	84h	00h	Zone 1 and Zone 2 hysteresis for limit comparisons
	Zone 3 and Zone 4 Hysteresis	85h	00h	Zone 3 and Zone 4 hysteresis for limit comparisons
	Zono o una Zono i riyotorodo	0011	00.1	Zono o ana Zono i mysterosio isi mini compansono
	Reserved	86h-8Dh	N/D	
70	- 46 4 06 TEMPER 47 17 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7			
ZONE	E 1b and 2b TEMPERATURE READIN	1		I
	Zone 1b Temp Adjust	8Eh	00h	Allows all Zone 1b temperature measurements to be adjusted by a programmable offset.
	Zone 2b Temp Adjust	8Fh	00h	Allows all Zone 2b temperature measurements to be adjusted by a programmable offset.
ОТНЕ	ER LIMIT REGISTERS		!	[
	AD_IN1 Low Limit	90h	00h	Low limit for analog input 1 measurement
	AD_IN1 High Limit	91h	FFh	High limit for analog input 1 measurement
	AD_IN2 Low Limit	92h	00h	Low limit for analog input 2 measurement
	AD_IN2 High Limit	93h	FFh	High limit for analog input 2 measurement
	AD_IN3 Low Limit	94h	00h	Low limit for analog input 3 measurement
	IAD_ING LOW LITTIE			

Loc k	Register Name 查询"LM94"供应商	Address	Default	Description
	AD_IN4 Low Limit	96h	00h	Low limit for analog input 4 measurement
	AD_IN4 High Limit	97h	FFh	High limit for analog input 4 measurement
	AD_IN5 Low Limit	98h	00h	Low limit for analog input 5 measurement
	AD_IN5 High Limit	99h	FFh	High limit for analog input 5 measurement
	AD_IN6 Low Limit	9Ah	00h	Low limit for analog input 6 measurement
	AD_IN6 High Limit	9Bh	FFh	High limit for analog input 6 measurement
	AD_IN7 Low Limit	9Ch	00h	Low limit for analog input 7 measurement
	AD_IN7 High Limit	9Dh	FFh	High limit for analog input 7 measurement
-	AD_IN8 Low Limit	9Eh	00h	Low limit for analog input 8 measurement
	AD_IN8 High Limit	9Fh	FFh	High limit for analog input 8 measurement
	AD_IN9 Low Limit	A0h	00h	Low limit for analog input 9 measurement
	AD_IN9 High Limit	A1h	FFh	High limit for analog input 9 measurement
	AD_IN10 Low Limit	A2h	00h	Low limit for analog input 10 measurement
	AD_IN10 High Limit	A3h	FFh	High limit for analog input 10 measurement
	AD_IN11 Low Limit	A4h	00h	Low limit for analog input 11 measurement
	AD_IN11 High Limit	A5h	FFh	High limit for analog input 11 measurement
	AD_IN12 Low Limit	A6h	00h	Low limit for analog input 12 measurement
	AD_IN12 High Limit	A7h	FFh	High limit for analog input 12 measurement
	AD_IN13 Low Limit	A8h	00h	Low limit for analog input 13 measurement
	AD_IN13 High Limit	A9h	FFh	High limit for analog input 13 measurement
	AD_IN14 Low Limit	AAh	00h	Low limit for analog input 14 measurement
-	AD_IN14 High Limit	ABh	FFh	High limit for analog input 14 measurement
-	AD_IN15 Low Limit	ACh	00h	Low limit for analog input 15 measurement
	AD_IN15 High Limit	ADh	FFh	High limit for analog input 15 measurement
	AD_IN16 Low Limit	AEh	00h	Low limit for analog input 16 measurement
	AD_IN16 High Limit	AFh	FFh	High limit for analog input 16 measurement
	P1_PROCHOT User Limit	B0h	FFh	User settable limit for P1_PROCHOT
	P2_PROCHOT User Limit	B1h	FFh	User settable limit for P2_PROCHOT
	Vccp1 Limit Offsets	B2h	17h	VID offset values for window comparator for CPU1 Vccp (AD_IN7)
	Vccp2 Limit Offsets	B3h	17h	VID offset values for window comparator for CPU2 Vccp (AD_IN8)
	FAN Tach 1 Limit LSB	B4h	FCh	FAN Tach 1 Limit LSB
	FAN Tach 1 Limit MSB	B5h	FFh	FAN Tach 1 Limit MSB
	FAN Tach 2 Limit LSB	B6h	FCh	FAN Tach 2 Limit LSB
	FAN Tach 2 Limit MSB	B7h	FFh	FAN Tach 2 Limit MSB
	FAN Tach 3 Limit LSB	B8h	FCh	FAN Tach 3 Limit LSB
	FAN Tach 3 Limit MSB	B9h	FFh	FAN Tach 3 Limit MSB
	FAN Tach 4 Limit LSB	BAh	FCh	FAN Tach 4 Limit LSB
	FAN Tach 4 Limit MSB	BBh	FFh	FAN Tach 4 Limit MSB
SETU	IP REGISTERS	!		
	Special Function Control 1	BCh	00h	Controls the hysteresis for voltage limit comparisons. Also selects
				filtered or unfiltered temperature usage for temperature limit
				comparisons and fan control.
	Special Function Control 2	BDh	00h	Enables smart tach detection. Also selects 0.5°C or 1.0°C resolution
				for fan control.
Х	GPI / VID Level Control	BEh	00h	Control the input threshold levels for the P1_VIDx, P2_VIDx and GPIO_x inputs.

Loc 査询	Register Name 'LM94"供应商	Address	Default	Description
x	PWM Ramp Control	BFh	00h	Controls the ramp rate of the PWM duty cycle when VRDx_HOT is asserted, as well as the ramp rate when PROCHOT exceeds the user threshold.
x	Fan Boost Hysteresis (Zones 1/2)	C0h	44h	Fan Boost Hysteresis for zones 1 and 2
x	Fan Boost Hysteresis (Zones 3/4)	C1h	44h	Fan Boost Hysteresis for zones 3 and 4
х	Zones 1/2 Spike Smoothing Control	C2h	00h	Configures Spike Smoothing for zones 1 and 2
х	LUT 1/2 MinPWM and Hysteresis	C3h	00h	Controls MinPWM and hysteresis setting for LUT 1 and 2 auto-fan control
x	LUT 3/4 MinPWM and Hysteresis	C4h	00h	Controls MinPWM and hysteresis setting for LUT 3 and 4 auto-fan control
	GPO	C5h	00h	Controls the output state of the GPIO pins
	PROCHOT Control	CCh	00h	Controls assertion of P1_PROCHOT or P2_PROCHOT
	PROCHOT Time Interval	C6h C7h	11h	Configures the time window over which the PROCHOT inputs are measured
	PWM1 Control 1	COb	006	Controls DWM control source hindings
<u>x</u>		C8h	00h	Controls PWM control source bindings.
X	PWM1 Control 2	C9h	00h	Controls PWM override and output polarity
X	PWM1 Control 3 PWM1 Control 4	CAh CBh	00h 00h	Controls PWM spin-up duration and duty cycle
<u>x</u>	PWWI Control 4	CBn	oon	Frequency control for PWM1.
x	PWM2 Control 1	CCh	00h	Controls PWM control source bindings.
х	PWM2 Control 2	CDh	00h	Controls PWM override and output polarity
х	PWM2 Control 3	CEh	00h	Controls PWM spin-up duration and duty cycle
x	PWM2 Control 4	CFh	00h	Frequency control for PWM2
<u>x</u>	LUT 1 Base Temperature	D0h	00h	Base temperature to which look-up table offset is applied for LUT 1
$\frac{\hat{x}}{x}$	LUT 2 Base Temperature	D1h	00h	Base temperature to which look-up table offset is applied for LUT 2
$\frac{\lambda}{x}$	LUT 3 Base Temperature	D2h	00h	Base temperature to which look-up table offset is applied for LUT 3
$\frac{\lambda}{x}$	LUT 4 Base Temperature	D3h	00h	Base temperature to which look-up table offset is applied for LUT 4
	201 1 Bass 16mpstatato		00.1	Sass temperature to minor rook up table effect to applied for 2011.
х	Step 2 Temp Offset	D4h	00h	Step 2 LUT 1/2 and LUT 3/4 Offset Temperatures
x	Step 3 Temp Offset	D5h	00h	Step 3 LUT 1/2 and LUT 3/4 Offset Temperatures
х	Step 4 Temp Offset	D6h	00h	Step 4 LUT 1/2 and LUT 3/4 Offset Temperatures
х	Step 5 Temp Offset	D7h	00h	Step 5 LUT 1/2 and LUT 3/4 Offset Temperatures
х	Step 6 Temp Offset	D8h	00h	Step 6 LUT 1/2 and LUT 3/4 Offset Temperatures
х	Step 7 Temp Offset	D9h	00h	Step 7 LUT 1/2 and LUT 3/4 Offset Temperatures
х	Step 8 Temp Offset	DAh	00h	Step 8 LUT 1/2 and LUT 3/4 Offset Temperatures
х	Step 9 Temp Offset	DBh	00h	Step 9 LUT 1/2 and LUT 3/4 Offset Temperatures
х	Step 10 Temp Offset	DCh	00h	Step 10 LUT 1/2 and LUT 3/4 Offset Temperatures
х	Step 11 Temp Offset	DDh	00h	Step 11 LUT 1/2 and LUT 3/4 Offset Temperatures
х	Step 12 Temp Offset	DEh	00h	Step 12 LUT 1/2 and LUT 3/4 Offset Temperatures
x	Step 13 Temp Offset	DFh	00h	Step 13 LUT 1/2 and LUT 3/4 Offset Temperatures
	TACH to PWM Binding	E0h	00h	Controls the tachometer input to PWM output binding
x	Tach Boost Control	E1h	3Fh	Controls the fan boost function upon a tach error
X	LM94 Status/Control	E2h	00h	Gives Master error status, ASF reset control and Max PWM control
x	LM94 Configuration	E3h	00h	Configures various outputs and provides START bit

ОС	Register Name 查询"LM94"供应商	Address	Default	Description
LEE	EP STATE CONTROL AND MASK R	EGISTERS	l	
	Sleep State Control	E4h	03h	Used to communicate the system sleep state to the LM94
	S1 GPI Mask	E5h	FFh	Sleep state S1 GPI error mask register
	S1 Fan Mask	E6h	0Fh	Sleep state S1 fan tach error mask register
	S3 GPI Mask	E7h	FFh	Sleep state S3 GPI error mask register
	S3 Fan Mask	E8h	0Fh	Sleep state S3 fan tach error mask register
	S3 Temperature/Voltage Mask	E9h	07h	Sleep state S3 temperature or voltage error mask register
	S4/5 GPI Mask	EAh	FFh	Sleep state S4/5 GPI error mask register
	S4/5 Temperature/Voltage Mask	EBh	07h	Sleep state S4/5 temperature or voltage error mask register
THI	ER MASK REGISTERS			
	GPI Error Mask	ECh	FFh	Error mask register for GPI faults
	Miscellaneous Error Mask	EDh	3Fh	Error mask register for VRDx_HOT, GPI, and dynamic Vccp limit
				checking.
ONI	E 1a AND 2a TEMPERATURE READ	ING ADJUS	TMENT R	EGISTERS
	Zone 1a Temp Adjust	EEh	00h	Allows all Zone 1a temperature measurements to be adjusted by
				programmable offset
	Zone 2a Temp Adjust	EFh	00h	Allows all Zone 2a temperature measurements to be adjusted by
	OK COMMANDO			programmable offset
LU	CK COMMANDS	Tol-	INI/A	OMP Plank Write Common and Conde
	Block Write Command	F0h	N/A	SMBus Block Write Command Code
	Block Read Command	F1h	N/A	SMBus Block Write/Read Process call
	Fixed Block 0	F2h	N/A	Fixed block code address 40h, size 8 bytes
	Fixed Block 1	F3h	N/A	Fixed block code address 48h, size 8 bytes
	Fixed Block 2	F4h	N/A	Fixed block code address 50h, size 6 bytes
	Fixed Block 3	F5h	N/A	Fixed block code address 56h, size 16 bytes
	Fixed Block 4	F6h	N/A	Fixed block code address 67h, size 4 bytes
	Fixed Block 5	F7h	N/A	Fixed block code address 6Eh, size 8 bytes
	Fixed Block 6	F8h	N/A	Fixed block code address 78h, size 12 bytes
	Fixed Block 7	F9h	N/A	Fixed block code address 90h, size 32 bytes
	Fixed Block 8	FAh	N/A	Fixed block code address B4h, size 8 bytes
	Fixed Block 9	FBh	N/A	Fixed block code address C8h, size 8 bytes
	Fixed Block 10	FCh	N/A	Fixed block code address D0h, size 16 bytes
	Fixed Block 11	FDh	N/A	Fixed block code address E5h, size 9 bytes
	Reserved	FEh-FFh	N/A	Reserved for future commands

16.3 FACTORY REGISTERS 00h-04h

查询."J-M94":供应商 xor Test

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
00h	R/W	XOR Test	RES								00h

Bit	Name	R/W	Default	Description	Sleep Masking
0	XEN	R/W	0	The LM94 incorporates an XOR tree test mode. When the test mode is enabled by setting this bit, the part enters XOR test mode. Clearing this bit brings the part out of XOR test mode.	N/A
7:1	RES	R	0	Reserved	N/A

16.3.2 Register 01h SMBus Test

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
01h	R/W	SMBus Test	7	6	5	4	3	2	1	0	00h

This register can be used to verify that the SMBus can read and write to the device without effecting any programmed settings.

16.3.3 "REMOTE DIODE" MODE SELECT

16.3.3.1 Register 05h Remote-Diode Transistor Mode Select

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
05h	R/W	Transistor Mode Select	RES	RES	RES	RES	P2b_T_E N	P2a_T_E N	P1b_T_E N	P1a_T_E N	00h

Bit	Name	R/W	Description
0	P1a_T_EN	R/W	If set, Processor 1 Remote-Diode "a" Transistor Mode enabled.
1	P1b_T_EN	R/W	If set, Processor 1 Remote-Diode "b" Transistor Mode enabled.
2	P2a_T_EN	R/W	If set, Processor 2 Remote-Diode "a" Transistor Mode enabled.
3	P2b_T_EN	R/W	If set, Processor 2 Remote-Diode "b" Transistor Mode enabled.
7:4	RES	R	Reserved

16.4 VALUE REGISTERS SECTION 1

16.4.1 Registers 06-07h and 50-53h Unfiltered Temperature Value Registers

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
06h	R	Zone 1b (CPU1) Temp	7	6	5	4	3	2	1	0	00h
07h	R	Zone 2b (CPU2) Temp	7	6	5	4	3	2	1	0	00h
50h	R	Zone 1a (CPU1) Temp	7	6	5	4	3	2	1	0	00h
51h	R	Zone 2a (CPU2) Temp	7	6	5	4	3	2	1	0	00h
52h	R	Zone 3 (Internal) Temp	7	6	5	4	3	2	1	0	00h
53h	R/W	Zone 4 (External Digital) Temp	7	6	5	4	3	2	1	0	00h

Zones 1 and 2 are all automatically updated by the LM94. The Zone 3 (Internal) Temp and Zone 4 (External Digital) Temp registers may be written by an external SMBus device or can be assigned to AD_IN11 and AD_IN15, respectively.

The temperature registers for zones 1 and 2 will return a value of 80h if the remote diode pins are not implemented by the board designer or are not functioning properly.

16.4.2 Registers 08–09h and 54–55h Filtered Temperature Value Registers

Register Address	I H94 Read/ Write	<mark>供应商</mark> Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
08h	R	Zone 1b (CPU1) Filtered Temp	7	6	5	4	3	2	1	0	00h
09h	R	Zone 2b (CPU2) Filtered Temp	7	6	5	4	3	2	1	0	00h
54h	R	Zone 1a (CPU1) Filtered Temp	7	6	5	4	3	2	1	0	00h
55h	R	Zone 2a (CPU2) Filtered Temp	7	6	5	4	3	2	1	0	00h

These registers reflect the temperature of zones 1 and 2 after the spike smoothing filter has been applied.

The characteristics of the filtering can be adjusted by using the Zones 1/2 Spike Smoothing Control register.

16.4.3 Register 0Ah and 0Bh PWM1 and PWM2 8-bit Duty Cycle Value

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
0Ah	R	PWM1 Duty Cycle Value	7	6	5	4	3	2	1	0	00h
0Bh	R	PWM2 Duty Cycle Value	7	6	5	4	3	2	1	0	00h

These registers report the current duty cycle being driven on the PWM1 or PWM2 outputs. It is the upper 8 bits of the 9-bit PWM value. It reflects the maximum duty cycle of any low-resolution or high-resolution PWM sources bound to the PWM1 or PWM2 outputs.

16.5 PWM Duty Cycle Overide Registers

16.5.1 Register 0Ch PWM1 Duty Cycle Override (low byte)

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
0Ch	R/W	PWM1 Duty Cycle	PWM1_	PWM1_	RES	RES	RES	RES	RES	RES	00h
		Override (low byte)	DC[0]	EN_Hres							
				_Over							

Bit	Name	R/W	Description
5:0	RES	R	Reserved
6	PWM1_EN_Hres_Over		When this bit is set, high-resolution override for PWM1 is enabled. When this bit is set, PWM1 will run at the programmed duty cycle: PWM1_DC [8:0]/256 * 100%; values over 100h are reserved.
7	PWM1_DC[0]	R/W	When this bit is set, bit [0] of the override duty cycle for PWM1 is set.

If manual PWM1 override is enabled in this register, all other PWM1 bindings are disabled except for the 100% override in the LM94 Status Control register (E2h).

16.5.2 Register 0Dh PWM1 Duty Cycle Override (high byte)

李冶"LL	104"/## 15	7 萬											
Register	Read)	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default		
Address	Write	_									Value		
0Dh	R/W	PWM1 Duty Cycle		PWM1_DC[8:1]									
		Override (high											
		byte)											

These bits set the upper 8-bits of the 9-bit override duty cycle value for PWM1.

16.5.3 Register 0Eh PWM2 Duty Cycle Override (low byte)

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
0Eh	R/W	PWM 2 Duty Cycle Override (low byte)	_	PWM2_ EN_Hre s _Over	RES	RES	RES	RES	RES	RES	00h

Bit	Name	R/W	Description
5:0	RES	R	Reserved
6	PWM2_EN_Hres_Over		When this bit is set, high-resolution override for PWM2 is enabled. When this bit is set, PWM2 will run at the programmed duty cycle: PWM2_DC [8:0]/256 * 100%; values over 100h are reserved.
7	PWM2_DC[0]	R/W	When this bit is set, bit [0] of the override duty cycle for PWM2 is set.

If manual PWM 2 override is enabled in this register, all other PWM 2 bindings are disabled except for the 100% override in the LM94 Status Control register (E2h).

16.5.4 Register 0Fh PWM2 Duty Cycle Override (high byte)

Register		Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default
Address	Write										Value
0Fh	R/W	PWM2 Duty Cycle Override (high byte)				PWM2_	DC[8:1]				00h

These bits set the upper 8-bits of the 9-bit override duty cycle value for PWM2.

16.6 EXTENDED RESOLUTION VALUE REGISTERS

16.6.1 Registers 10h - 17h Zone 1 (CPU1) and Zone 2 (CPU2) Extended Resolution Unfiltered Temperature Value Registers, Most and Least Significant Bytes

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
10h	R	Z1a_LSB	0.5	0	0	0	0	0	0	0	00h
11h	R	Z1a_MSB	Sign	64	32	16	8	4	2	1	00h

Register 11h is a mirror of register Zone 1a (CPU1) Temp at address 50h.

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
12h	R	Z1b_LSB	0.5	0	0	0	0	0	0	0	00h
13h	R	Z1b_MSB	Sign	64	32	16	8	4	2	1	00h

Register 13h is a mirror of register Zone 1b (CPU1) Temp at address 06h.

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
14h	R	Z2a_LSB	0.5	0	0	0	0	0	0	0	00h
15h	R	Z2a_MSB	Sign	64	32	16	8	4	2	1	00h

Register 15h is a mirror of register Zone 2a (CPU2) Temp at address 51h.

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
16h	R	Z2b_LSB	0.5	0	0	0	0	0	0	0	00h
17h	R	Z2b_MSB	Sign	64	32	16	8	4	2	1	00h

Register 17h is a mirror of register Zone 2b (CPU2) Temp at address 07h.

16.6.2 Registers 18h – 1Fh Zone 1 (CPU1) and Zone 2 (CPU2) Extended Resolution Filtered Value Registers, Most and September 18th – 1Fh Zone 1 (CPU1) and Zone 2 (CPU2) Extended Resolution Filtered Value Registers, Most and

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
18h	R	Z1a_F_LSB	0.5	0.25	0.125	0.0625	0	0	0	0	00h
19h	R	Z1a_F_MSB	Sign	64	32	16	8	4	2	1	00h

Register 19h is a mirror of register Zone 1a (CPU1) Filtered Temp at address 54h.

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
1Ah	R	Z1b_F_LSB	0.5	0.25	0.125	0.0625	0	0	0	0	00h
1Bh	R	Z1b_F_MSB	Sign	64	32	16	8	4	2	1	00h

Register 1Bh is a mirror of register Zone 1b (CPU1) Filtered Temp at address 08h.

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
1Ch	R	Z2a_F_LSB	0.5	0.25	0.125	0.0625	0	0	0	0	00h
1Dh	R	Z2a_F_MSB	Sign	64	32	16	8	4	2	1	00h

Register 1Dh is a mirror of register Zone 2a (CPU2) Filtered Temp at address 55h.

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
1Eh	R	Z2b_F_LSB	0.5	0.25	0.125	0.0625	0	0	0	0	00h
1Fh	R	Z2b_F_MSB	Sign	64	32	16	8	4	2	1	00h

Register 1Fh is a mirror of register Zone 2b (CPU2) Filtered Temp at address 09h.

16.6.3 Registers 20h - 23h Zone 3 and Zone 4 Extended Resolution Value Registers, Most and Least Significant Bytes

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
20h	R/W	Z3_LSB	0.5	0	0	0	0	0	0	0	00h
21h	R/W	Z3_MSB	Sign	64	32	16	8	4	2	1	00h

Register 21h is a mirror of register Zone 3 (Internal) Temp at address 52h.

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
22h	R/W	Z4_LSB	0.5	0	0	0	0	0	0	0	00h
23h	R/W	Z4_MSB	Sign	64	32	16	8	4	2	1	00h

Register 23h is a mirror of register Zone 4 (External Digital) Temp at address 53h.

16.7 PI LOOP FAN CONTROL SETUP REGISTERS

Dogistor	Read/	Dogiotor Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default	
Register Address	Write	Register Name	BIL /	BILO	Біі э	Bit 4	Біі з	Bit 2	BILI	BILU	Value	
31h	R/W	Internal/ External	RES	RES	RES	INT_	Z2bE	Z1bE	EXT_	INT_	00h	
		Temperature				WR_E			AD15	AD11		
		Source Select										
					-	-	-		-	-		
Bit					Description	on						
0		INT_ADC11	R/	l	automatica	bit is set, thally updated	d with the v	alue from	the ADC_II	V11 Volta	ge Value	
					-	nus 128 by	•				-	
				1		required s				•	•	
				1		en this bit is			•	•	,	
						omatically u	•		•		-	
			the LM94's internal thermal diode. All functions related Temperature Register value are affected by this bit (LL Boost, etc.)									
										.010, 1011	porataro	
1		EXT ADC15	R/W When this bit is set, the External Digital Temperatu						mperature	reaister (Z	one 4) will	
		_			become read-only and will be automatically updated from the ADC_IN15							
					Voltage Value register minus 128 by inverting the MSb. Subtraction of 12 or inverting the MSb is required since the data in the temperature register							
					•	. When this			_			
					•	writable an		•		•		
						elated to th		-	•	register ar	e affected	
		741.5			-	(LUTs, Ten	-					
2		Z1bE	R/			bit is set, p			Hemote 10	input. wr	ien this bit	
		70h F				pin 23 is se			Damata Ob	. i.e.e \ \ / le	an thin hit	
3		Z2bE	"			bit is set, p pin 24 is se			nemote 20	input. Wr	ien mis dit	
4		INT WD E							ıra Valus "	ogiotor mas	bo	
4		INT_WR_E	"			bit is set, th		•		•	-	
						ıre Value re			All automatic updates of the Internal			
7:3		RES	-		Reserved	• • • • • • • • • • • • • • • • • •	29.0101 11111					
		1120		· '	.500.700							

16.7.2 Register 32h PWM Filter Settings

Register	Read/	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default
Address	Write										Value
32h	R/W	PWM_Filter	RES	FC	_PWM2[2	2:0]	RES	FC	_PWM1[2	2:0]	00h
		•	-				*	*			

Bit	Name	R/W	Description
2:0	FC_PWM1[2:0]	R/W	Sets the filter coefficient for the IIR filter on PWM1 low resolution sources.
3	RES	R	Reserved
6:4	FC_PWM2[2:0]	R/W	Sets the filter coefficient for the IIR filter on PWM2 low resolution sources.
7	RES	R	Reserved

FC_PWM1[2:0] or FC_PWM2[2:]	95% Settling Time Interval
000	Filter bypassed
001	0.098s
010	0.237s
011	0.510s
100	1.056s
101	2.147s

	FC_PWM1[2:0] or FC_PWM2[2:]	95% Settling Time Interval
查	间"LM94"供应商	4.328s
	111	8.689s

16.7.3 Register 33h PWM1 Filter Shutoff Threshold

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
33h	R/W	PWM1_Filter Shut_Thresh		PWM1_SHUT_DC[4:0]				RES	RES	RES	00h

Bit	Name	R/W	Description
2:0	RES	R	Reserved
7:3	PWM1_SHUT_DC[4:0]	R/W	Sets the filter shutoff threshold. The actual duty cycle threshold is 3.15% times this value. If the PWM filter is disabled the shutdown threshold is also disabled. The shutdown threshold allows the PWM1 output to be turned off for duty cycles less than the programmed value.

Bit [7:3]	9-bit Threshold	Corresponding Duty Cycle
0	0	0.000%
1	8	3.125%
2	16	6.25%
	-	•
29	232	90.625%
30	240	93.750%
31	248	96.875%

16.7.4 Register 34h PWM2 Filter Shutoff Threshold

Register Address		Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
34h	R/W	PWM2_Filter Shut_Thresh		PWM2	SHUT_C	C[4:0]		RES	RES	RES	00h

Bit	Name	R/W	Description
2:0	RES	R	Reserved
7:3	PWM2_SHUT_DC[4:0]	R/W	Sets the filter shutoff threshold. The actual duty cycle threshold is 3.15% times this value. If the PWM filter is disabled the shutdown threshold is also disabled. The shutdown threshold allows the PWM1 output to be turned off for duty cycles less than the programmed value.

Bit [7:3]	9-bit Threshold	Corresponding Duty Cycle
0	0	0.000%
1	8	3.125%
2	16	6.25%
·		
	·	
	·	·
29	232	90.625%
30	240	93.750%
31	248	96.875%

16.7.5 Register 35h PI/LUT Fan Control Bindings

Register Address	Read/	194"(共)	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
35h	R/W	Fan Control	LUT4	LUT3	LUT2	LUT1	PWM2	PWM1	PI_Z2	PI_Z1	30h
		Bindings	_Z2	_Z1	_Z2	_Z1	_PI	_PI			

Bit	Name	R/W	Description
0	PI_Z1	R/W	When this bit is set, the PI controller is bound to the P1 temperature (zone
			1). This also changes the available filtering options for the P1 temperature.
1	PI_Z2	R/W	When this bit is set, the PI controller is bound to the P2 temperature (zone
			2). This also changes the available filtering options for the P2 temperature
			zone.
2	PWM1_PI	R/W	When this bit is set, the PWM1 output is bound to the PI controller.
3	PWM2_PI	R/W	When this bit is set, the PWM2 output is bound to the PI controller.
4	LUT1_Z1	R/W	When this bit is set, LUT1 will use the P1 temperature (zone 1) instead of
			the Internal temperature (zone 3).
5	LUT2_Z2	R/W	When this bit is set, LUT2 will use the P2 temperature (zone2) instead of
			the External Digital temperature (zone 4).
6	LUT3_Z1	R/W	When this bit is set, LUT3 will use the P1 temperature (zone1) instead of
			the Internal temperature (zone 3).
7	LUT4_Z2	R/W	When this bit is set, LUT4 will use the P2 temperature (zone 2) instead of
			the External Digital temperature (zone 4).

16.7.6 Register 36h PI Controller Minimum PWM and Hysteresis

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
36h	R/W	PI MinPWM and Hyst	PI_MinPWM[3:0]					00h			
Bit		Name	В	/W D	escription	1	-				

BIT	Name	H/W	Description
3:0	PI_Hyst[3:0]	R/W	Sets the hysteresis for the PI Loop fan controller in 0.5°C steps up to 7.5°
			C.
7:4	PI_MinPWM[3:0]	R/W	Defines the minimum PWM output for the PI Loop fan controller in 6.25%
			steps up to 93.75%.

PI_Hyst[3:0]	Hysteresis (°C)
0h	0
1h	0.5
2h	1.0
3h	1.5
4h	2.0
5h	2.5
6h	3.0
7h	3.5
8h	4.0
9h	4.5
Ah	5.0
Bh	5.5
Ch	6.0
Dh	6.5
Eh	7.0
Fh	7.5

询"LM94"供应部_MinPWM [3:0]	Minimum Duty Cycle
0h	0.00%
1h	6.25%
2h	12.5%
3h	18.75%
4h	25.00%
5h	31.25%
6h	37.50%
7h	43.75%
8h	50.00%
9h	56.25%
Ah	62.50%
Bh	68.75%
Ch	75.00%
Dh	81.25%
Eh	87.5%
Fh	93.75%

16.7.7 Registers 37h and 38h Zone 1 and 2 PI Controller Target Temperature (Tcontrol)

Register Address		Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
37h	R/W	Zone 1 Tcontrol	7	6	5	4	3	2	1	0	00h
38h	R/W	Zone 2 Tcontrol	7	6	5	4	3	2	1	0	00h

Same format as temperature value register for Zone 1 and Zone 2. The PWM output controls the airflow over the processors and thus the temperature of the processors is adjusted by the PI loop to maintain the hottest Zone 1 or Zone 2 temperature reading between their respective values for Tcontrol and Tcontrol - hysteresis. Intel specifies an optimum Tcontrol temperature for some of it's processors that can be found in the MSR register space.

16.7.8 Register 39h and 3Ah Zone 1 and 2 PI Fan Control Off Temperature (Toff)

Register Address		Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
39h	R/W	Z1 Toff	7	6	5	4	3	2	1	0	80h
3Ah	R/W	Z2 Toff	7	6	5	4	3	2	1	0	80h

Same format as temperature value register for Zone 1 and Zone 2. When these registers are set to 80h, the Toff function is disabled. Toff is the temperature at which the PI control loop output is forced to zero duty cycle.

16.7.9 Register 3Bh Proportional Coefficient

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
3Bh	R/W	P Coefficient	7	6	5	4	3	2	1	0	00h

16.7.10 Register 3Ch Integral Coefficient

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
3Ch	R/W	I Coefficient	7	6	5	4	3	2	1	0	00h

16.7.11 Register 3Dh PI Coefficient Exponents

	本治" N	104"(卅広喜									
Register	Read/ N	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default
Address	Write										Value
3Dh	R/W	PI Exponents	RES	RES	RES	RES	PCE	[1:0]	ICE	[1:0]	00h

Bit	Name	R/W	Description
1:0	ICE[1:0]	R/W	PI controller integral coefficient exponent (2-bit signed value)
2:3	PCE[1:0]	R/W	PI controller proportional coefficient exponent (2-bit signed value)
7:4	RES	R	Reserved

ICE[1:0]	Integral Exponent
10b	-2
11b	-1
00b	0
01b	1

PCE[1:0]	Proportional Exponent
10b	-2
11b	-1
00b	0
01b	1

16.8 DEVICE IDENTIFICATION REGISTERS (3Eh-3Fh)

16.8.1 Register 3Eh Manufacturer ID

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
3Eh	R	Manufacturer ID	0	0	0	0	0	0	0	0	01h

The Manufacturer ID register contains the manufacturer identification number. This number is assigned by National Semiconductor and is a method for uniquely identifying the part manufacturer.

16.8.2 Register 3Fh Version/Stepping

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
3Fh	R	Version/Stepping		VER	[3:0]			STP	[3:0]		79h
			0	1	1	1	1	0	0	1	

The four least significant bits of the Version/Stepping register [3:0] contain the current stepping of the LM94 silicon. The four most significant bits [7:4] reflect the LM94 version number. The LM94 has a fixed version number of 0111b wich matches the LM93, since the LM94 is closely related to the LM93. To differentiat the LM94 from the LM93 for the first stepping of LM94 this register reads 01111000b. For the second stepping of the LM94, this register reads 01111001b and so on. It is incrementally increased for future versions for the silicon. The final released silicon has a stepping of 9h therefore this register reads 79h.

The register is used by application software to identify which device in the family of hardware monitoring ASICs has been implemented in the given system. Based on this information, software can determine which registers to read from and write to. Application software may use the current stepping to implement work-a-rounds for bugs found in a specific silicon stepping.

16.9 BMC ERROR STATUS REGISTERS 40h-47h

sets a given bit whenever the corresponding error event occurs. The BMC_ERR bit in the LM94 Status/Control register is also set if any bit in the BMC Error Status registers is set. If enabled, ALERT is also asserted anytime BMC_ERR is set. The exception to this is the fixed threshold error status bits in the PROCHOT Error Status registers. They have no influence on BMC_ERR or ALERT.

Once a bit is set in the BMC Error Status registers, it is not automatically cleared by the LM94 if the error event goes away. Each bit must be cleared by software. If software attempts to clear a bit while the error condition still exists, and the error is unmasked, the bit does not clear. If the error is masked, the bit can be cleared even if the error condition still exists.

If the LM94 is in ASF mode, the BMC Error Status registers are both read-to-clear and write-one-to-clear. When not in ASF mode, the registers are only write-one-to-clear.

Each register described in this section has a column labeled **Sleep Masking**. This column describes which error events are masked in various sleep states. The sleep state of the system is communicated to the LM94 by writing to the Sleep State Control register. If a sleep state in this column has a "* next to it, it denotes that the error event is optionally masked in that sleep mode, depending on the Sleep State Mask registers.

16.9.1 Register 40h B_Error Status 1

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
40h	RWC	B_Error Status 1	RI	RES		VRD1 _ERR	ZN4_ ERR	ZN3_ ERR	ZN2_ ERR	ZN1_ ERR	00h

Bit	Name	R/W	Description	Sleep Masking
0	ZN1_ERR	RWC	This bit is set when any zone 1 temperature has fallen outside its associated temperature limits.	S3*, S4/5*
1	ZN2_ERR	RWC	This bit is set when any zone 2 temperature has fallen outside its associated temperature limits.	S3*, S4/5*
2	ZN3_ERR	RWC	This bit is set when the zone 3 temperature has fallen outside the zone 3 temperature limits.	none
3	ZN4_ERR	RWC	This bit is set when the zone 4 temperature has fallen outside the zone 4 temperature limits.	none
4	VRD1_ERR	RWC	This bit is set when the VRD1_HOT input has been asserted.	S3, S4/5
5	VRD2_ERR	RWC	This bit is set when the VRD2_HOT# input has been asserted.	S3, S4/5
7:6	RES	R	Reserved	N/A

16.9.2 Register 41h B_Error Status 2

Register Address	Read/ Write	Règister Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
41h	RWC	B_Error Status 2	ADIN8 _ERR	ADIN7 _ERR	ADIN6 _ERR	ADIN5 _ERR	ADIN4 _ERR	ADIN3 _ERR	ADIN2 _ERR	ADIN1 _ERR	00h

Bit	Name	R/W	Description	Sleep Masking
0	AD1_ERR	RWC	This bit is set when the AD_IN1 voltage has fallen outside the range defined by the AD_IN1 Low Limit and the AD_IN1 High Limit registers.	S3, S4/5
1	AD2_ERR	RWC	This bit is set when the AD_IN2 voltage has fallen outside the range defined by the AD_IN2 Low Limit and the AD_IN2 High Limit registers.	S3, S4/5
2	AD3_ERR	RWC	This bit is set when the AD_IN3 voltage has fallen outside the range defined by the AD_IN3 Low Limit and the AD_IN3 High Limit registers.	S3, S4/5
3	AD4_ERR	RWC	This bit is set when the AD_IN4 voltage has fallen outside the range defined by the AD_IN4 Low Limit and the AD_IN4 High Limit registers.	S3, S4/5
4	AD5_ERR	RWC	This bit is set when the AD_IN5 voltage has fallen outside the range defined by the AD_IN5 Low Limit and the AD_IN5 High Limit registers.	S3, S4/5
5	AD6_ERR	RWC	This bit is set when the AD_IN6 voltage has fallen outside the range defined by the AD_IN6 Low Limit and the AD_IN6 High Limit registers.	S3, S4/5
6	AD7_ERR	RWC	This bit is set when the AD_IN7 voltage has fallen outside the range defined by the AD_IN7 Low Limit and the AD_IN7 High Limit registers.	S3, S4/5
7	AD8_ERR	RWC	This bit is set when the AD_IN8 voltage has fallen outside the range defined by the AD_IN8 Low Limit and the AD_IN8 High Limit registers.	S3, S4/5

16.9.3 Register 42h B_Error Status 3

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
42h	RWC	B_Error Status 3	ADIN16 ERR	ADIN15 ERR	ADIN14 ERR	ADIN13 ERR	ADIN12 ERR	ADIN11 ERR	ADIN10 ERR	ADIN9 ERR	00h

Bit	Name	R/W	Description	Sleep Masking
0	AD9_ERR	RWC	This bit is set when the AD_IN9 voltage has fallen outside the range defined by the AD_IN9 Low Limit and the AD_IN9 High Limit registers.	S3, S4/5
1	AD10_ERR	RWC	This bit is set when the AD_IN10 voltage has fallen outside the range defined by the AD_IN10 Low Limit and the AD_IN10 High Limit registers.	S3, S4/5
2	AD11_ERR	RWC	This bit is set when the AD_IN11 voltage has fallen outside the range defined by the AD_IN11 Low Limit and the AD_IN11 High Limit registers.	S3, S4/5
3	AD12_ERR	RWC	This bit is set when the AD_IN12 voltage has fallen outside the range defined by the AD_IN12 Low Limit and the AD_IN12 High Limit registers.	S3*, S4/5*
4	AD13_ERR	RWC	This bit is set when the AD_IN13 voltage has fallen outside the range defined by the AD_IN13 Low Limit and the AD_IN13 High Limit registers.	S3*, S4/5*
5	AD14_ERR	RWC	This bit is set when the AD_IN14 voltage has fallen outside the range defined by the AD_IN14 Low Limit and the AD_IN14 High Limit registers.	S3*, S4/5*
6	AD15_ERR	RWC	This bit is set when the AD_IN15 voltage has fallen outside the range defined by the AD_IN15 Low Limit and the AD_IN15 High Limit registers.	S3, S4/5
7	AD16_ERR	RWC	This bit is set when the AD_IN16 voltage has fallen outside the range defined by the AD_IN16 Low Limit and the AD_IN16 High Limit registers.	none

16.9.4 Register 43h B_Error Status 4

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
43h	RWC	B_Error Status 4	D2a_ ERR	D1a_ ERR	DV _{DD} P2 _ERR	DV _{DD} P1 _ERR	GPI9 _ERR	GPI8 _ERR	D2b _ERR	D1b _ERR	00h

Bit	Name	R/W	Description	Sleep Masking
0	D1b_ERR	RWC	Diode Fault Error This bit is set if there is an open or short circuit on the REMOTE1b+ and REMOTE1- pins.	S3*, S4/5*
1	D2b_ERR	RWC	Diode Fault Error This bit is set if there is an open or short circuit on the REMOTE2b+ and REMOTE2- pins.	S3*, S4/5*
2	GPI8	RWC	SCSI Fuse Error This bit is set if GPI8 has been asserted. Enabled only when VID mode is set to VRD 10.	S3, S4/5
3	GPI9	RWC	SCSI Fuse Error This bit is set if GPI9 has been asserted. Enabled only when VID mode is set to VRD 10.	S3, S4/5
4	DV _{DD} P1_ERR	RWC	Dynamic Vccp Limit Error. This bit is set if AD_IN7 (P1_Vccp) did not match the requested voltage as reported by P1_VID[7:0].	S3, S4/5
5	DV _{DD} P2_ERR	RWC	Dynamic Vccp Limit Error. This bit is set if AD_IN8 (P2_Vccp) did not match the requested voltage as reported by P1_VID[7:0].	S3, S4/5
6	D1a_ERR	RWC	Diode Fault Error This bit is set if there is an open or short circuit on the REMOTE1a+ and REMOTE1 – pins.	S3*, S4/5*
7	D2a_ERR	RWC	Diode Fault Error This bit is set if there is an open or short circuit on the REMOTE2a+ and REMOTE2- pins.	S3*, S4/5*

16.9.5 Register 44h B_P1_PROCHOT Error Status

	Read/ Write	一 供应用e gister Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
44h	RWC	B_P1_PROCHOT Error Status	PH1 _ERR	TMAX	T100	T75	T50	T25	T12	T0	00h

Bit	Name	R/W	Description	Sleep Masking
0	ТО	RWC	Set when P1_PROCHOT has had a throttled event. This bit is set for any amount of PROCHOT throttling >0%.	S3, S4/5
1	T12	RWC	Set when P1_PROCHOT has throttled greater than or equal to 0.39% but less than 12.5%.	S3, S4/5
2	T25	RWC	Set when P1_PROCHOT has throttled greater than or equal to 12.5% but less than 25%.	S3, S4/5
3	T50	RWC	Set when P1_PROCHOT has throttled greater than or equal to 25% but less than 50%.	S3, S4/5
4	T75	RWC	Set when P1_PROCHOT has throttled greater than or equal to 50% but less than 75%.	S3, S4/5
5	T100	RWC	Set when P1_PROCHOT has throttled greater than or equal to 75% but less than 100%.	S3, S4/5
6	TMAX	RWC	Set when P1_PROCHOT has throttled 100%.	S3, S4/5
7	PH1_ERR	RWC	Set when P1_PROCHOT has throttled more than the user limit.	S3, S4/5

The PH1_ERR bit is the only bit in this register that will set BMC_ ERR in the LM94 Status/Control register.

16.9.6 Register 45h B_P2_PROCHOT Error Status

§询"LM94"供应商 Register Read/ Register Default Bit 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0 Address Write Name Value B_P2_PROCHOT PH2 TMAX 45h RWC T100 T0 00h T75 T50 T25 T12 Error Status _ERR

Bit	Name	R/W	Description	Sleep Masking
0	Т0	RWC	Set when P2_PROCHOT has had a throttled event. This bit is set for any amount of PROCHOT throttling >0%.	S3, S4/5
1	T12	RWC	Set when P2_PROCHOT has throttled greater than or equal to 0.0% but less than 12.5%.	S3, S4/5
2	T25	RWC	Set when P2_PROCHOT has throttled greater than or equal to 12.5% but less than 25%.	S3, S4/5
3	T50	RWC	Set when P2_PROCHOT has throttled greater than or equal to 25% but less than 50%.	S3, S4/5
4	T75	RWC	Set when P2_PROCHOT has throttled greater than or equal to 50% but less than 75%.	S3, S4/5
5	T100	RWC	Set when P2_PROCHOT has throttled greater than or equal to 75% but less than 100%.	S3, S4/5
6	TMAX	RWC	Set when P2_PROCHOT has throttled 100%.	S3, S4/5
7	PH2_ERR	RWC	Set when P2_PROCHOT has throttled more than the user limit.	S3, S4/5

The PH2_ERR bit is the only bit in this register that will set BMC_ ERR in the LM94 Status/Control register.

16.9.7 Register 46h B_GPI Error Status

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
46h	RWC	B_GPI Error Status	GPI7 _ERR	GPI6 _ERR	GPI5 _ERR	GPI4 _ERR	GPI3 _ERR	GPI2 _ERR	GPI1 _ERR	GPI0 _ERR	00h

Bit	Name	R/W	Description	Sleep Masking
0	GPI0_ERR	RWC	This bit is set whenever GPIO0 is driven low (unless masked via the GPI Error Mask register).	S1*, S3*, S4/5*
1	GPI1_ERR	RWC	This bit is set whenever GPIO1 is driven low (unless masked via the GPI Error Mask register).	S1*, S3*, S4/5*
2	GPI2_ERR	RWC	This bit is set whenever GPIO2 is driven low (unless masked via the GPI Error Mask register).	S1*, S3*, S4/5*
3	GPI3_ERR	RWC	This bit is set whenever GPIO3 is driven low (unless masked via the GPI Error Mask register).	S1*, S3*, S4/5*
4	GPI4_ERR	RWC	This bit is set whenever GPIO4 is driven low (unless masked via the GPI Error Mask register).	S1*, S3*, S4/5*
5	GPI5_ERR	RWC	This bit is set whenever GPIO5 is driven low (unless masked via the GPI Error Mask register).	S1*, S3*, S4/5*
6	GPI6_ERR	RWC	This bit is set whenever GPIO6 is driven low (unless masked via the GPI Error Mask register).	S1*, S3*, S4/5*
7	GPI7_ERR	RWC	This bit is set whenever GPIO7 is driven low (unless masked via the GPI Error Mask register).	S1*, S3*, S4/5*

16.9.8 Register 47h B_Fan Error Status

Register Address	Read/ Write		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
47h	RWC	B_Fan Error Status		RE	ΞS		FAN4 _ERR	FAN3 _ERR	FAN2 _ERR	FAN1 _ERR	00h

Bit	Name	R/W	Description	Sleep Masking
0	FAN1_ERR	RWC	This bit is set when the Fan Tach 1 value register is above the value set in the Fan Tach 1 Limit register.	S1*, S3*, S4/5
1	FAN2_ERR	RWC	This bit is set when the Fan Tach 2 value register is above the value set in the Fan Tach 2 Limit register.	S1*, S3*, S4/5
2	FAN3_ERR	RWC	This bit is set when the Fan Tach 3 value register is above the value set in the Fan Tach 3 Limit register.	S1*, S3*, S4/5
3	FAN4_ERR	RWC	This bit is set when the Fan Tach 4 value register is above the value set in the Fan Tach 4 Limit register.	S1*, S3*, S4/5
7:4	RES	R	Reserved	N/A

16.10 HOST ERROR STATUS REGISTERS

The Host Error Status Registers contain several bits that each represent a particular error event that the LM94 can monitor. The LM94 sets a given bit whenever the corresponding error event occurs. The HOST_ERR bit in the LM94 Status/Control register also sets if any bit in the Host Error Status registers is set. The exception to this is the fixed threshold error status bits in the PROCHOT Error Status registers. They have no influence on HOST_ERR.

Once a bit is set in the Host Error Status registers, it is not automatically cleared by the LM94 if the error event goes away. Each bit must be cleared by software. If software attempts to clear a bit while the error condition still exists, the bit does not clear.

Software must specifically write a 1 to any bits it wishes to clear in the Host Error Status registers (write-one-to-clear).

Each register described in this section has a column labeled **Sleep Masking**. This column describes which error events are masked in various sleep states. The sleep state of the system is communicated to the LM94 by writing to the Sleep State Control register. If a sleep state in this column has a "* next to it, it denotes that the error event is optionally masked in that sleep mode, depending on the Sleep State Mask registers.

16.10.1 Register 48h H_Error Status 1

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
48h	RWC	H_Error Status 1	RI	RES		VRD1 _ERR	ZN4_ ERR	ZN3_ ERR	ZN2_ ERR	ZN1_ ERR	00h

Bit	Name	R/W	Description	Sleep Masking
0	ZN1_ERR	RWC	This bit is set when any zone 1 temperature has fallen outside its associated temperature limits.	S3*, S4/5*
1	ZN2_ERR	RWC	This bit is set when any zone 2 temperature has fallen outside its associated temperature limits.	S3*, S4/5*
2	ZN3_ERR	RWC	This bit is set when the zone 3 temperature has fallen outside the zone 3 temperature limits.	none
3	ZN4_ERR	RWC	This bit is set when the zone 4 temperature has fallen outside the zone 4 temperature limits.	none
4	VRD1_ERR	RWC	This bit is set when the VRD1_HOT input has been asserted.	S3, S4/5
5	VRD2_ERR	RWC	This bit is set when the VRD2_HOT# input has been asserted.	S3, S4/5
7:6	RES	R	Reserved	N/A

16.10.2 Register 49h H_Error Status 2

音词"LM9- Register Address			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
49h	RWC	H_Error Status 2	ADIN8 _ERR	ADIN7 _ERR	ADIN6 _ERR	ADIN5 _ERR	ADIN4 _ERR	ADIN3 _ERR	ADIN2 _ERR	ADIN1 _ERR	00h

Bit	Name	R/W	Description	Sleep Masking
0	AD1_ERR	RWC	This bit is set when the AD_IN1 voltage has fallen outside the range defined by the AD_IN1 Low Limit and the AD_IN1 High Limit registers.	S3, S4/5
1	AD2_ERR	RWC	This bit is set when the AD_IN2 voltage has fallen outside the range defined by the AD_IN2 Low Limit and the AD_IN2 High Limit registers.	S3, S4/5
2	AD3_ERR	RWC	This bit is set when the AD_IN3 voltage has fallen outside the range defined by the AD_IN3 Low Limit and the AD_IN3 High Limit registers.	S3, S4/5
3	AD4_ERR	RWC	This bit is set when the AD_IN4 voltage has fallen outside the range defined by the AD_IN4 Low Limit and the AD_IN4 High Limit registers.	S3, S4/5
4	AD5_ERR	RWC	This bit is set when the AD_IN5 voltage has fallen outside the range defined by the AD_IN5 Low Limit and the AD_IN5 High Limit registers.	S3, S4/5
5	AD6_ERR	RWC	This bit is set when the AD_IN6 voltage has fallen outside the range defined by the AD_IN6 Low Limit and the AD_IN6 High Limit registers.	S3, S4/5
6	AD7_ERR	RWC	This bit is set when the AD_IN7 voltage has fallen outside the range defined by the AD_IN7 Low Limit and the AD_IN7 High Limit registers.	S3, S4/5
7	AD8_ERR	RWC	This bit is set when the AD_IN8 voltage has fallen outside the range defined by the AD_IN8 Low Limit and the AD_IN8 High Limit registers.	S3, S4/5

16.10.3 Register 4Ah H_Error Status 3

Register Address		Register Name		Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
4Ah	RWC	H_Error Status 3	ADIN16 _ERR	ADIN15 _ERR	ADIN14 _ERR	ADIN13 _ERR	ADIN12 _ERR	ADIN11 _ERR	ADIN10 _ERR	ADIN9 _ERR	00h

Bit	Name	R/W	Description	Sleep Masking
0	AD9_ERR	RWC	This bit is set when the AD_IN9 voltage has fallen outside the range defined by the AD_IN9 Low Limit and the AD_IN9 High Limit registers.	S3, S4/5
1	AD10_ERR	RWC	This bit is set when the AD_IN10 voltage has fallen outside the range defined by the AD_IN10 Low Limit and the AD_IN10 High Limit registers.	S3, S4/5
2	AD11_ERR	RWC	This bit is set when the AD_IN11 voltage has fallen outside the range defined by the AD_IN11 Low Limit and the AD_IN11 High Limit registers.	S3, S4/5
3	AD12_ERR	RWC	This bit is set when the AD_IN12 voltage has fallen outside the range defined by the AD_IN12 Low Limit and the AD_IN12 High Limit registers.	S3*, S4/5*
4	AD13_ERR	RWC	This bit is set when the AD_IN13 voltage has fallen outside the range defined by the AD_IN13 Low Limit and the AD_IN13 High Limit registers.	S3*, S4/5*
5	AD14_ERR	RWC	This bit is set when the AD_IN14 voltage has fallen outside the range defined by the AD_IN14 Low Limit and the AD_IN14 High Limit registers.	S3*, S4/5*
6	AD15_ERR	RWC	This bit is set when the AD_IN15 voltage has fallen outside the range defined by the AD_IN15 Low Limit and the AD_IN15 High Limit registers.	S3, S4/5
7	AD16_ERR	RWC	This bit is set when the AD_IN16 voltage has fallen outside the range defined by the AD_IN16 Low Limit and the AD_IN16 High Limit registers.	none

16.10.4 Register 4Bh H_Error Status 4

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Régister Address	Read) [/] Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
4Bh	RWC	H_Error Status 4	D2a_ ERR	D1a_ ERR	DV _{DD} P2 _ERR	DV _{DD} P1 _ERR	GPI9 _ERR	GPI8 _ERR	D2b _ERR	D1b _ERR	00h

Bit	Name	R/W	Description	Sleep Masking
0	D1b_ERR	RWC	Diode Fault Error This bit is set if there is an open or short circuit on the REMOTE1b+ and REMOTE1- pins.	S3*, S4/5*
1	D2b_ERR	RWC	Diode Fault Error This bit is set if there is an open or short circuit on the REMOTE2b+ and REMOTE2- pins.	S3*, S4/5*
2	GPI8	RWC	SCSI Fuse Error This bit is set if GPI8 has been asserted. Enabled only when VID mode is set to VRD 10.	S3, S4/5
3	GPI9	RWC	SCSI Fuse Error This bit is set if GPI9 has been asserted. Enabled only when VID mode is set to VRD 10.	S3, S4/5
4	DV _{DD} P1_ERR	RWC	Dynamic Vccp Limit Error. This bit is set if AD_IN7 (P1_Vccp) did not match the requested voltage as reported by P1_VID[7:0].	S3, S4/5
5	DV _{DD} P2_ERR	RWC	Dynamic Vccp Limit Error. This bit is set if AD_IN8 (P2_Vccp) did not match the requested voltage as reported by P1_VID[7:0].	S3, S4/5
6	D1a_ERR	RWC	Diode Fault Error This bit is set if there is an open or short circuit on the REMOTE1a+ and REMOTE1- pins.	S3*, S4/5*
7	D2a_ERR	RWC	Diode Fault Error This bit is set if there is an open or short circuit on the REMOTE2a+ and REMOTE2- pins.	S3*, S4/5*

16.10.5 Register 4Ch H_P1_PROCHOT Error Status

	Read/ Write	4"供应首 Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
4Ch	RWC	H_P1_PROCHOT Error Status	PH1_ERR	TMAX	T100	T75	T50	T25	T12	T0	00h

Bit	Name	R/W	Description	Sleep Masking
0	ТО	RWC	Set when $\overline{P1_PROCHOT}$ has had a throttled event. This bit is set for any amount of $\overline{PROCHOT}$ throttling >0%.	S3, S4/5
1	T12	RWC	Set when P1_PROCHOT has throttled greater than or equal to 0.00% but less than 12.5%.	S3, S4/5
2	T25	RWC	Set when P1_PROCHOT has throttled greater than or equal to 12.5% but less than 25%.	S3, S4/5
3	T50	RWC	Set when P1_PROCHOT has throttled greater than or equal to 25% but less than 50%.	S3, S4/5
4	T75	RWC	Set when P1_PROCHOT has throttled greater than or equal to 50% but less than 75%.	S3, S4/5
5	T100	RWC	Set when P1_PROCHOT has throttled greater than or equal to 75% but less than 100%.	S3, S4/5
6	TMAX	RWC	Set when P1_PROCHOT has throttled 100%.	S3, S4/5
7	PH1_ERR	RWC	Set when P1_PROCHOT has throttled more than the user limit.	S3, S4/5

The PH1_ERR bit is the only bit in this register that will set HOST_ ERR in the LM94 Status/Control register.

16.10.6 Register 4Dh B_P2_PROCHOT Error Status

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ŀ	Register	Read/	Register				D:. 4					Default
	Address	Write	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value
	4Dh	RWC	H_P2_PROCHOT Error Status	PH2_ERR	TMAX	T100	T75	T50	T25	T12	T0	00h

Bit	Name	R/W	Description	Sleep Masking
0	ТО	RWC	Set when $\overline{P2_PROCHOT}$ has had a throttled event. This bit is set for any amount of $\overline{PROCHOT}$ throttling >0%.	S3, S4/5
1	T12	RWC	Set when P2_PROCHOT has throttled greater than or equal to 0.00% but less than 12.5%.	S3, S4/5
2	T25	RWC	Set when P2_PROCHOT has throttled greater than or equal to 12.5% but less than 25%.	S3, S4/5
3	T50	RWC	Set when P2_PROCHOT has throttled greater than or equal to 25% but less than 50%.	S3, S4/5
4	T75	RWC	Set when P2_PROCHOT has throttled greater than or equal to 50% but less than 75%.	S3, S4/5
5	T100	RWC	Set when P2_PROCHOT has throttled greater than or equal to 75% but less than 100%.	S3, S4/5
6	TMAX	RWC	Set when P2_PROCHOT has throttled 100%.	S3, S4/5
7	PH2_ERR	RWC	Set when P2_PROCHOT has throttled more than the user limit.	S3, S4/5

The PH2_ERR bit is the only bit in this register that will set HOST_ERR in the LM94 Status/Control register.

16.10.7 Register 4Eh H_GPI Error Status 本治"I MO4"(# 应商

		叫供应蓄									
Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
4Eh	RWC	H_GPI Error Status	GPI7 _ERR	GPI6 _ERR	GPI5 _ERR	GPI4 _ERR	GPI3 _ERR	GPI2 _ERR	GPI1 _ERR	GPI0 _ERR	00h

Bit	Name	R/W	Description	Sleep Masking
0	GPI0_ERR	RWC	This bit is set whenever GPIO0 is driven low (unless masked via the GPI Error Mask register).	S1*, S3*, S4/5*
1	GPI1_ERR	RWC	This bit is set whenever GPIO1 is driven low (unless masked via the GPI Error Mask register).	S1*, S3*, S4/5*
2	GPI2_ERR	RWC	This bit is set whenever GPIO2 is driven low (unless masked via the GPI Error Mask register).	S1*, S3*, S4/5*
3	GPI3_ERR	RWC	This bit is set whenever GPIO3 is driven low (unless masked via the GPI Error Mask register).	S1*, S3*, S4/5*
4	GPI4_ERR	RWC	This bit is set whenever GPIO4 is driven low (unless masked via the GPI Error Mask register).	S1*, S3*, S4/5*
5	GPI5_ERR	RWC	This bit is set whenever GPIO5 is driven low (unless masked via the GPI Error Mask register).	S1*, S3*, S4/5*
6	GPI6_ERR	RWC	This bit is set whenever GPIO6 is driven low (unless masked via the GPI Error Mask register).	S1*, S3*, S4/5*
7	GPI7_ERR	RWC	This bit is set whenever GPIO7 is driven low (unless masked via the GPI Error Mask register).	S1*, S3*, S4/5*

16.10.8 Register 4Fh H_Fan Error Status

查询"LM94	叫出应蓝										
Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
4Fh	RWC	H_Fan Error Status		RES				FAN3 _ERR	FAN2 _ERR	FAN1 _ERR	00h

Bit	Name	R/W	Description	Sleep Masking
0	FAN1_ERR	RWC	This bit is set when the Fan Tach 1 value register is above the value set in the Fan Tach 1 Limit register.	S1*, S3*, S4/5
1	FAN2_ERR	RWC	This bit is set when the Fan Tach 2 value register is above the value set in the Fan Tach 2 Limit register.	S1*, S3*, S4/5
2	FAN3_ERR	RWC	This bit is set when the Fan Tach 3 value register is above the value set in the Fan Tach 3 Limit register.	S1*, S3*, S4/5
3	FAN4_ERR	R	This bit is set when the Fan Tach 4 value register is above the value set in the Fan Tach 4 Limit register.	S1*, S3*, S4/5
7:4	RES	R	Reserved	N/A

16.11 VALUE REGISTERS

16.11.1 Registers 50-53h Unfiltered Temperature Value Registers

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
06h	R	Zone 1b (CPU1) Temp	7	6	5	4	3	2	1	0	00h
07h	R	Zone 2b (CPU2) Temp	7	6	5	4	3	2	1	0	00h
50h	R	Zone 1a (CPU1) Temp	7	6	5	4	3	2	1	0	00h
51h	R	Zone 2a (CPU2) Temp	7	6	5	4	3	2	1	0	00h
52h	R	Zone 3 (Internal) Temp	7	6	5	4	3	2	1	0	00h
53h	R/W	Zone 4 (External Digital) Temp	7	6	5	4	3	2	1	0	00h

Zones 1 and 2 are all automatically updated by the LM94. The Zone 3 (Internal) Temp and Zone 4 (External Digital) Temp registers may be written by an external SMBus device or can be assigned to AD_IN11 and AD_IN15, respectively.

The temperature registers for zones 1 and 2 will return a value of 80h if the remote diode pins are not implemented by the board designer or are not functioning properly.

16.11.2 Registers 54-55h Filtered Temperature Value Registers

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
08h	R	Zone 1b (CPU1) Filtered Temp	7	6	5	4	3	2	1	0	00h
09h	R	Zone 2b (CPU2) Filtered Temp	7	6	5	4	3	2	1	0	00h
54h	R	Zone 1a (CPU1) Filtered Temp	7	6	5	4	3	2	1	0	00h
55h	R	Zone 2a (CPU2) Filtered Temp	7	6	5	4	3	2	1	0	00h

These registers reflect the temperature of zones 1 and 2 after the spike smoothing filter has been applied.

The characteristics of the filtering can be adjusted by using the Zones 1/2 Spike Smoothing Control register.

16.11.3 Register 56-65h A/D Channel Voltage Registers

Register Default Bit 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0 Address Write Value Name N/D 56h R AD_IN1 Voltage 57h R AD_IN2 Voltage N/D 58h R AD_IN3 Voltage N/D 59h R AD_IN4 Voltage N/D R N/D 5Ah AD_IN5 Voltage R AD_IN6 Voltage N/D 5Bh R AD_IN7 Voltage N/D 5Ch 5Dh R AD_IN8 Voltage N/D R N/D 5Eh AD IN9 Voltage R 5Fh AD_IN10 Voltage N/D R AD_IN11 Voltage N/D 60h R 61h AD IN12 Voltage N/D 62h R AD_IN13 Voltage N/D 63h R AD IN14 Voltage N/D 64h R AD_IN15 Voltage N/D 65h R AD_IN16 Voltage N/D

The voltage reading registers reflect the current voltage of the LM94 voltage monitoring inputs. Voltages are presented in the registers at ¾ full scale for the nominal voltage. Therefore, at nominal voltage, each register reads C0h.

16.11.4 Register 67h Current P1_PROCHOT

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
67h	R	Current P1_PROCHOT	7	6	5	4	3	2	1	0	00h

This is the value of the PROCHOT percentage active time for Processor 1 at the end of each PROCHOT monitoring interval as set by the PROCHOT Time Interval register. Writing to this register does not effect the register contents, but does restart the capture cycle for both PROCHOT channels (P1_PROCHOT and P2_PROCHOT). A register value of one represents anything greater than 0% but less than 0.39% of active time.

Register Value (Decimal)	Percentage Active Time
0	0%
1	0.39%
2	0.78%
•	•
•	•
•	•
n	n/256*100
255	99.60%

16.11.5 Register 68h Average P1_PROCHOT

<u> 李祁川 M/0//</u>											
Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
68h	R	Average P1_PROCHOT	7	6	5	4	3	2	1	0	00h

This is the average percentage active time of P1_PROCHOT. It is the result of adding the contents of this register to the contents of the Current P1_PROCHOT register and dividing the result by 2. The update occurs at the same time that the Current P1_PROCHOT register gets updated. A register value of one represents anything greater than 0% but less than 0.39% of active time.

16.11.6 Register 69h Current P2_PROCHOT

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
69h	R	Current P2_PROCHOT	7	6	5	4	3	2	1	0	00h

This is the value of the PROCHOT percentage active time for Processor 2 at the end of each PROCHOT monitoring interval as set by the PROCHOT Time Interval register. Writing to this register does not effect the register contents, but does restart the capture cycle for both PROCHOT channels (P1_PROCHOT and P2_PROCHOT). A register value of one represents anything greater than 0% but less than 0.39% of active time.

Register Value (Decimal)	Percentage Active Time
0	0%
1	0.39%
2	0.78%
•	•
•	•
•	•
n	n/256*100
255	99.60%

16.11.7 Register 6Ah Average P2_PROCHOT

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
6Ah	R	Average P2_PROCHOT	7	6	5	4	3	2	1	0	00h

This is the average percentage active time of P2_PROCHOT. It is the result of adding the contents of this register to the contents of the Current P2_PROCHOT register and dividing the result by 2. The update occurs at the same time that the Current P2_PROCHOT register gets updated. A register value of one represents anything greater than 0% but less than 0.39% of active time.

16.11.8 Register 6Bh Current GPI State 查询"I M94"供应商

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
6Bh	R	GPI State	GPI7	GPI6	GP15	GPI4	GPI3	GPI2	GPI1	GPI0	00h

Bit	Name	Read/Write	Description
0	GPI0	R	1 if GPIO_0 input is LOW, not latched
1	GPI1	R	1 if GPIO_1 input is LOW, not latched
2	GPI2	R	1 if GPIO_2 input is LOW, not latched
3	GPI3	R	1 if GPIO_3 input is LOW, not latched
4	GPI4	R	1 if GPIO_4 input is LOW, not latched
5	GPI5	R	1 if GPIO_5 input is LOW, not latched
6	GPI6	R	1 if GPIO_6 input is LOW, not latched
7	GPI7	R	1 if GPIO_7 input is LOW, not latched

16.11.9 Register 6Ch P1_VID

章 说言中國語中國語彙的可以表現的。

Special Function Control 2 register at address BDh. See the Special Function Control 2 register description for further details.

Register Address	l	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
		R P1_VID	RE	S (0)	(0) P1_VID[5:0] for VRD 10 mode (functions same as LM93)						00h
6Ch	R		RES (0)	P1_VID[6:0] for VRD 10.2 Extended mode						00h	
6CII			RES (0)	P1_VI	P1_VID[6:0] for VRD 11 , Mode 1 (most commonly used mode for VRD11)					00h	
				•	P1_VID[7:	1] for VRD	11, Mode 2			RES (0)	00h

VRD 10 mode

Bit	Name	Read/Write	Description
5:0	P1_VID[5:0]	R	Processor 1 VID status. Reports the current state of the P1_VID5 through P1_VID0 pins. This register will only be updated if P1_VID signals remain stable for at least 600 ns.
7:6	RES	R	Reserved and will always report 0.

VRD 10.2 Extended mode

Bit	Name	Read/Write	Description
6:0	P1_VID[6:0]		Processor 1 VID status. Reports the current state of the P1_VID6 through P1_VID0 pins. This register will only be updated if P1_VID signals remain stable for at least 600 ns.
7	RES	R	Reserved and will always report 0.

VRD 11 Mode 1

Bit	Name	Read/Write	Description
6:0	P1_VID[6:0]	R	Processor 1 VID status. This mode is the recommended mode for support of VRD11. Reports the current state of the P1_VID6 through P1_VID0 pins. This register will only be updated if P1_VID signals remain stable for at least 600 ns.
7	RES	R	Reserved and will always report 0.

VRD 11 Mode 2

Bit	Name	Read/Write	Description
0	RES	R	Reserved and will always report 0.
7:1	P1_VID[7:1]	R	Processor 1 VID status. This mode is supplied for future experimentation and will require additional hardware in order to support both VRD11 and VRD10 specifications. Reports the current state of the P1_VID7 through P1_VID1 pins. This register will only be updated if P1_VID signals remain stable for at least 600 ns.

16.11.10 Register 6Dh P2_VID

This register described in the table. The mapping is determined by the VID mode as selected in the Special Function Control 2 register at address BDh. See the Special Function Control 2 register description for further details.

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
		R P2_VID	RE	S (0)	(0) P2_VID[5:0] for VRD 10 mode (functions same as LM93)						00h
6Dh			RES (0)	P2_VID[6:0] for VRD 10.2 Extended mode						00h	
וועט	ĸ		RES (0)	P2_VID[6:0] for VRD 11 , Mode 1 (most commonly used mode for VRD11)						00h	
				P2_VID[7:1] for VRD 11, Mode 2 RES (0)							00h

VRD 10 mode

Bit	Name	Read/Write	Description
5:0	P2_VID[5:0]		Processor 2 VID status. Reports the current state of the P2_VID5 through P2_VID0 pins. This register will only be updated if P2_VID signals remain stable for at least 600 ns.
7:6	RES	R	Reserved and will always report 0.

VRD 10.2 Extended mode

Bit	Name	Read/Write	Description
6:0	P2_VID[6:0]		Processor 2 VID status. Reports the current state of the P2_VID6 through P2_VID0 pins. This register will only be updated if P2_VID signals remain stable for at least 600 ns.
7	RES	R	Reserved and will always report 0.

VRD 11 Mode 1

Bit	Name	Read/Write	Description
6:0	P2_VID[6:0]	R	Processor 2 VID status. This mode is the recommended mode for support of VRD11. Reports the current state of the P2_VID6 through P2_VID0 pins. This register will only be updated if P2_VID signals remain stable for at least 600 ns.
7	RES	R	Reserved and will always report 0.

VRD 11 Mode 2

Bit	Name	Read/Write	Description
0	RES	R	Reserved and will always report 0.
7:1	P2_VID[7:1]	R	Processor 2 VID status. This mode is supplied for future experimentation and will require additional hardware in order to support both VRD11 and VRD10 specifications. Reports the current state of the P2_VID7 through P2_VID1 pins. This register will only be updated if P2_VID signals remain stable for at least 600 ns.

16.11.11 Register 6E-75h Fan Tachometer Readings

Register Register Default Bit 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0 Address Write Name Value Fan Tach 1 T1ST[1:0] TACH1[5:0] 6Eh R 00h LSB Fan Tach 1 6Fh R TACH1[13:6] 00h MSB Fan Tach 2 70h R TACH2[5:0] T2ST[1:0] 00h LSB Fan Tach 2 R TACH2[13:6] 71h 00h **MSB** Fan Tach 3 72h R TACH3[5:0] T3ST[1:0] 00h LSB Fan Tach 3 73h R TACH3[13:6] 00h **MSB** Fan Tach 4 74h R TACH4[5:0] T4ST[1:0] 00h LSB Fan Tach 4 75h R TACH4[13:6] 00h **MSB**

The 14-bit fan tach readings indicate the number of 22.5 kHz clock periods that occurred during two full periods of the tachometer input signal. Most fans produce two tachometer pulses per full revolution. These registers must be updated at least once every second.

The fan tachometer reading registers must always return an accurate fan tachometer measurement, even when a fan is disabled or non-functional. 3FFFh indicates that the fan is stalled, not spinning fast enough to measure, or the tachometer input is not connected to a valid signal.

If the pulses per revolution of the fan is known, the RPM can be calculated with the following equation:

RPM= 22500 cycles/sec * 60 sec/min * 2 pulses / COUNT cycles / PULSES_PER_REV

where:

PULSES PER REV = the number of pulses that the fan produces per revolution

COUNT = The 14-bit value read from the tach register

Bit	Name	Read/Write	Description
1:0	T1ST[1:0], T2ST[1:0], T3ST[1:0], T4ST[1:0]	R	Two bits for each tachometer reading that report the state of the fan control circuitry used to acquire a reading. See table below for further clarification.
7:2	TACH1[5:0], TACH2[5:0], TACH3[5:0], TACH4[5:0]	R	Least significant bit field of tachometer reading.
7:0	TACH1[13:6], TACH2[13:6], TACH3[13:6], TACH4[13:6]		Most significant bit fielf of tachometer reading.

T1ST[1:0], T2ST[1:0], T3ST[1:0], or T4ST[1:0]	State of Fan Control Circuitry
00	Normal Mode (Smart Tach Mode disabled)
01	Reserved
10	Smart Tach Mode 1, less accurate with most stable Fan RPM
11	Smart Tach Mode 2, most accurate with least stable Fan RPM

16.12 LIMIT REGISTERS

16.12. <u>香油"LM 94" 供应商</u>mperature Limit Registers

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
78h	R/W	Processor 1 (Zone1) Low Temp	7	6	5	4	3	2	1	0	80h
79h	R/W	Processor 1 (Zone1) High Temp	7	6	5	4	3	2	1	0	80h
7Ah	R/W	Processor 2 (Zone2) Low Temp	7	6	5	4	3	2	1	0	80h
7Bh	R/W	Processor 2 (Zone2) High Temp	7	6	5	4	3	2	1	0	80h
7Ch	R/W	Internal (Zone3) Low Temp	7	6	5	4	3	2	1	0	80h
7Dh	R/W	Internal (Zone3) High Temp	7	6	5	4	3	2	1	0	80h
7Eh	R/W	External Digital (Zone4) Low Temp	7	6	5	4	3	2	1	0	80h
7Fh	R/W	External Digital (Zone4) High Temp	7	6	5	4	3	2	1	0	80h

If an external temperature input or the internal temperature sensor either exceeds the value set in the high limit register or falls below the value set in the low limit register, the corresponding bit in the B_ and H_Error Status 1 register is set automatically by the LM94. For example, if the temperature read from the Remote1– and Remote1+ inputs exceeds the Processor (Zone1) High Temp register limit setting, the ZN1_ERR bit in both B_Error Status 1 and H_Error Status 1 registers is set. The temperature limits in these registers is represented as 8 bit, 2's complement, signed numbers in Celsius.

If any high temp limit register is set to 80h then the B_ and H_Error Status register bit for that temperature channel is masked.

16.12.2 Registers 80–83h Fan Boost Temperature Registers

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
80h	R/W	Fan Boost Temp Zone 1	7	6	5	4	3	2	1	0	3Ch
81h	R/W	Fan Boost Temp Zone 2	7	6	5	4	3	2	1	0	3Ch
82h	R/W	Fan Boost Temp Zone 3	7	6	5	4	3	2	1	0	23h
83h	R/W	Fan Boost Temp Zone 4	7	6	5	4	3	2	1	0	23h

If any thermal zone exceeds the temperature set in the Fan Boost Limit register, both of the PWM outputs are set to 100%. The fan boost function takes precedence over low-resolution manual override. High-resolution manual overide takes priority over the fan boost function. This is a safety feature that attempts to cool the system if there is a potentially catastrophic thermal event. If set to 7Fh and the fan control temperature resolution is 1°C, the feature is disabled.

Default = 60° C = 3Ch for zones 1 and 2

Default = 35°C = 23h for zones 3 and 4

The temperature has to fall the number of degrees specified in the Fan Boost Hysteresis registers, below this temperature to cause the PWM outputs to return to normal operation. The fan boost function can be disabled by setting the associated register to 80h.

16.12.3 Register 84h Zone1, and Zone2 Hysteresis for Limit Comparisons

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
84h	R/W	Limit Comparison Hysteresis (Zones 1/2)		Н	C2			Н	C1		00h

Bit	Name	R/W	Description
3:0	HC1	R/W	Sets the limit comparison hysteresis for zone 1 for both the High and Low limits. The hysteresis can be set from
			0°C to 15°C and has 1°C resolution.
7:4	HC2	R/W	Sets the limit comparison hysteresis for zone 2 for both the High and Low limits. The hysteresis can be set from 0°C to 15°C and has 1°C resolution.

16.12.4 Register 85h Zone3 and Zone4 Hysteresis for Limit Comparisons

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
85h	R/W	Limit Comparison Hysteresis (Zones 3/4)		Н	C4			Н	C3		00h

Bit	Name	R/W	Description
3:0	НС3	R/W	Sets the limit comparison hysteresis for zone 3 for both the High and Low limits. The hysteresis can be set from 0°C to 15°C and has 1°C resolution.
7:4	HC4	R/W	Sets the limit comparison hysteresis for zone 4 for both the High and Low limits. The hysteresis can be set from 0°C to 15°C and has 1°C resolution.

16.12.5 Registers 8E–8Fh Zone 1b and Zone 2b Temperature Reading Adjustment Registers

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
8Eh	R/W	Zone 1b Temp Adjust	RES	RES	Z1b_ADJUST[5:0]						00h
8Fh	R/W	Zone 2b Temp Adjust	RES	RES	Z2b_ADJUST[5:0]						00h

Bit	Name	R/W	Description
5:0	Z1b_ADJUST[5:0] or Z2b_ADJUST[5:0]		6-bit signed 2's complement offset adjustment. This value is added to zone 1b or zone 2b temperature measurements as they are made. All LM94 registers and
		1	functions behave as if the resulting temperature was the true measured temperature. This register allows offset adjustments from +31°C to -32°C in 1°C steps.
7:6	RES	R	Reserved

16.12.6 Registers 90-AFh Voltage Limit Registers

Register	间"LM94	"供应商 Register	1	I							Default
Address	Write	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value
90h	R/W	AD_IN1 Low Limit	7	6	5	4	3	2	1	0	00h
91h	R/W	AD_IN1 High Limit	7	6	5	4	3	2	1	0	FFh
92h	R/W	AD_IN2 Low Limit	7	6	5	4	3	2	1	0	00h
93h	R/W	AD_IN2 High Limit	7	6	5	4	3	2	1	0	FFh
94h	R/W	AD_IN3 Low Limit	7	6	5	4	3	2	1	0	00h
95h	R/W	AD_IN3 High Limit	7	6	5	4	3	2	1	0	FFh
96h	R/W	AD_IN4 Low Limit	7	6	5	4	3	2	1	0	00h
97h	R/W	AD_IN4 High Limit	7	6	5	4	3	2	1	0	FFh
98h	R/W	AD_IN5 Low Limit	7	6	5	4	3	2	1	0	00h
99h	R/W	AD_IN5 High Limit	7	6	5	4	3	2	1	0	FFh
9Ah	R/W	AD_IN6 Low Limit	7	6	5	4	3	2	1	0	00h
9Bh	R/W	AD_IN6 High Limit	7	6	5	4	3	2	1	0	FFh
9Ch	R/W	AD_IN7 Low Limit	7	6	5	4	3	2	1	0	00h
9Dh	R/W	AD_IN7 High Limit	7	6	5	4	3	2	1	0	FFh
9Eh	R/W	AD_IN8 Low Limit	7	6	5	4	3	2	1	0	00h
9Fh	R/W	AD_IN8 High Limit	7	6	5	4	3	2	1	0	FFh
A0h	R/W	AD_IN9 Low Limit	7	6	5	4	3	2	1	0	00h
A1h	R/W	AD_IN9 High Limit	7	6	5	4	3	2	1	0	FFh
A2h	R/W	AD_IN10 Low Limit	7	6	5	4	3	2	1	0	00h
A3h	R/W	AD_IN10 High Limit	7	6	5	4	3	2	1	0	FFh
A4h	R/W	AD_IN11 Low Limit	7	6	5	4	3	2	1	0	00h
A5h	R/W	AD_IN11 High Limit	7	6	5	4	3	2	1	0	FFh
A6h	R/W	AD_IN12 Low Limit	7	6	5	4	3	2	1	0	00h
A7h	R/W	AD_IN12 High Limit	7	6	5	4	3	2	1	0	FFh
A8h	R/W	AD_IN13 Low Limit	7	6	5	4	3	2	1	0	00h
A9h	R/W	AD_IN13 High Limit	7	6	5	4	3	2	1	0	FFh
AAh	R/W	AD_IN14 Low Limit	7	6	5	4	3	2	1	0	00h
ABh	R/W	AD_IN14 High Limit	7	6	5	4	3	2	1	0	FFh
ACh	R/W	AD_IN15 Low Limit	7	6	5	4	3	2	1	0	00h
ADh	R/W	AD_IN15 High Limit	7	6	5	4	3	2	1	0	FFh
AEh	R/W	AD_IN16 Low Limit	7	6	5	4	3	2	1	0	00h
AFh	R/W	AD_IN16 High Limit	7	6	5	4	3	2	1	0	FFh

FFh as the high limit acts as a mask for that voltage sensor and so prevents this channel from being able to set the associated error status bit in the $B_{\rm or}$ H_ Error Status registers, for both high and low limit errors.

If a voltage input either exceeds the value set in the voltage high limit register or falls below the value set in the voltage low limit register, the corresponding bit is set automatically by the LM94 in the B_ and H_Error Status registers.

16.12.7 Register B0–B1h PROCHOT User Limit Registers

李诒"LM04"	\$句"I_MO4"供应商										
Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
B0h	R/W	P1_PROCHOT User Limit	7	6	5	4	3	2	1	0	FFh
B1h	R/W	P2_PROCHOT User Limit	7	6	5	4	3	2	1	0	FFh

These registers allow a user limit to be set for the PROCHOT monitoring function. If the corresponding Current Px_PROCHOT register exceeds this value, the PH1_ERR or PH2_ERR bit is set in the corresponding Host and BMC error status registers. A value of FFh acts as a mask and prevents the error status bits from being set.

Register Value (Decimal)	Threshold Percentage
0	0%
1	0.39%
2	0.78%
•	•
•	•
•	•
n	n/256*100
255	99.60%

16.12.8 Register B2–B3h Dynamic Vccp Limit Offset Registers

Register Address	Read/ Write	用egister Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
B2h	R/W	Vccp1 Limit Offsets	ι	UPPER_OFFSET1		L	17h				
B3h	R/W	Vccp2 Limit Offsets	ι	UPPER_OFFSET2 LOWE		OWER_	OFFSET	2	17h		

These offsets are used to determine the upper and lower limits of the dynamic Vccp window comparator. These offsets are added or subtracted from the value selected by the VID bits.

LOWER_OFFSET1 or LOWER_OFFSET2	Lower Offset
0h	25 mV
1h	50 mV
2h	75 mV
3h	100 mV
Ch	325 mV
Dh	350 mV
Eh	375 mV
Fh	400 mV

UPPER_OFFSET1 or UPPER_OFFSET2	Upper Offset			
0h	12.5 mV			
1h	25 mV			
2h	37.5 mV			
3h	50 mV			
~ ~	~ ~			
Dh	175 mV			
Eh	187.5 mV			
Fh	200 mV			

16.12.9 Register B4-BBh Fan Tach Limit Registers

本询"LM0/ "	供应商										
查询"LM94" Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
B4h	R/W	Fan Tach 1 Limit LSB			TLIMI	Γ1[5:0]			RI	ES .	FCh
B5h	R/W	Fan Tach 1 Limit MSB		TLIMIT1[13:6]						FFh	
B6h	R/W	Fan Tach 2 Limit LSB		TLIMIT2[5:0] RES						FCh	
B7h	R/W	Fan Tach 2 Limit MSB		TLIMIT2[13:6]					FFh		
B8h	R/W	Fan Tach 3 Limit LSB			TLIMI	Г3[5:0]			RI	≣S	FCh
B9h	R/W	Fan Tach 3 Limit MSB		TLIMIT1[13:6]				FFh			
BAh	R/W	Fan Tach 4 Limit LSB		TLIMIT4[5:0] RES				FCh			
BBh	R/W	Fan Tach 4 Limit MSB		TLIMIT4[13:6]							FFh

If a tachometer reading exceeds its limit (as defined by these registers) the corresponding bit is set in the Host and BMC Error Status registers. The fan tachometer readings can be associated with a particular PWM output, but the tach errors are not automatically masked when a PWM is at 0% or set to level that causes the fan RPM to be below the limit purposely. In order to prevent false errors, care needs to be taken to make sure that the Fan Tach Limits are properly set. Errors are never generated for a fan if its limit is set to 3FFFh.

16.13 SETUP REGISTERS

16.13. <u>奔闾"LMO4"供应商</u> Function Control 1 (Voltage Hysteresis and Fan Control Filter Enable)

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
BCh	R/W	Special Function Control 1	RES	FCFE2	FCFE1	LCFE2	LCFE1		VH		00h

Bit	Name	R/W	Description
2:0	VH	R/W	Voltage hysteresis control. This determines the amount of hysteresis to be applied to all voltage limit comparisons. It applies to both high and low limits. One LSB equals one A/D count, so the actual voltage represented by one LSB depends on the voltage channel.
3	LCFE1	R/W	Limit Comparison Filter Enable. Setting this bit causes limit comparisons for temperature zone 1a and 1b to use the filtered (spike smoothed) temperature instead of the unfiltered temperature.
4	LCFE2	R/W	Limit Comparison Filter Enable. Setting this bit causes limit comparisons for temperature zone 2a and 2b to use the filtered (spike smoothed) temperature instead of the unfiltered temperature.
5	FCFE1	R/W	Fan Control Filter Enable. Setting this bit causes fan control functions for zone 1a and 1b (including fan boost) to use the filtered (spike smoothed) temperature instead of the unfiltered temperature. This includes the PI Loop controller, LUT, and temperature fan boost functions.
6	FCFE2	R/W	Fan Control Filter Enable. Setting this bit causes fan control functions for zone 2a and 2b (including fan boost) to use the filtered (spike smoothed) temperature instead of the unfiltered temperature. This includes the PI Loop controller, LUT, and temperature fan boost functions.
7	RES	R	Reserved

In order for the LCFE1, LCFE2, FCFE1 and FCFE2 bits to work correctly, the ZN1E and ZN2E bits in the Zones 1/2 Spike Smoothing Control register (at address C2h) should be cleared.

Application Note: If hysteresis for voltage limit comparisons is non-zero, special care needs to be taken when changing the voltage limit registers while a voltage error condition exists. If software relaxes the voltage limits in an attempt to prevent an error condition, it may be necessary to relax the limits by an amount greater than the hysteresis value and wait several milliseconds before attempting to clear the error status bit for the given voltage channel. Once the error status bit has been cleared, the desired limit(s) can be programmed.

16.13.2 Register BDh Special Function Control 2 (Smart Tach Mode Enable, Fan Control Temperature Resolution Control **首的以外**物物物

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
BDh	R/W	Special Function Control 2	VID_MODE[1:0]		LT34 _RS	LT12 _RS	STE4	STE3	STE2	STE1	00h

Bit	Name	R/W	Description
0	STE1	R/W	Enable Smart Tach for Tach 1
1	STE2	R/W	Enable Smart Tach for Tach 2
2	STE3	R/W	Enable Smart Tach for Tach 3
3	STE4	R/W	Enable Smart Tach for Tach 4
4	LT12_RS	R/W	When this bit is set, the LUT1 and LUT2 fan controls will use 0.5°C. The resolution of the LUT offsets and hysteresis settings are affected by this bit. These bits apply to the fan control offset registers, fan control hysteresis registers, and boost hysteresis registers.
5	LT34_RS	R/W	When this bit is set, the LUT3 and LUT4 fan controls will use 0.5°C. The resolution of the LUT offsets and hysteresis settings are affected by this bit.
7:6	VID_MODE [1:0]	R/W	These bits select the VID mode which determines how the VID code is handled by the P1_VID and P2_VID value registers and the dynamic Vccp monitoring.

VID Mode Select Bit Description

VID_MODE[1:0]	VID Mode	Comments
00	VRD10	Supports the VRD10 specification from Intel and is backwards compatible with the LM93 dynamic Vccp monitoring circuitry. This mode has a voltage range of 0.8375V to 1.600V with 12.5mV resolution and supports 6 VID bits/pins.
01	VRD10.2 Extended	Supports the VRD10.2 Extended specification from Intel. This mode has a voltage range of 0.83125V to 1.600V with 6.25mV resolution and supports 7 VID bits/pins.
10	VRD11 Mode 1	Supports the VRD11 specification from Intel. This mode has a voltage range of 0.83125V to 1.600V with 6.25mV resolution and supports 7 VID bits/pins (VID6-VID0). It assumes VID7 is 0. This is the recommended mode of operation for support of VRD10 and VRD11 without requiring additional hardware.
11	VRD11 Mode 2	Supports the VRD11 specification from Intel. This mode has a voltage range of 0.0375V to 1.600V with 12.5mV resolution and supports 7 VID bits/pins (VID7-VID1). It assumes VID0 is 0. This mode measures voltage levels below 0.83125V for VRD11, but will require additional hardware to simultaneously support VRD10 operation.

Application Note: Enabling Smart Tach mode is not supported while either PWM output is configured for 22.5 kHz. The behavior of the part is undefined if this configuration is programmed. Register E0h Special Function TACH to PWM Binding must be setup when Smart Tach modes are enabled.

16.13.3 Register BEh GPI/VID Level Control

Register Address		用 供证的 Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
BEh	R/W	GPI/VID Level Control	GPI7 LVL	GPI6 LVL	GPI5 _LVL	GPI4 LVL	GPI9 LVL	GPI8 LVL	P2_VID LVL	P1_VID LVL	00h

Bit	Name	R/W	Description
0	P1_VID_LVL	R/W	If set, P1_VIDx inputs use alternate lower $V_{\rm IH}$ and $V_{\rm IL}$ levels.
1	P2_VID_LVL	R/W	If set, P2_VIDx uses alternate lower V _{IH} and V _{IL} levels.
2	GPI8_LVL	R/W	When in VRD10 mode, if set, GPI_8 input uses alternate lower $V_{\rm IH}$ and $V_{\rm IL}$ levels.
3	GPI9_LVL	R/W	When in VRD10 mode, if set, GPI_9 input will use alternate lower $\rm V_{IH}$ and $\rm V_{IL}$ levels.
4	GPI4_LVL	R/W	If set, GPIO4 input will use alternate lower $V_{\rm IH}$ and $V_{\rm IL}$ levels
5	GPI5_LVL	R/W	If set, GPIO5 input will use alternate lower $V_{\rm IH}$ and $V_{\rm IL}$ levels
6	GPI6_LVL	R/W	If set, GPIO6 input will use alternate lower V _{IH} and V _{IL} levels
7	GPI7_LVL	R/W	If set, GPIO7 input will use alternate lower $V_{\rm IH}$ and $V_{\rm IL}$ levels

See the DC Electrical Characteristics for exact \mathbf{V}_{IH} and \mathbf{V}_{IL} levels.

16.13.4 Register BFh PWM Ramp Control

音词"LM94" Register Address		Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
BFh	R/W	PWM Ramp Control	PH_RAMP			VRD_	RAMP		00h		

Bit	Name	R/W	Description
3:0	VRD_RAMP	R/W	Sets the time delay between ramp steps for the
			VRDx_HOT ramp up/ramp down PWM function.
7:4	PH_RAMP	R/W	Sets the time delay between ramp steps for the
			Px_PROCHOT ramp up/ramp down PWM function.

If the time delay between steps is set to 0 ms, the PWM duty cycle goes immediately to 100% instead of ramping up gradually.

VRD_RAMP or PH_RAMP	Time Delay between Ramp Steps
0h	0 ms
1h	50 ms
2h	100 ms
3h	150 ms
4h	200 ms
5h	250 ms
6h	300 ms
7h	350 ms
8h	400 ms
9h	450 ms
Ah	500 ms
Bh	550 ms
Ch	600 ms
Dh	650 ms
Eh	700 ms
Fh	750 ms

16.13.5 Register C0h Fan Boost Hysteresis (Zones 1/2)

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
	Fan Boost										
C0h	R/W	Hysteresis	H2						44h		
		(Zones 1/2)									

Bit	Name	R/W	Description
3:0	H1	R/W	Sets the fan boost hysteresis for Zone 1a and 1b, has 1°
			C resolution.
7:4	H2	R/W	Sets the fan boost hysteresis for zone 2a and 2b, has 1° C resolution.

If the temperature zone is above fan boost temperature and then drops below the fan boost temperature, the following occurs: the PWM output remains at 100% until the temperature goes a certain amount below the fan boost temperature. These hysteresis registers control this amount and can be set anywhere from 0° C to 15° C (unsigned).

16.13.6 Register C1h Fan Boost Hysteresis (Zones 3/4)

	<u> </u>										
Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
C1h	R/W	Fan Boost Hysteresis (Zones 3/4)	H4					Н	3		44h

Bit	Name	R/W	Description
3:0	H3	R/W	Sets the fan boost hysteresis for zone 3 and has 1°C resolution.
7:4	H4	R/W	Sets the fan boost hysteresis for zone 4 and has 1°C resolution.

If the temperature zone is above fan boost temperature and then drops below the fan boost temperature, the following occurs: the PWM output remains at 100% until the temperature goes a certain amount below the fan boost temperature. These hysteresis registers control this amount and can be set anywhere from 0°C to 15°C (unsigned).

16.13.7 Register C2h Zones 1/2 Spike Smoothing Control

<u> </u>	<u> </u>										
Register	Read)"	Register									Default
Address	Write	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value
C2h	R/W	Zones 1/2 Spike Smoothing Control	ZN2E		ZN2		ZN1E		ZN1		00h

Bit	Name	R/W	Description
2:0	ZN1	R/W	Configures the spike smoothing characteristics for zone 1a and 1b
3	ZN1E	R/W	When set, the filtered temperature for zone 1a and 1b is used for both limit checking and auto-fan control instead of the unfiltered temperature. Even when this bit is cleared, the filtered temperature can be read by software from the filtered temperature register.
6:4	ZN2	R/W	Configures the spike smoothing characteristics for zone 2a and 2b
7	ZN2E	R/W	When set, the filtered temperature for zone 2a and 2b is used for both limit checking and auto-fan control instead of the unfiltered temperature. Even when this bit is cleared, the filtered temperature can be read by software from the filtered temperature register.

If all the REMOTE1 or REMOTE2 pins are connected to a processor or chipset, instantaneous temperature spikes may be sampled by the LM94. If these spikes are not ignored, the PWM outputs may cause the fans to turn on prematurely and produce unpleasant noise. Also, false error events may occur. For this reason, any zone that is connected to a chipset or processor may need spike smoothing enabled. The spike smoothing provides additional filtering above and beyond any $\Sigma\Delta$ A/D inherent averaging.

When spike smoothing is enabled, the temperature reading registers still reflect the current value of the temperature—not the filtered value. Only the filtered temperature registers reflect the filtered value.

ZN1 or ZN2	Spike Smoothed Over				
0h	11.8 seconds				
1h	7.0 seconds				
2h	4.4 seconds				
3h	3.0 seconds				
4h	1.6 seconds				
5h	0.8 seconds				
6h	0.6 seconds				
7h	0.4 seconds				

16.13.8 Register C3h LUT 1/2 MinPWM and Hysteresis

Register Address	Read/ Write	共沙筒 R é gister Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
C3h	R/W	LUT 1/2 MinPWM and Hvsteresis		MinP\	WM12			LUT_F0	C_TH12		00h

Bit	Name	R/W	Description
3:0	LUT_FC_TH12	R/W	This field sets the amount of hysteresis (in degrees C) that is used by the auto-fan control for LUT 1 and 2. This should be set greater than 0 to avoid unwanted oscillation between two steps in the look-up table. The resolution of this field is controlled by Special Function Control 2 register bit 4.
7:4	MinPWM12	R/W	This field determines the duty cycle that the auto-fan control requests for LUT 1 and 2 if the temperature for the given zone falls below the programmed base temperature for the assigned LUT. This field accepts 16 possible values 13 of which are mapped to duty cycles according the table in the Auto-Fan Control section Section 15.10.2 LUT Fan Control Duty Cycles.

16.13.9 Register C4h LUT 3/4 MinPWM and Hysteresis

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
C4h	R/W	LUT 3/4 MinPWM and	MinPWM34		LUT_FC_TH34			00h			
		Hysteresis									

Bit	Name	R/W	Description
3:0	LUT_FC_TH34	R/W	This field sets the amount of hysteresis (in degrees C) that is used by the auto-fan control for LUT 3 and 4. This should be set greater than 0 to avoid unwanted oscillation between two steps in the look-up table. The resolution of this field is controlled by Special Function Control 2 register bit 5.
7:4	MinPWM34	R/W	This field determines the duty cycle that the auto-fan control requests for LUT 3 and 4 if the temperature for the given zone falls below the programmed base temperature for the assigned LUT. This field accepts 16 possible values 13 of which are mapped to duty cycles according the table in the Auto-Fan Control section Section 15.10.2 LUT Fan Control Duty Cycles.

16.13.10 Register C5h GPO

≦询"LM94"供应商 Register Read/ Default Register Bit 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0 Address Write Name Value GPO1 C5h R/W GPO GPO7 GPO6 GPO5 GPO4 GPO3 GPO2 GPO0 00h

Bit	Name	R/W	Description
0	GPO0	R/W	If set, GPIO_0 will be pulled low. If cleared, the output is not pulled low. This bit should be 0 if GPIO_0 is being used as an input.
1	GPO1	R/W	If set, GPIO_1 will be pulled low. If cleared, the output is not pulled low. This bit should be 0 if GPIO_1 is being used as an input.
2	GPO2	R/W	If set, GPIO_2 will be pulled low. If cleared, the output is not pulled low. This bit should be 0 if GPIO_2 is being used as an input.
3	GPO3	R/W	If set, GPIO_3 will be pulled low. If cleared, the output is not pulled low. This bit should be 0 if GPIO_3 is being used as an input.
4	GPO4	R/W	If set, GPIO_4 will be pulled low. If cleared, the output is not pulled low. This bit should be 0 if GPIO_4 is being used as an input.
5	GPO5	R/W	If set, GPIO_5 will be pulled low. If cleared, the output is not pulled low. This bit should be 0 if GPIO_5 is being used as an input.
6	GPO6	R/W	If set, GPIO_6 will be pulled low. If cleared, the output is not pulled low. This bit should be 0 if GPIO_6 is being used as an input.
7	GPO7	R/W	If set, GPIO_7 will be pulled low. If cleared, the output is not pulled low. This bit should be 0 if GPIO_7 is being used as an input.

16.13.11 Register C6h PROCHOT Control 本句"Mo4"# 应商

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
C6h	R/W	PROCHOT Override	FORCE _P1	FORCE P2	P2_VRD2 _DIS	P1_VRD1 _DIS		PHT	_DC		00h

Bit	Name	R/W	Description
3:0	PHT_DC	R/W	PROCHOT duty cycle select.
4	P1_VRD1_DIS	R/W	When this bit is set by software, P1_PROCHOT will not be asserted when P1_VRD_HOT is asserted.
5	P2_VRD2_DIS	R/W	When this bit is set by software, P2_PROCHOT will not be asserted when P2_VRD_HOT is asserted.
6	FORCE_P1	R/W	When this is set by software, P1_PROCHOT will be asserted by the LM94 with the duty cycle selected by PHT_DC.
7	FORCE_P2	R/W	When this is set by software, P2_PROCHOT will be asserted by the LM94 with the duty cycle selected by PHT_DC.

Note that if the $\overline{P1P2_PROCHOT}$ bit is set to short the $\overline{Px_PROCHOT}$ pins together, both $\overline{Px_PROCHOT}$ outputs will be driven together, even if only one of the FORCE_Px bits is set.

The period of the PWM signal driven on $\overline{Px_PROCHOT}$ is 3.56 ms (80 internal 22.5 kHz clocks). The asserted time can be increased in 5 clock increments. 5 clocks is about 220 μ s and would represent 6.25% percent throttled.

Possible settings for PHT_DC:

PHT_DC	Asserted Period
0h	5 clocks
1h	10 clocks
2h	15 clocks
3h	20 clocks
4h	25 clocks
5h	30 clocks
6h	35 clocks
7h	40 clocks
8h	45 clocks
9h	50 clocks
Ah	55 clocks
Bh	60 clocks
Ch	65 clocks
Dh	70 clocks
Eh	75 clocks
Fh	80 clocks

16.13.12 Register C7h PROCHOT Time Interval

道"LM94" Register Re Register Default Bit 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0 Address Write Name Value **PROCHOT** P1_TI R/W C7h Time P2_TI 11h Interval

Bit	Name	R/W	Description
3:0	P1_TI	R/W	Sets the monitoring interval for P1_PROCHOT
7:4	P2_TI	R/W	Sets the monitoring interval for P2_PROCHOT

Possible settings for P1_TI and P2_TI:

P1_TI or P2_TI	Monitoring Time Interval (seconds)					
0h	0.73					
1h	1.46					
2h	2.9					
3h	5.8					
4h	11.7					
5h	23.3					
6h	46.6					
7h	93.2					
8h	186					
9h	372					
Ah–Fh	Reserved					

Note that changing this value while $\overline{PROCHOT}$ measurements are running may cause the monitoring circuit to produce a erroneous value. To avoid alerts and invalid B_Px_PROCHOT or B_Px_PROCHOT Error Status values, only change this value while the chip is programmed for S3 or S4/5.

16.13.13 Register C8h PWM1 Control 1

Register	Read/	共 兴 尚 Register	D:+ 7	Dit C	Bit 5	D: 4	Dit 0	Dit 0	D:4 1	Dit 0	Default
Address	Write	Name	Bit 7	Bit 6	Біі э	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value
C8h	R/W	PWM1 Control 1	VRD2	VRD1	PH2	PH1	LUT4	LUT3	LUT2	LUT1	00h

Bit	Name	R/W	Description
0	LUT1	R/W	If set, PWM1 will be bound to LUT 1.
1	LUT2	R/W	If set, PWM1 will be bound to LUT 2.
2	LUT3	R/W	If set, PWM1 will be bound to LUT 3.
3	LUT4	R/W	If set, PWM1 will be bound to LUT 4.
4	PH1	R/W	If set, PWM1 will be bound to P1_PROCHOT.
5	PH2	R/W	If set, PWM1 will be bound to P2_PROCHOT.
6	VRD1	R/W	If set, PWM1 will be bound to VRD1_HOT1.
7	VRD2	R/W	If set, PWM1 will be bound to VRD1_HOT2.

This register can bind PWM1 to several different control sources. The temperature zones control the PWM duty cycle using the table lookup function. The $\overline{\text{Px}_\text{PROCHOT}}$ and $\overline{\text{VRDx}_\text{HOT}}$ inputs control the PWM using the ramp up/ramp down functions. If multiple control sources are bound to PWM1, the largest duty cycle being requested will be used.

16.13.14 Register C9h PWM1 Control 2

查询"LM94" Register	供应商	Dominton	ı		Γ						Defect
Address	Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
C9h	R/W	PWM1 Control 2		OVR	R_DC		PPL	EPPL	INV	OVR	00h

Bit	Name	R/W	Description
0	OVR	R/W	When set, enables manual duty cycle override for PWM1.
1	INV	R/W	Invert PWM1 output. When 0, 100% duty cycle corresponds to the PWM output continuously HIGH. When 1, 100% duty cycle corresponds to the PWM output continuously LOW.
2	EPPL	R/W	Enable PROCHOT PWM1 lock. When set, this bit causes bound PROCHOT events on PWM1 to trigger PPL (bit [3]). When cleared, PPL never gets set.
3	PPL	R/W	PROCHOT PWM1 lock. When set, this bit indicates that PWM1 is currently being held at 100% because a bound PROCHOT event occurred while EPPL (bit [2]) was set. This bit is cleared by writing a zero. Clearing this bit allows the fans to return to normal operation. This bit is not locked by the LOCK bit in the LM94 Configuration register.
7:4	OVR_DC	R/W	This field sets the duty cycle that will be used by PWM1 whenever manual low resolution override mode is active. This field accepts 16 possible values that are mapped to duty cycles according the table in the Fan Control section. Whenever this register is read, it returns the duty cycle that is currently being used by PWM1 regardless of whether override mode is active or not. The value read may not match the last value written if another control source is requesting a greater duty cycle. This field always returns 0h when the PWM1 spin up cycle is active.

16.13.15 Register CAh PWM1 Control 3

_	<u> </u>												
Register	Read/	Register								-:-	Default		
Address	Write	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value		
CAh	R/W	PWM1 Control 3	SI	J_DUR[2	:0]	SU_DUR[3]	SU_DC				00h		

Bit	Name	R/W	Description
3:0	SU_DC	R/W	This field sets the duty cycle that will be used whenever PWM1 experiences a Spin-Up cycle. This field accepts 16 possible values that are mapped to duty cycles according the table in the Auto-Fan Control section Section 15.10.2 LUT Fan Control Duty Cycles. Setting this field to 0h will effectively disable Spin-Up.
4	SU_DUR[3]	R/W	Most significant bit that sets the Spin-up duration for PWM1.
7:0	SU_DUR[2:0]	R/W	Least significant bits that set the Spin-Up duration for PWM1 least significant bits.

Bits 7:4 configure the spin-up duration. When the duty cycle of PWM1 changes from zero to a non-zero value, the spin-up sequence is activated for the specified amount of time. The available settings are defined according to this table:

SU_DUR[3] (Bit 4)	SU_DUR[2:0] (Bits[7:5])	Spin-Up Time
0	0h	Spin-up disabled
0	1h	100 ms
0	2h	250 ms
0	3h	400 ms
0	4h	700 ms
0	5h	1s
0	6h	2 s
0	7h	4 s
1	0h	6 s
1	1h	8 s
1	2h	10 s
1	3h	12 s
1	4h	14 s
1	5h	16 s
1	6h	18 s
1	7h	20 s

16.13.16 Register CBh PWM1 Control 4

查询"LM94 Register Address	Read/ Write		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
CBh	R/W	PWM1 Control 4	RES	RES	RES	RES	HF_LUT _MAP	FREQ1			00h

Bit	Name	R/W	Description
2:0	FREQ1	R/W	PWM1 frequency control. Setting this value controls the frequency of the PWM1 output according to the table below.
3	HF_LUT_MAP	R/W	Selects between two different maps for the PWM duty cycle assignment in the LUT when the PWM frequency is set to 22.5kHz. All 4 LUTs, VRD ramp, PROCHOT ramp, spin-up and low-resolution overide will be affected by this bit. When this bit is set the LUT duty cycle assignment will increment 6.25% steps starting at 25%. When this bit is cleared the duty cycle mapping will match the Low Frequency table. This bit has no effect when the PWM frequency is set to anything other than 22.5kHz and the low PWM frequency mapping will be used.
7:4	RES	R	Reserved

FREQ1	Frequency of PWM1 (Hz)
0h	22500
1h	96
2h	84
3h	72
4h	60
5h	48
6h	36
7h	12

LUT 1-4 Duty Cycle Assignment with PWM Frequency=22.5kHz as Controlled by the HF_LUT_MAP bit.

LUT Duty Cycle /	Assignments when HF_LUT_MAP='0'	LUT Duty Cycle Assignments when HF_LUT_MAP='1' (Low PWM Frequency Mapping)					
LUT Step	Duty Cycle (%)	LUT Step	Duty Cycle (%)				
1	25	1	25				
2	31.25	2	28.57				
3	37.5	3	32.14				
4	43.75	4	35.71				
5	50	5	39.29				
6	56.25	6	42.86				
7	62.25	7	46.43				
8	68.75	8	50				
9	75	9	53.57				
10	81.25	10	57.14				
11	87.5	11	71.43				
12	93.75	12	85.71				
13	100	13	100				

16.13.17 Register CCh PWM2 Control 1

	<u>"1001 1"E</u>	供应赛									
Register	Read/	Register									Default
Address	Write	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value
CCh	R/W	PWM2 Control 1	VRD2	VRD1	PH2	PH1	LUT4	LUT3	LUT2	LUT1	00h

Bit	Name	R/W	Description
0	LUT1	R/W	If set, PWM2 will be bound to LUT 1.
1	LUT2	R/W	If set, PWM2 will be bound to LUT 2.
2	LUT3	R/W	If set, PWM2 will be bound to LUT 3.
3	LUT4	R/W	If set, PWM2 will be bound to LUT 4.
4	PH1	R/W	If set, PWM2 will be bound to P1_PROCHOT.
5	PH2	R/W	If set, PWM2 will be bound to P2_PROCHOT.
6	VRD1	R/W	If set, PWM2 will be bound to VRD1_HOT.
7	VRD2	R/W	If set, PWM2 will be bound to VRD2_HOT.

This register can bind PWM2 to several different control sources. The temperature zones control the PWM duty cycle using the table lookup function. The $\overline{\text{Px}_\text{PROCHOT}}$ and $\overline{\text{VRDx}_\text{HOT}}$ inputs control the PWM using the ramp up/ramp down functions. If multiple control sources are bound to PWM2, the largest duty cycle being requested will be used.

16.13.18 Register CDh PWM2 Control 2

查询"LM94" Register Address	供 <u>应商</u> Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
CDh	R/W	PWM2 Control 2		OVP	L_DC	I	PPL	EPPL	INV	OVR	00h

Bit	Name	R/W	Description
0	OVR	R/W	When set, enables manual duty cycle override for PWM2.
1	INV	R/W	Invert PWM1 output. When 0, 100% duty cycle corresponds to the PWM output continuously HIGH. When 1, 100% duty cycle corresponds to the PWM output continuously LOW.
2	EPPL	R/W	Enable PROCHOT PWM2 lock. When set, this bit causes bound PROCHOT events on PWM2 to trigger PPL (bit [3]). When cleared, PPL never gets set.
3	PPL	R/W	PROCHOT PWM2 lock. When set, this bit indicates that PWM2 is currently being held at 100% because a bound PROCHOT event occurred while EPPL (bit [2]) was set. This bit is cleared by writing a zero. Clearing this bit allows the fans to return to normal operation. This bit is not locked by the LOCK bit in the LM94 Configuration register.
7:4	OVR_DC	R/W	This field sets the duty cycle that will be used by PWM2 whenever manual low resolution override mode is active. This field accepts 16 possible values that are mapped to duty cycles according the table in the Fan Control section. Whenever this register is read, it returns the duty cycle that is currently being used by PWM2 regardless of whether override mode is active or not. The value read may not match the last value written if another control source is requesting a greater duty cycle. This field always returns 0h when the PWM2 spin up cycle is active.

16.13.19 Register CEh PWM2 Control 3

_											
Register	Read/	Register									Default
Address	Write	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value
CEh	R/W	PWM2 Control 3	SI	J_DUR[2	:0]	SU_DUR[3]	SU_DC			00h	

Bit	Name	R/W	Description
3:0	SU_DC	R/W	This field sets the duty cycle that used whenever PWM2 experiences a Spin-Up cycle. This field accepts 16 possible values that are mapped to duty cycles according the table in the Auto-Fan Control section Section 15.10.2 LUT Fan Control Duty Cycles. Setting this field to 0h effectively disables Spin-Up.
4	SU_DUR[3]	R/W	Most significant bit that sets the spin-up duration for PWM2
7:5	SU_DUR[2:0]	R/W	Least significant bits that set the Spin-Up duration for PWM2.

Bits 7:4 configure the spin-up duration. When the duty cycle of PWM2 changes from zero to a non-zero value, the spin-up sequence is activated for the specified amount of time. The available settings are defined according to this table:

SU_DUR[3] (Bit 4)	SU_DUR[2:0] (Bits[7:5])	Spin-Up Time					
0	0h	Spin-up disabled					
0	1h	100 ms					
0	2h	250 ms					
0	3h	400 ms					
0	4h	700 ms					
0	5h	1s					
0	6h	2 s					
0	7h	4 s					
1	0h	6 s					
1	1h	8 s					
1	2h	10 s					
1	3h	12 s					
1	4h	14 s					
1	5h	16 s					
1	6h	18 s					
1	7h	20 s					

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16.13.20 Register CFh PWM2 Control 4

查询"LM94" Register Address	供文章 Head/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
CFh	R/W	PWM2 Control 4	RES	RES	RES	RES	HF_LUT _MAP		FREQ2		00h

查询"LN	⁄ιο ^{Βit} ⁄±	ւմ <mark>-M</mark> ame	R/W	Description
	2:0	FREQ2	R/W	PWM2 frequency control. Controls the frequency of the PWM2 output in the same fashion as FREQ1 in the PWM1 Control 4 register.
	3	HF_LUT_MAP	R/W	Selects between two different maps for the PWM duty cycle assignment in the LUT when the PWM frequency is set to 22.5kHz. All 4 LUTs, VRD ramp, PROCHOT ramp, spin-up, and low-resolution override will be affected by this bit. When this bit is cleared the LUT duty cycle assignment will increment 6.25% steps starting at 25%. When this bit is set the duty cycle mapping will match the Low Frequency table. This bit has no effect when the PWM frequency is set to anything other than 22.5kHz and the low PWM frequency mapping will be used.
	7:4	RES	R	Reserved

FREQ1	Frequency of PWM1 (Hz)
0h	22500
1h	96
2h	84
3h	72
4h	60
5h	48
6h	36
7h	12

LUT 1-4 Duty Cycle Assignment with PWM Frequency=22.5kHz as Controlled by the HF_LUT_MAP bit.

LUT Duty Cycle Ass	ignments when HF_LUT_MAP='0'	LUT Duty Cycle Assignments when HF_LUT_MAP= (Low PWM Frequency Mapping)				
LUT Step	Duty Cycle (%)	LUT Step	Duty Cycle (%)			
1	25	1	25			
2	31.25	2	28.57			
3	37.5	3	32.14			
4	43.75	4	35.71			
5	50	5	39.29			
6	56.25	6	42.86			
7	62.25	7	46.43			
8	68.75	8	50			
9	75	9	53.57			
10	81.25	10	57.14			
11	87.5	11	71.43			
12	93.75	12	85.71			
13	100	13	100			

16.13.21 Register D0h-D3h LUT 1 to 4 Base Temperatures

<u> 季请"LM0//"</u>	供应甚										
Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
D0h	R/W	LUT 1 Base Temperature	7	6	5	4	3	2	1	0	00h
D1h	R/W	LUT 2 Base Temperature	7	6	5	4	3	2	1	0	00h
D2h	R/W	LUT 3 Base Temperature	7	6	5	4	3	2	1	0	00h
D3h	R/W	LUT 4 Base Temperature	7	6	5	4	3	2	1	0	00h

The value in this register is used as the base in the temperature calculation for the auto fan control look-up table. These registers use the standard temperature format (8-bit signed data). The look-up table contains the temperature offsets. The offsets are added to the base temperature to determine the true temperature to be used for each table entry for auto fan control.

16.13.22 Register D4h-DFh Lookup Table Steps-LUT 1/2 and LUT 3/4 Offset Temperature

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value	
D4h	R/W	Step 2 Temp Offset		LUT3/4	_STEP2			LUT1/2	_STEP2		00h	
D5h	R/W	Step 3 Temp Offset		LUT3/4_STEP3 LUT1/2_STEP3					00h			
D6h	R/W	Step 4 Temp Offset		LUT3/4	_STEP4			LUT1/2_STEP4				
D7h	R/W	Step 5 Temp Offset		LUT3/4_STEP5				LUT1/2_STEP5				
D8h	R/W	Step 6 Temp Offset		LUT3/4_STEP6 LUT1				LUT1/2	_STEP6		00h	
D9h	R/W	Step 7 Temp Offset		LUT3/4_STEP7 LUT1/2_STEP7					00h			
DAh	R/W	Step 8 Temp Offset		LUT3/4	_STEP8			LUT1/2	_STEP8		00h	
DBh	R/W	Step 9 Temp Offset		LUT3/4	_STEP9			LUT1/2_STEP9				
DCh	R/W	Step 10 Temp Offset		LUT3/4_	STEP10			LUT1/2_	STEP10		00h	
DDh	R/W	Step 11 Temp Offset		LUT3/4_STEP11 LUT1/2_STEF				STEP11		00h		
DEh	R/W	Step 12 Temp Offset	LUT3/4_STEP12 LUT1/2_STEP12					00h				
DFh	R/W	Step 13 Temp Offset		LUT3/4_	STEP13			LUT1/2_	STEP13		00h	

There are two look up tables of 13 steps (12 offsets), one for LUT 1 and 2 the other for LUT 3 and 4. Each 8-bit offset register contains the offset temperature for LUT 1 and 2 as well as the offset temperature for LUT 3 and 4. The format for the offsets is a 4-bit unsigned value, and one LSB is either 1°C or 0.5°C. The offset resolution is controlled by LT34_RS and LT12_RS bits found in the Special Function Control 2 register (at address BDh). Therefore, the offset range is variable as well and is either 15°C to 0°C or 7.5°C to 0°C.

See the Section 15.10 FAN CONTROL for information on how the base temperature/lookup table should be used for controlling the PWM output(s).

16.13.23 Register E0h Special Function TACH to PWM Binding

	Read/ Write		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
E0h	R/W	Special Function TACH to PWM Binding	T4P2	T4P1	T3P2	T3P1	T2P2	T2P1	T1P2	T1P1	00h

Bit	Name	R/W	Description
0	T1P1	R/W	If set, TACH1 is bound to PWM1.
1	T1P2	R/W	If set, TACH1 is bound to PWM2.
2	T2P1	R/W	If set, TACH2 is bound to PWM1.
3	T2P2	R/W	If set, TACH2 is bound to PWM2.
4	T3P1	R/W	If set, TACH3 is bound to PWM1.
5	T3P2	R/W	If set, TACH3 is bound to PWM2.
6	T4P1	R/W	If set, TACH4 is bound to PWM1.
7	T4P2	R/W	If set, TACH4 is bound to PWM2.

If a TACH channel is bound to a PWM channel, TACH errors on that channel are automatically masked when the bound PWM is at 0% duty cycle or performing spin-up. Behavior is undefined if a TACH channel is bound to both PWM outputs. This register must be setup when Smart Tach Mode is enabled in register BDh, Special Function Control 2, and when Tach Boost is enabled in register E1h, Tachometer Fan Boost Cotrol.

16.13.24 Register E1h Tachometer Fan Boost Control Register

Register	Read/	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default
Address	Write										Value
E1h	R/W	Tach Fan Boost Control	RES	TBS	TBT[5:0]				3Fh		

Lock	Bit	Name	R/W	Description
х	5:0	TBT[5:0]]	R/W	TACH error fan boost enable timeout. Set to 63 (3Fh) to disable the TACH error fan boost feature (default). Values other than 63 enable the TACH error fan boost feature and set the timeout according to the following table.
	6	TBS	R/W	TACH boost status: When set, this bit indicates that the TACH error boost has been triggered and is currently requesting 100% PWM. If bits [5:0] are configured for an infinite timeout, and the TACH error (s) have ceased, then writing a zero to this bit will un-trigger the TACH boost. If TACH error boost is disabled, this bit always returns a 0.
	7	RES	R	Reserved

Timeout Assignments for TBT[5:0]

TBT[5:0]	Timeout/Function
0	0
1	3
	·
	·
N	N * 32 * 0.091 sec
60	175
61	178
62	Infinite setting (software must clear bit 6 of this register to reset)
63	Disabled

16.13.25 Register E2h LM94 Status Control

本治川M	简"LM04"供应商 Register Read/ Register Bu Su Bu Su											
Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value	
Eab	DAM	LM94 Status/	BMC	HOST	TACH	 _EDGE	GPI5_A	GPI4_AM	ASF	OVRID	00h	
E2h	R/W	Control	_ERR	_ERR			М				OON	

Lock	Bit	Name	R/W	Description
	0	OVRID	R/W	If this bit is set, all PWM outputs go to 100% duty cycle.
X	1	ASF	R/W	If this bit is set, BMC error registers support ASF, i.e. reset on read. When not in ASF mode, a write "1" is required to clear the bits in the BMC error status registers.
	2	GPI4_AM	R/W	GPI4 Auto Mask Enable If this bit is set, an error event on GPI4 causes all other error events to be masked. The BMC Error Status registers do not reflect any new error events until the GPI4_ERR bit is cleared in the B_GPI Error Status register. The HOST Error Status registers do not reflect any new error events until the GPI4_ERR bit is cleared in the H_GPI Error Status register. If a CPU_THERMTRIP signal is connected to GPIO4, this ensures that unwanted error events do not fire once CPU_THERMTRIP is asserted.
	3	GP15_AM	R/W	GPI5 Auto Mask Enable This bit works exactly the same as GPI4_AM, but applies to GPI5.
	5:4	TACH_EDGE	R/W	This field determines what type of edges are used for measuring fan tach pulses. This effects all four tachometer inputs.
	6	HOST_ERR	R	This bit gets set if any error bit is set in any of the Host Error Status registers (H_).
	7	BMC_ERR	R	This bit gets set if any error bit is set in any of the BMC Error Status registers (B_). When this bit is set, ALERT are asserted if enabled.

TACH_EDGE	Edge Type Used for Tachometer Measurements
0h	Either rising or falling edges may
	be used.
1h	Rising edges only
2h	Falling edges only
3h	Reserved

16.13.26 Register E3h LM94 Configuration 李句"LM04"供应商

Register Read/ Register					5	54	5 o	5 6	54	D :: 0	Default	
Address	Write	Name	Bit 7	Bit 6	Bit 5 Bit 4		Bit 3	Bit 2	Bit 1	Bit 0	Value	
E3h	R/W	LM94	READY	RES	ALERT_	P1P2_	ALERT	GMSK	LOCK	START	00h	
ESII	□/ VV	Configuration	NEADT		COMP_EN	PROCHOT	_EN				0011	

Lock	Bit	Name	R/W	Description
х	0	START	R/W	When this bit is 0, the LM94 operates in basic mode. All error events are masked. The auto fan control algorithm is disabled. Both PWMs are set to 0%. All monitoring functions are active and the value registers are updated. Once this bit is set, error events are no longer globally masked, and the auto-fan control algorithm is enabled. Fan boost uses the programmed values. It is expected that all limit and setup registers are set by BIOS or application software prior to setting this bit.
х	1	LOCK	R/W	Setting this bit locks all registers and register bits that are indicated as lockable. Lockable registers have an "x" in the Lock column of their description. This register is locked once it is set. This bit can only be cleared by an external device asserting RESET.
	2	GMSK	R/W	Global Mask When this bit is set by software, all error events are masked. Setting this bit does not effect any other mask registers or value registers.
	3	ALERT_EN	R/W	When this bit is set, the ALERT output is enabled. If this bit is cleared, the ALERT output is disabled.
	4	P1P2_ PROCHOT	R/W	In some configurations it may be required to have both processors throttling at the same rate. When this bit is set, the LM94 connects P1_PROCHOT to P2_PROCHOT. If P1_PROCHOT and P2_PROCHOT are already shorted by some other means, this bit should NOT be set. Doing so would cause both PROCHOT signals to be stuck low until this bit is cleared.
	5	ALERT_ COMP_EN	R/W	When this bit is set the ALERT output will function in the thermal comparator mode. In the thermal comparator mode ALERT will be asserted only for unmasked thermal error events. ALERT will be de-assserted immediately when the error event ceases.
	6	RES	R/W	Reserved
	7	READY	R	The LM94 sets this bit automatically after valid data has been collected for all temperatures and voltages. Software should not use any temperature or voltage values until this bit has been set.

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
E4h	R/W	Sleep State Control	RES SB				03h				

Bit	Name	R/W	Description
1:0	SB		Sleep State Control. Setting this field tells the LM94 which sleep state the system is in. Several error events are masked depending on the state of this field.
7:2	RES	R	Reserved

SB	Description
00	Sleep state = S0
	Do not mask errors.
01	Sleep state = S1
	Mask errors according to S1 mask registers and standard S1 masking.
10	Sleep state = S3 Mask errors according to S3 mask registers and standard S3 masking.
11	Sleep state = S4/5 Mask errors according to S4/5 mask registers and standard S4/5 masking. This mode is activated automatically if the RESET input is asserted.

16.14.2 Register E5h S1 GPI Mask

		Register Name		Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
E5h	R/W	S1 GPI Mask	GPI7_S1 _MSK	GPI6_S1 _MSK	GPI5_S1 _MSK	GPI4_S1 _MSK	GPI3_S1 _MSK	GPI2_S1 _MSK	GPI1_S1 _MSK	GPI0_S1 _MSK	FFh

Bit	Name	R/W	Description
0	GPI0_S1_MSK	R/W	If set, GPI0 errors are masked in S1 sleep state.
1	GPI1_S1_MSK	R/W	If set, GPI1 errors are masked in S1 sleep state.
2	GPI2_S1_MSK	R/W	If set, GPI2 errors are masked in S1 sleep state.
3	GPI3_S1_MSK	R/W	If set, GPI3 errors are masked in S1 sleep state.
4	GPI4_S1_MSK	R/W	If set, GPI4 errors are masked in S1 sleep state.
5	GPI5_S1_MSK	R/W	If set, GPI5 errors are masked in S1 sleep state.
6	GPI6_S1_MSK	R/W	If set, GPI6 errors are masked in S1 sleep state.
7	GPI7_S1_MSK	R/W	If set, GPI7 errors are masked in S1 sleep state.

16.14.3 Register E6h S1 Tach Mask

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
E6h	R/W	S1 Tach Mask		RI	ES		TACH4_S1 _MSK	TACH3_S1 _MSK	TACH2_S1 _MSK	TACH1_S1 _MSK	0Fh

Bit	Name	R/W	Description
0	TACH1_S1_MSK	R/W	If set, Tach1 errors are masked in S1 sleep state.
1	TACH2_S1_MSK	R/W	If set, Tach2 errors are masked in S1 sleep state.
2	TACH3_S1_MSK	R/W	If set, Tach3 errors are masked in S1 sleep state.
3	TACH4_S1_MSK	R/W	If set, Tach4 errors are masked in S1 sleep state.
7:4	RES	R	Reserved

16.14.4 Register E7h S3 GPI Mask 查询"I M04"供应商

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
E7h	R/W	S3 GPI Mask	GPI7_S3 _MSK	GPI6_S3 _MSK	GPI5_S3 _MSK	GPI4_S3 _MSK	GPI3_S3 _MSK	GPI2_S3 _MSK	GPI1_S3 _MSK	GPI0_S3 _MSK	FFh

Bit	Name	R/W	Description
0	GPI0_S3_MSK	R/W	If set, GPI0 errors are masked in S3 sleep state.
1	GPI1_S3_MSK	R/W	If set, GPI1 errors are masked in S3 sleep state.
2	GPI2_S3_MSK	R/W	If set, GPI2 errors are masked in S3 sleep state.
3	GPI3_S3_MSK	R/W	If set, GPI3 errors are masked in S3 sleep state.
4	GPI4_S3_MSK	R/W	If set, GPI4 errors are masked in S3 sleep state.
5	GPI5_S3_MSK	R/W	If set, GPI5 errors are masked in S3 sleep state.
6	GPI6_S3_MSK	R/W	If set, GPI6 errors are masked in S3 sleep state.
7	GPI7_S3_MSK	R/W	If set, GPI7 errors are masked in S3 sleep state.

16.14.5 Register E8h S3 Tach Mask

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
E8h	R/W	S3 Tach Mask		RI	ES		TACH4_S3 _MSK	TACH3_S3 _MSK	TACH2_S3 _MSK	TACH1_S3 _MSK	0Fh

Bit	Name	R/W	Description
0	TACH1_S3_MSK	R/W	If set, Tach1 errors are masked in S3 sleep state.
1	TACH2_S3_MSK	R/W	If set, Tach2 errors are masked in S3 sleep state.
2	TACH3_S3_MSK	R/W	If set, Tach3 errors are masked in S3 sleep state.
3	TACH4_S3_MSK	R/W	If set, Tach4 errors are masked in S3 sleep state.
7:4	RES	R	Reserved

16.14.6 Register E9h S3 Temperature/Voltage Mask

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
E9h	R/W	S3 Voltage Mask		RI	ES	-	TEMP_ S3_MSK	AIN14_S3 _MSK	AIN13_S3 _MSK	AIN12_S3 _MSK	07h

Bit	Name	R/W	Description
0	AIN12_S3_MS	R/W	If set, AIN12 errors as masked in S3 sleep state.
	K		
1	AIN13_S3_MS	R/W	If set, AIN13 errors as masked in S3 sleep state.
	K		
2	AIN14_S3_MS	R/W	If set, AIN14 errors as masked in S3 sleep state.
	K		
3	TEMP_S3_MS	R/W	If set, temperature errors and diode fault errors for zones
	K		1 and 2 are masked in S3 sleep state.
7:3	RES	R	Reserved

16.14.7 Register EAh S4/5 GPI Mask

]<u>"LM94"供应商</u> Read/ Register Register Default Bit 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0 Address Write Name Value GPI2 GPI7 GPI6 GPI5 GPI4 GPI3 GPI1 GPI0 S4/5 GPI _S4/5 EAh R/W _S4/5 _S4/5 _S4/5 FFh _S4/5 _S4/5 _S4/5 _S4/5 Mask _MSK MSK _MSK _MSK _MSK _MSK _MSK _MSK

Bit	Name	R/W	Description
0	GPI0_S4/5_MSK	R/W	If set, GPI0 errors are masked in S4/5 sleep state.
1	GPI1_S4/5_MSK	R/W	If set, GPI1 errors are masked in S4/5 sleep state.
2	GPI2_S4/5_MSK	R/W	If set, GPI2 errors are masked in S4/5 sleep state.
3	GPI3_S4/5_MSK	R/W	If set, GPI3 errors are masked in S4/5 sleep state.
4	GPI4_S4/5_MSK	R/W	If set, GPI4 errors are masked in S4/5 sleep state.
5	GPI5_S4/5_MSK	R/W	If set, GPI5 errors are masked in S4/5 sleep state.
6	GPI6_S4/5_MSK	R/W	If set, GPI6 errors are masked in S4/5 sleep state.
7	GPI7_S4/5_MSK	R/W	If set, GPI7 errors are masked in S4/5 sleep state.

16.14.8 Register EBh S4/5 Temperature/Voltage Mask

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
EBh	R/W	S4/5 Voltage Mask		RES			TEMP_ S4/5_MSK	AIN14_S4/5 _MSK	AIN13_S4/5 _MSK	AIN12_S4/5 _MSK	07h

Bit	Name	R/W	Description
0	AIN12_S4/5_MSK	R/W	If set, AIN12 errors as masked in S4/5 sleep state.
1	AIN13_S4/5_MSK	R/W	If set, AIN13 errors as masked in S4/5 sleep state.
2	AIN14_S4/5_MSK	R/W	If set, AIN14 errors as masked in S4/5 sleep state.
3	TEMP_S4/5_MSK	R/W	If set, temperature errors and diode fault errors for zones
			1 and 2 are masked in S4/5 sleep state.
7:3	RES	R	Reserved

16.15 OTHER MASK REGISTERS 查询"15.MASK GPI Error Mask

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
ECh	R/W	GPI Error Mask	GPI7 _MSK	GPI6 _MSK	GPI5 _MSK	GPI4 _MSK	GPI3 _MSK	GPI2 _MSK	GPI1 _MSK	GPI0 _MSK	FFh

Bit	Name	R/W	Description
0	GPI0_MSK	R/W	When this bit is set, GPI0 error events are masked.
1	GPI1_MSK	R/W	When this bit is set, GPI1 error events are masked.
2	GPI2_MSK	R/W	When this bit is set, GPI2 error events are masked.
3	GPI3_MSK	R/W	When this bit is set, GPI3 error events are masked.
4	GPI4_MSK	R/W	When this bit is set, GPI4 error events are masked.
5	GPI5_MSK	R/W	When this bit is set, GPI5 error events are masked.
6	GPI6_MSK	R/W	When this bit is set, GPI6 error events are masked.
7	GPI7_MSK	R/W	When this bit is set, GPI7 error events are masked.

These bits mask the corresponding bits in the B_ and H_GPI Error Status Registers. They do not effect the GPI State register.

16.15.2 Register EDh Miscellaneous Error Mask

Register Address	Read/ Write	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
EDh	R/W	Miscellaneous Error Mask	RI	ΞS	DVccp2 _MSK	DVccp1 _MSK	SCSI2 _MSK	SCSI1 _MSK	VRD2 _MSK	VRD1 _MSK	3Fh

Bit	Name	R/W	Description
0	VRD1_MSK	R/W	When this bit is set, VRD1_HOT error events are masked.
1	VRD2_MSK	R/W	When this bit is set, VRD2_HOT error events are masked.
2	SCSI1_MSK	R/W	When this bit is set, GPI8 error events are masked.
3	SCSI2_MSK	R/W	When this bit is set, GPI9 error events are masked.
4	DVccp1_MSK	R/W	When this bit is set, dynamic Vccp limit error events for AD_IN7 (CPU1) are masked.
5	DVccp2_MSK	R/W	When this bit is set, dynamic Vccp limit error events for AD_IN8 (CPU2) are masked.
7:6	RES	R	Reserved

16.15.3 Register EE and EFh Zone 1a and Zone 2a Adjustment Register

Register Address		94"供及首 Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default Value
EEh	R/W	Zone 1a Adjust	RES	RES			Z1a_ADJ	UST[5:0]			00h
EFh	R/W	Zone 2a Adjust	RES	RES			Z2a_ADJ	UST[5:0]			00h

Bit	Name	R/W	Description
5:0	Z1a_ADJUST[5:0] or Z2a_ADJUST[5:0]	R/W	6-bit signed 2's complement offset adjustment. This value is added to all zone 1a and 2a temperature measurements as they are made. All LM94 registers and functions behave as if the resulting temperature was the true measured temperature. This register allows offset adjustments from +31°C to -32°C in 1°C
			steps. The format is sign two's complement.
7:6	RES	R	Reserved

17.0 Absolute Maximum Ratings (Note 查询"LM94"供应商

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Positive Supply Voltage (V_{DD}) 6.0V Voltage on Any Digital Input or

Output Pin -0.3V to 6.0V

Voltage on +5V Input -0.3V to +6.667V

Voltage at Positive Remote

Diode Inputs, AD_IN1, AD_IN2,

AD_IN3, and AD_IN15 Inputs -0.3V to $(V_{DD} + 0.05V)$

Voltage at Other Analog Voltage

Inputs -0.3V to +6.0V

Input Current at Thermal Diode

Negative Inputs ±1 mA
Input Current at any pin (*Note 3*) ±10mA
Package Input Current (*Note 3*) ±100 mA

Package Input Current (*Note 3*)

Maximum Junction Temperature

(Note 9)

 (T_{JMAX})

ESD Susceptibility (Note 4)

Human Body Model 3 kV

Machine Model 300V

Charged Device Model 750V

Storage Temperature -65°C to +150°C

For soldering specifications,

see product folder at www.national.com and www.national.com/ms/MS/MS-SOLDERING.pdf

18.0 Operating Ratings (Note 1, Note 2)

 $T_{MIN} \le T_{A} \le T_{MAX}$ Operating Temperature Range $0^{\circ}C \le T_{A} \le +85^{\circ}C$ Nominal Supply Voltage 3.3V Supply Voltage Range (V_{DD}) +3.0V to +3.6V VID0-VID5 -0.05V to +5.5V

Digital Input Voltage Range $\begin{array}{c} -0.05 \text{V to} \\ \text{(V}_{\text{DD}} + 0.05 \text{V)} \end{array}$

79°C/W

Package Thermal Resistance

(Note 6)

19.0 DC Electrical Characteristics

The following limits apply for +3.0 V_{DC} to +3.6 V_{DC} , unless otherwise noted. **Bold face limits apply for T_A = T_J over T_{MIN} to T_{MAX} of the operating range;** all other limits T_A = T_J = 25°C unless otherwise noted. T_A is the ambient temperature of the LM94; T_J is the junction temperature of the LM94; T_D is the junction temperature of the thermal diode.

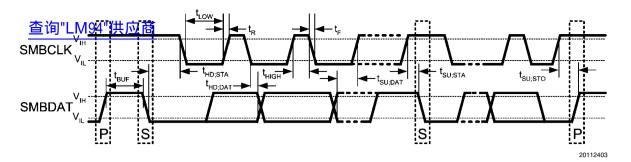
150 °C

Symbol	Parameter	Conditions	Typical (Note 9)	Limits (Note 10)	Units (Limits)
POWER SUP	PLY CHARACTERISTICS				
	Power Supply Current	Converting, Interface and Fans Inactive, Peak Current	2	2.75	mA (max)
		Converting, Interface and Fans Inactive, Average Current	1.6		mA
	Power-On Reset Threshold Voltage		2	1.6	V (min)
				2.7	V (max)
TEMPERATU	RE-TO-DIGITAL CONVERTER CHARACTERISTICS				
	Local Temperature Accuracy Over Full Range	0°C ≤ T _A ≤ 85°C	±2	±3	°C (max)
	1	T _A = +55°C	±1	±2.5	°C (max)
	Local Temperature Resolution		1		°C
	Full Range; targeted for a typical Pentium processor	$0^{\circ}\text{C} \le \text{T}_{\text{A}} \le 85^{\circ}\text{C}$ and $0^{\circ}\text{C} \le \text{T}_{\text{D}} \le 100^{\circ}\text{C}$		±3	°C (max)
	on 90 nm or 65 nm process(<i>Note 8</i>)	$0^{\circ}\text{C} \le \text{T}_{\text{A}} \le 85^{\circ}\text{C}$ and $\text{T}_{\text{D}} = 70^{\circ}\text{C}$		±2.5	°C (max)
	1	$0^{\circ}\text{C} \le \text{T}_{\text{A}} \le 85^{\circ}\text{C}$ and $25^{\circ}\text{C} \le \text{T}_{\text{D}} \le 70^{\circ}\text{C}$	±1		°C
	Remote Temperature Resolution		1		°C
	Thermal Diode Source Current	High Level	172	230	μA (max)
		Low Level	10.75		μA
	Thermal Diode Current Ratio		16		
T _C	Total Monitoring Cycle Time			100	ms (max)

Symbol	Parameter 旬"LM94"供应商	Conditions	Typical (Note 9)	Limits	Units
TUE	Total Unadjusted Error (<i>Note 12</i>)		(Note 9)	(Note 10)	(Limits) % of
				±2	FS (max)
DNL	Differential Non-Linearity		±1		LSB
PSS	Power Supply (V _{DD}) Sensitivity		±1		%/V (of FS)
T _C	Total Monitoring Cycle Time			100	ms (max)
	Input Resistance for Inputs with Dividers		200	140	kΩ (min)
	AD_IN1- AD_IN3 and AD_IN15 Analog Input Leakage Current (<i>Note 13</i>)			60	nA (max)
REFERENCE	E OUTPUT (V _{REF}) CHARACTERISTICS	1	•	Į.	
	Tolerance			±1	% (max)
V _{REF}	Output Voltage (Note 14)		2.500	2.525 2.475	V (max) V (min)
	Load Regulation	I _{SOURCE} = -2 mA I _{SINK} = 2 mA	0.1		%
DIGITAL OU	TPUTS: PWM1, PWM2				
I _{OL}	Maximum Current Sink			8	mA (min)
V _{OL}	Output Low Voltage	I _{OUT} = 8.0 mA		0.4	V (max)
DIGITAL OU	TPUTS: ALL				
V_{OL}	Output Low Voltage (Note excessive current flow	I _{OUT} = 4.0 mA		0.4	V (min)
	causes self-heating and degrades the internal temperature accuracy.)	I _{OUT} = 6 mA		0.55	V (min)
I _{OH}	High Level Output Leakage Current	$V_{OUT} = V_{DD}$	0.1	10	μA (max)
I _{OTMAX}	Maximum Total Sink Current for all Digital Outputs Combined			32	mA (max)
Co	Digital Output Capacitance		20		pF
DIGITAL INF	PUTS: ALL				
V_{IH}	Input High Voltage Except Address Select			2.1	V (min)
V_{IL}	Input Low Voltage Except Address Select			0.8	V (max)
V_{IH}	Input High Voltage for Address Select			90% V _{DD}	V (min)
V _{IM}	Input Mid Voltage for Address Select			43% V _{DD} 57% V _{DD}	V (min) V (max)
V _{IL}	Input Low Voltage for Address Select			10% V _{DD}	V (max)
V _{HYST}	DC Hysteresis		0.3		V
I _{IH}	Input High Current	$V_{IN} = V_{DD}$		-10	μA (min)
I _{IL}	Input Low Current	$V_{IN} = 0V$		10	μA (max)
C _{IN}	Digital Input Capacitance		20		pF
DIGITAL INF	PUTS: P1_VIDx, P2_VIDx, GPI_9, GPI_8, GPIO_7, GI	PIO_6, GPIO_5, GPIO_4 (V		e bit set in	· ·
V _{IH}	Alternate Input High Voltage (AGTL+ Compatible)			0.8	V (min)
V _{IL}	Alternate Input Low Voltage (AGTL+ Compatible)			0.4	V (max)
- IL	The state of the s			J 07	Ι • (ιιιαλ)

20.0 AC Electrical Characteristics 证 V_{DC} V_{DC} V_{DC} to +3.6 V_{DC} , unless otherwise noted. Bold face limits apply for $V_{A} = V_{J} = V_{MIN}$ to V_{MAX} of the operating range; all other limits $V_{A} = V_{J} = 25^{\circ}$ C unless otherwise noted.

Symbol	Parameter	Conditions	Typical (Note 9)	Limits (Note 10)	Units (Limits)
FAN RPM-TO	D-DIGITAL CHARACTERISTICS			, ,	, ,
	Counter Resolution		14		bits
	Number of fan tach pulses count is based		2		pulses
	on				'
	Counter Frequency		22.5		kHz
	Accuracy			±6	% (max)
PWM OUTPU	JT CHARACTERISTICS		•	'	
	Frequency Tolerances			±6	% (max)
	Duty-Cycle Tolerance		±2	±6	% (max)
RESET INPU	IT/OUTPUT CHARACTERISTICS			•	•
	Output Pulse Width			250	ms (min)
	Upon Power Up			330	ms (max
	Minimum Input Pulse Width			10	μs (min)
	Reset Output Fall Time	1.6V to 0.4V Logic Levels		1	μs (max
SMBus TIMI	NG CHARACTERISTICS				
f _{SMBCLK}	SMBCLK (Clock) Clock Frequency			10	kHz (min
				100	kHz (max
t _{BUF}	SMBus Free Time between Stop and Start Conditions			4.7	μs (min)
t _{HD;STA}	Hold time after (Repeated) Start Condition. After this period, the first clock is generated.			4.0	μs (min)
t _{SU;STA}	Repeated Start Condition Setup Time			4.7	μs (min)
t _{su;sto}	Stop Condition Setup Time			4.0	μs (min)
t _{SU;DAT}	Data Input Setup Time to SMBCLK High			250	ns (min)
t _{HD;DAT}	Data Output Hold Time after SMBCLK			300	ns (min)
nu;uA1	Low			1075	ns (max
t _{LOW}	SMBCLK Low Period			4.7	μs (min)
2011				50	μs (max
t _{HIGH}	SMBCLK High Period			4.0	μs (min)
				50	μs (max)
t _R	Rise Time			1	μs (max
t _F	Fall Time			300	ns (max
t _{TIMEOUT}	Timeout		31		ms
	SMBDAT or SMBCLK low time required to reset the Serial Bus Interface to the Idle State			25 35	ms (min ms (max
t _{POR}	Time in which a device must be operational after power-on reset	V _{DD} > +2.8V		500	ms (max
C _L	Capacitance Load on SMBCLK and SMBDAT			400	pF (max



Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

Note 2: All voltages are measured with respect to GND, unless otherwise noted.

Note 3: When the input voltage (V_{IN}) at any pin exceeds the power supplies $(V_{IN} < (GND \text{ or } AGND) \text{ or } V_{IN} > V_{DD}$, except for analog voltage inputs), the current at that pin should be limited to 10 mA. The 100 mA maximum package input current rating limits the number of pins that can safely exceed the power supplies with an input current of 10 mA to ten. Parasitic components and/or ESD protection circuitry are shown below for the LM94's pins. Care should be taken not to forward bias the parasitic diode, D1, present on pins D+ and D- as shown in circuits C and D. Doing so by more than 50 mV may corrupt temperature measurements. D1 and the ESD Clamp are connected between V+ $(V_{DD}, AD_{-}IN16)$ and GND as shown in circuit B. SNP stands for snap-back device.

Symbol	Pin #	Circuit	All Input Circuits
GPIO_0/TACH1	1	Α	P
GPIO_1/TACH2	2	Α	PIN
GPIO_2/TACH3	3	Α	SNP
GPIO_3/TACH4	4	Α	▎ ┆┖┯┦ ╻┃
GPIO_4 / P1_THERMTRIP	5	Α	<u> </u>
GPIO_5 / P2_THERMTRIP	6	Α	GND
GPIO_6	7	A	
GPIO_7	8	Α	
VRD1_HOT	9	A	
VRD2_HOT	10	A	
SCSI_TERM1	11	Α	
SCSI_TERM2	12	Α	□ ∨+
SMBDAT	13	Α	
SMBCLK	14	Α	
ALERT/XtestOut	15	Α	D1 D2 → \$160 k
RESET	16	Α	Clamp 6.5V A'
AGND	17	B (Internally	D3 本 ≥ 80 k
		shorted to GND	
		pin.)	GND
V _{REF}	18	A	<u> </u>
REMOTE1-	19	С	
REMOTE1+	20	D	
REMOTE2-	21	С	
REMOTE+	22	D	
AD_IN1	23	D	□ ∨+
AD_IN2	24	D	
AD_IN3	25	D	D2
AD_IN4	26	Е	PIN
AD_IN5	27	Е	ESD ESD
AD_IN6	28	Е	D1 6.5V CLAMP
AD_IN7	29	Е	6<u>*</u>
AD_IN8	30	Е	GND
AD_IN9	31	Е	
AD_IN10	32	Е	
AD_IN11	33	Е	

Symbol	Pin #	Circuit	All Input Circuits
查询性M94"供应商	34	Е	I
AD_IN13	35	E	50Ω
AD_IN14	36	E	PIN
AD_IN15	37	D	SNP ±D1
ADDR_SEL	38	Α	T T
AD_IN16/V _{DD} (V+)	39	В	L
GND	40	B (Internally shorted to AGND.)	GND
PWM1	41	Α	
PWM2	42	Α	
P1_VID0	43	Α	
P1_VID1	44	Α	
P1_VID2	45	Α	
P1_VID3	46	Α	į
P1_VID4	47	Α	500 Ti
P1_VID5	48	Α	PIN R1
P1_PROCHOT	49	Α	I SNP ★ D1 T R2
P2_PROCHOT	50	Α	¦┡┤
P2_VID0	51	Α	L
P2_VID1	52	Α	GND
P2_VID2	53	Α	
P2_VID3	54	Α	
P2_VID4	55	Α	
P2_VID5	56	Α	

Note 4: Human body model, 100 pF discharged through a 1.5 k Ω resistor. Machine model, 200 pF discharged directly into each pin. Charged device model (CDM) simulates a pin slowly acquiring charge (such as from a device sliding down the feeder in an automated assembler) then rapidly being discharged.

Note 5: Reflow temperature profiles are different for lead-free and non lead-free packages.

Note 6: The maximum power dissipation must be de-rated at elevated temperatures and is dictated by T_{JMAX} , θ_{JA} and the ambient temperature, T_A . The maximum allowable power dissipation at any temperature is $P_{DMAX} = (T_{JMAX} - T_A) / \theta_{JA}$. The θ_{JA} for the LM94 when mounted to 1 oz. copper foil PCB the θ_{JA} with different air flow is listed in the following table.

Air Flow	Junction to Ambient Thermal Resistance, θ_{JA}
0 m/s	79 °C/W
1.14 m/s (225 LFPM)	62 °C/W
2.54 m/s (500 LFPM)	52 °C/W

Note 7: See the URL "http://www.national.com/packaging/" for other recommendations and methods of soldering surface mount devices.

Note 8: At the time of first publication of this specification (Jan 2006), this specification applies to either Pentium or Xeon Processors on 90nm or 65nm process when TruTherm is selected. When TruTherm is deselected this specification applies to an MMBT3904. This specification does include the error caused by the variability of the diode ideality and series resistance parameters.

Note 9: Typical parameters are at $T_J = T_A = 25$ °C and represent most likely parametric norm.

Note 10: Limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

Note 11: TUE (Total Unadjusted Error) includes Offset, Gain and Linearity errors of the ADC.

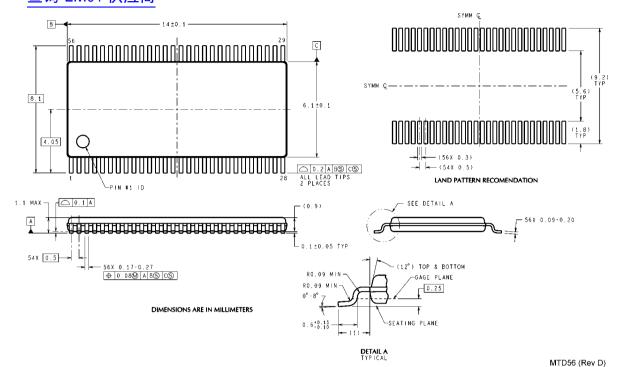
Note 12: Total Monitoring Cycle Time includes all temperature and voltage conversions.

Note 13: Leakage current approximately doubles every 20 °C.

Note 14: A total digital I/O current of 40 mA can cause 6 mV of offset in Vref.

Note 15: Timing specifications are tested at the TTL logic levels, $V_{IL} = 0.4V$ for a falling edge and $V_{IH} = 2.4V$ for a rising edge. TRI-STATE output voltage is forced to 1.4V.

21.0 Physical Dimensions inches (millimeters) unless otherwise noted 查询"LM94"供应商



56-Lead Molded TSSOP Package, JEDEC Registration Number MO-153 Variation EE, Order Number LM94CIMT or LM94CIMTX, NS Package Number MTD56

Notes

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Switching Regulators	www.national.com/switchers	Distributors	www.national.com/contacts
LDOs	www.national.com/ldo	Quality and Reliability	www.national.com/quality
LED Lighting	www.national.com/led	Feedback/Support	www.national.com/feedback
Voltage References	www.national.com/vref	Design Made Easy	www.national.com/easy
PowerWise® Solutions	www.national.com/powerwise	Applications & Markets	www.national.com/solutions
Serial Digital Interface (SDI)	www.national.com/sdi	Mil/Aero	www.national.com/milaero
Temperature Sensors	www.national.com/tempsensors	SolarMagic™	www.national.com/solarmagic
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